

COMPAL CONFIDENTIAL

MODEL NAME : **NCL01**

PCB NO : **LA-5472P (DAA00001I00)**

E2 Rothschild DSC

rPGA Arrandale +
FCBGA PCH IBEXPEAK-M
+ N10M-NS-S

2010-01-20

REV : 1.0(A00)

@ : Nopop Component

MB Type	BOM P/N	PCMCIA	Express	TCM		TPM		ATG		BOM CONFIG	
		1@	2@	W(3@)	W/O(4@)	W(5@)	W/O(6@)	7@	8@		9@
EXPRESS CARD ,Enble TPM ,Disable TCM	43177831L01		*		*	*					2@,4@,5@
EXPRESS CARD ,Disable TPM ,Enble TCM	43177831L02		*	*			*				2@,3@,6@
EXPRESS CARD ,Disable TPM ,Disable TCM	43177831L03		*		*	*					2@,4@,6@
PCMCIA CARD ,Enble TPM ,Disable TCM	43177831L04	*			*	*					1@,4@,5@
PCMCIA CARD ,Disable TPM ,Enble TCM	43177831L05	*		*			*				1@,3@,6@
PCMCIA CARD ,Disable TPM ,Disable TCM	43177831L06	*			*		*				1@,4@,6@

MB PCB	
Part Number	Description
DAA0A200100	PCB NCL01 LA-5472P LS-5471P/5473P/5574P

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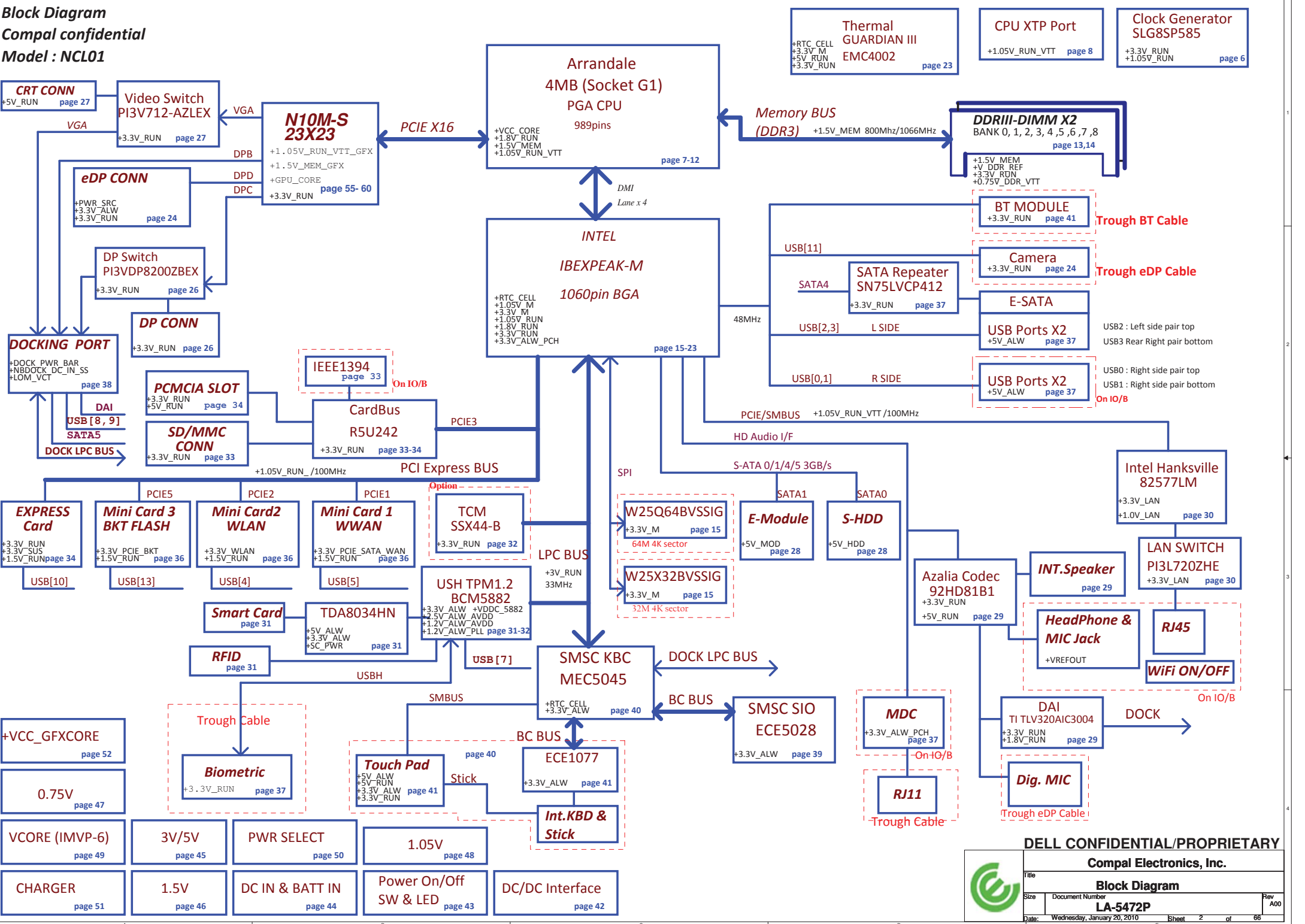


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Block Diagram
Compal confidential
Model : NCL01



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		Block Diagram	
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POWER STATES

State \ Signal	SLP S3#	SLP S4#	SLP S5#	S4 STATE#	SLP M#	ALWAYS PLANE	M PLANE	SUS PLANE	RUN PLANE	CLOCKS
S0 (Full ON) / M0	HIGH	HIGH	HIGH	HIGH	HIGH	ON	ON	ON	ON	ON
S3 (Suspend to RAM) / M1	LOW	HIGH	HIGH	HIGH	HIGH	ON	ON	ON	OFF	OFF
S4 (Suspend to DISK) / M1	LOW	LOW	HIGH	LOW	HIGH	ON	ON	OFF	OFF	OFF
S5 (SOFT OFF) / M1	LOW	LOW	LOW	LOW	HIGH	ON	ON	OFF	OFF	OFF
S3 (Suspend to RAM) / M-OFF	LOW	HIGH	HIGH	HIGH	LOW	ON	OFF	ON	OFF	OFF
S4 (Suspend to DISK) / M-OFF	LOW	LOW	HIGH	LOW	LOW	ON	OFF	OFF	OFF	OFF
S5 (SOFT OFF) / M-OFF	LOW	LOW	LOW	LOW	LOW	ON	OFF	OFF	OFF	OFF

PM TABLE

State \ power plane	+15V_ALW +5V_ALW +3.3V_ALW_PCH +3.3V_RTC_LDO	+3.3V_SUS +1.5V_MEM	+5V_RUN +3.3V_RUN +1.8V_RUN +1.5V_RUN +0.75V_DDR_VTT +VCC_CORE +1.05V_RUN_VTT +1.05V_RUN	+3.3V_M +1.05V_M	+3.3V_M +1.05V_M (M-OFF)
S0	ON	ON	ON	ON	ON
S3	ON	ON	OFF	ON	OFF
S5 S4/AC	ON	OFF	OFF	ON	OFF
S5 S4/AC don't exist	OFF	OFF	OFF	OFF	OFF

PCH	USB PORT#	DESTINATION
	0	JUSB1 (Ext Right Side Top)
	1	JUSB1 (Ext Right Side Bottom)
	2	JESA1 (Ext Left Side Top)
	3	JESA1 (Ext Left Side Bottom)
	4	WLAN
	5	WWAN
	6	Bluetooth
	7	USH->BIO
	8	DOCKING
	9	DOCKING
	10	Express card
	11	Camera
	12	none
13	JMINI3(PCIE/BKT CARD)	

PCI EXPRESS	DESTINATION
Lane 1	MINI CARD-1 WWAN
Lane 2	MINI CARD-2 WLAN
Lane 3	PCMCIA
Lane 4	EXPRESS CARD
Lane 5	MINI CARD-3 PCIE/BKT
Lane 6	10/100/1G LAN
Lane 7	None
Lane 8	None

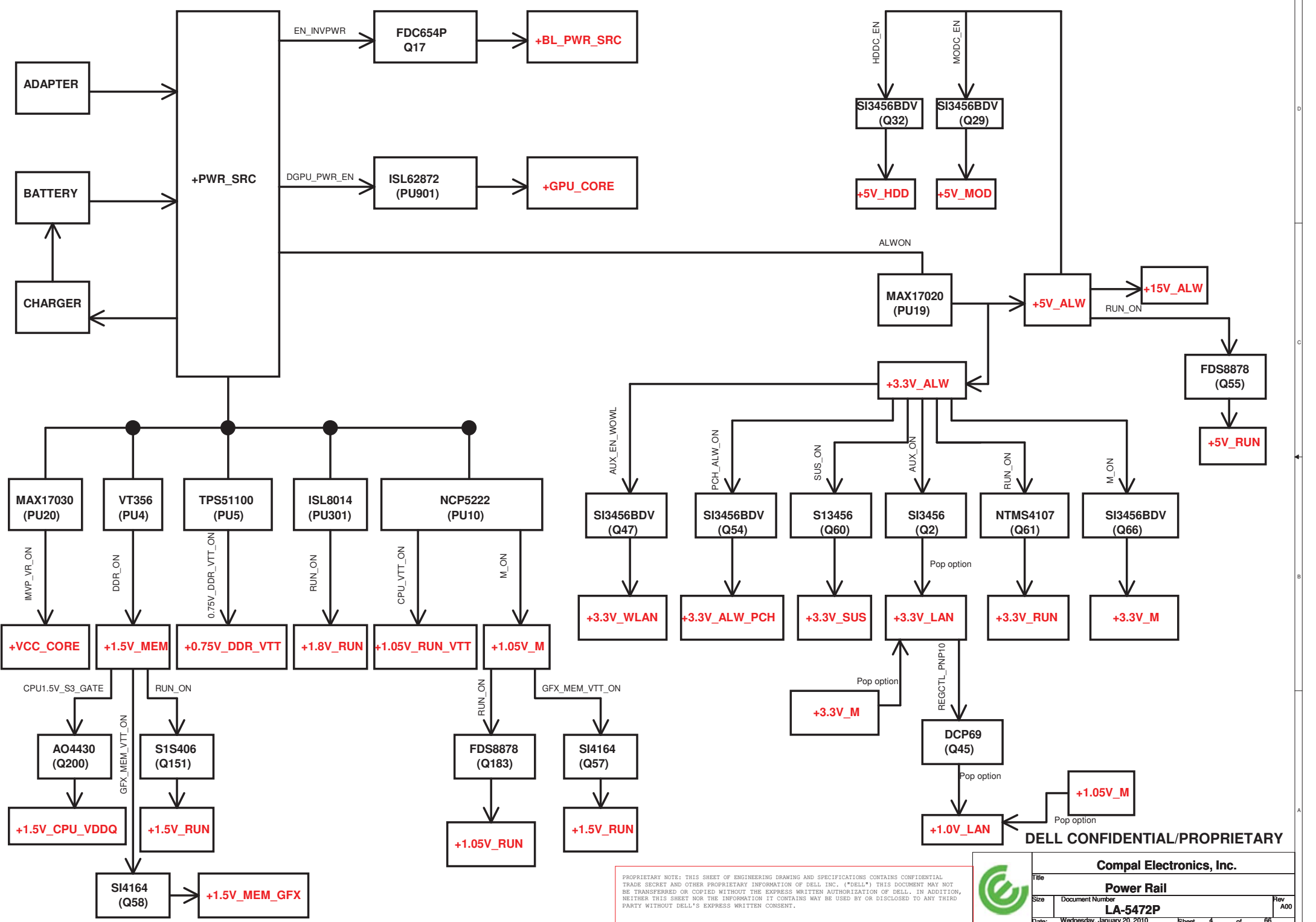
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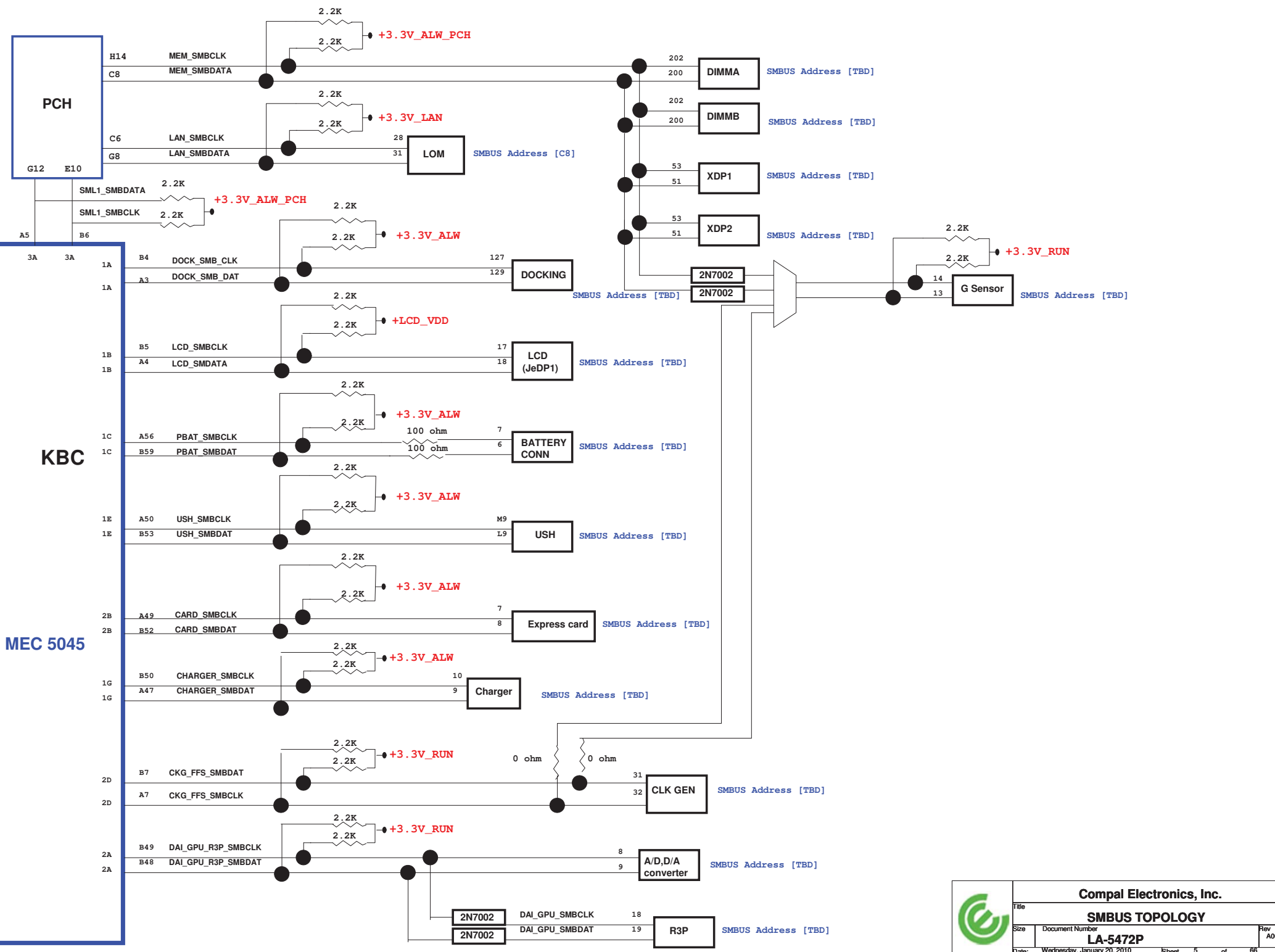
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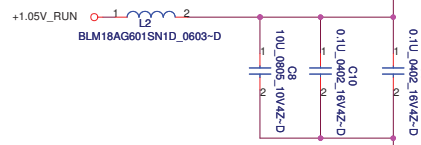
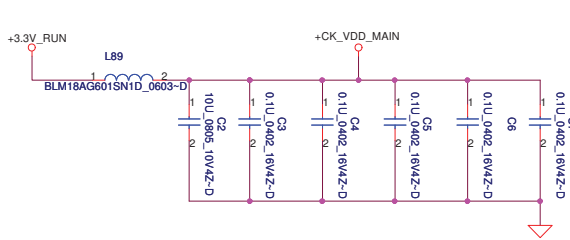
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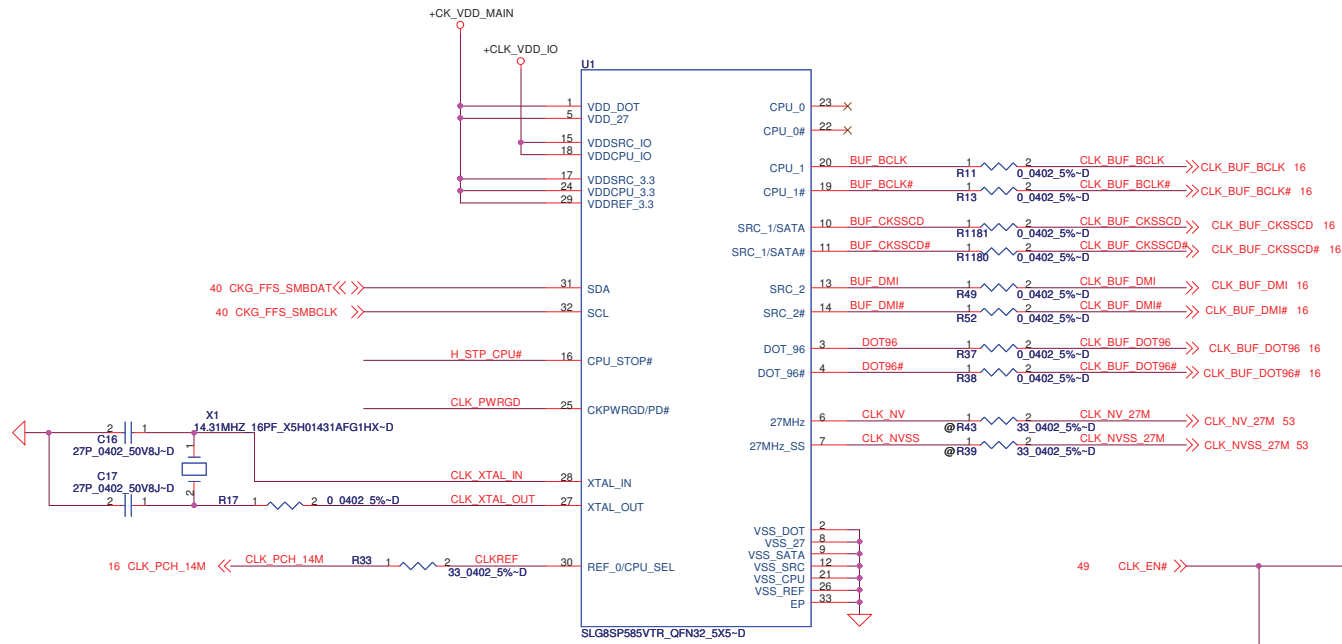
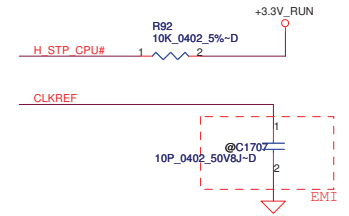
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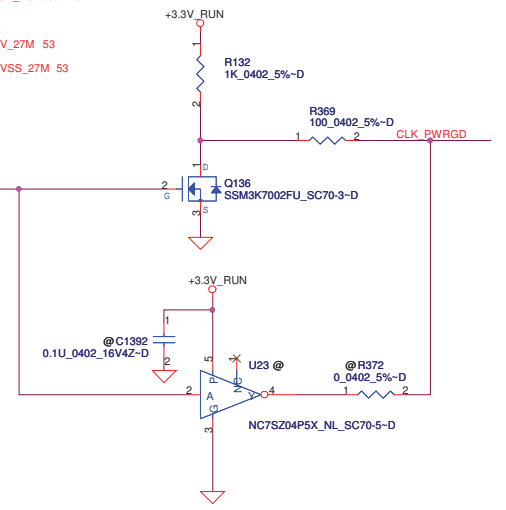


+CLK_VDD_IO CAN BE RANGE FROM 1.05V TO 3V



REF_0/CPU_SEL

PIN 30	CPU0	CPU1
1 (0.7~1.5v)	100MHz	100MHz
0 (DEFAULT)	133MHz	133MHz



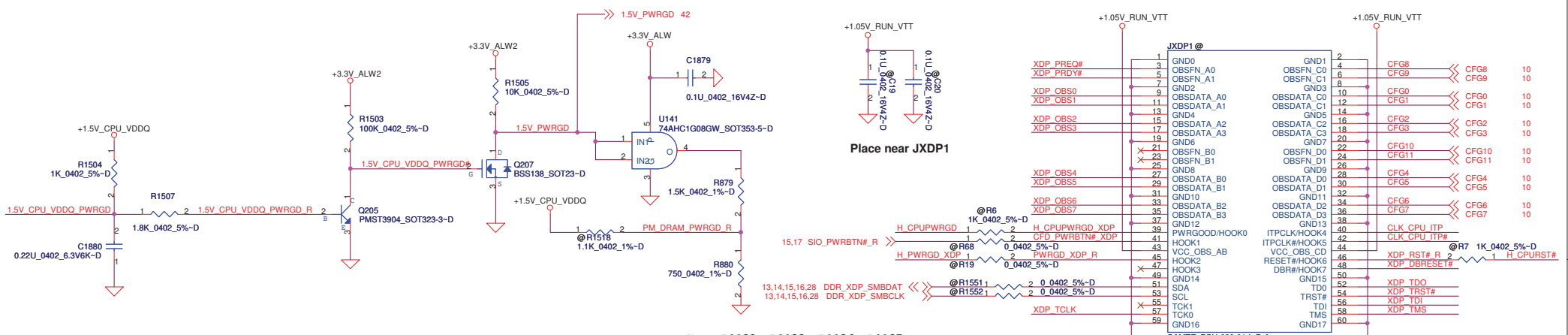
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Clock Generator			
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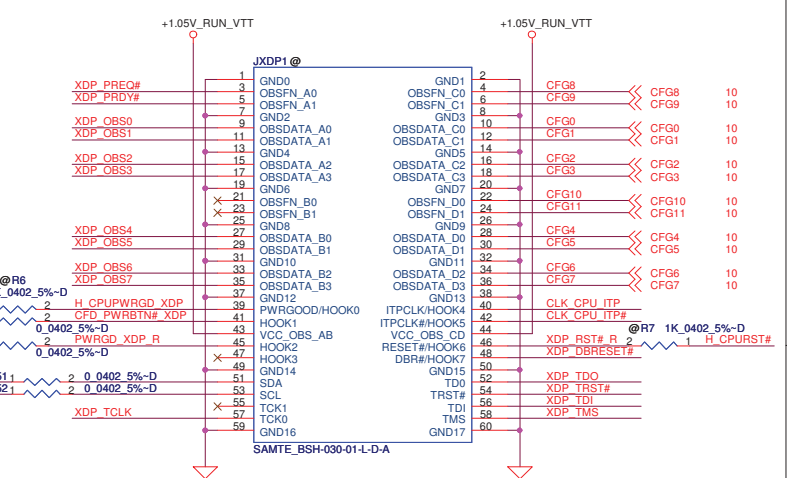
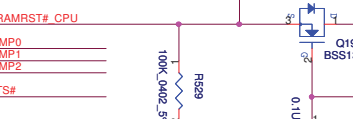
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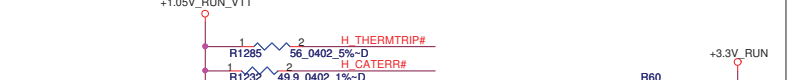
Keep R1132, R1133, R1136, R1137 for slew rate control.



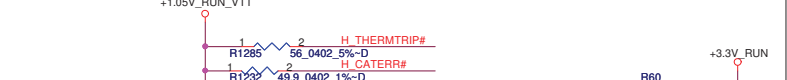
For ESD concern, please put near CPU

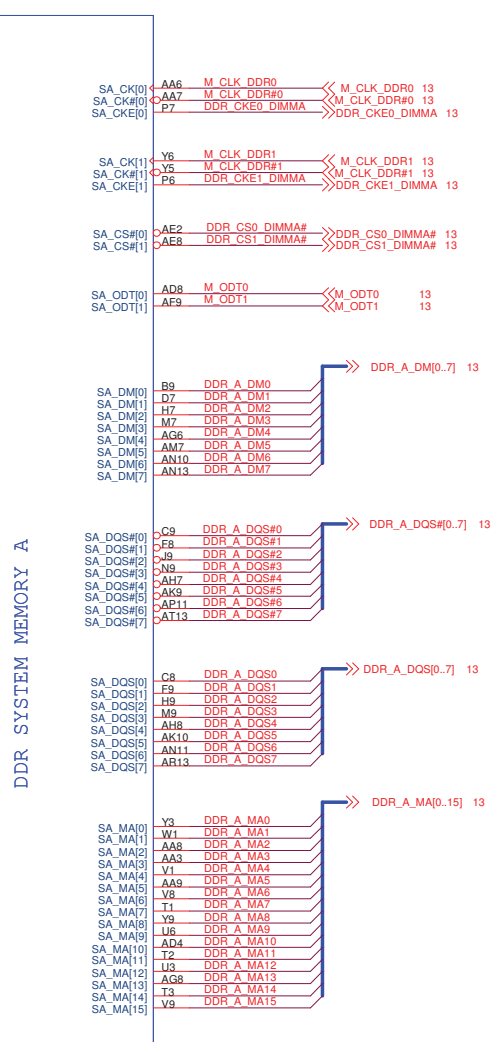
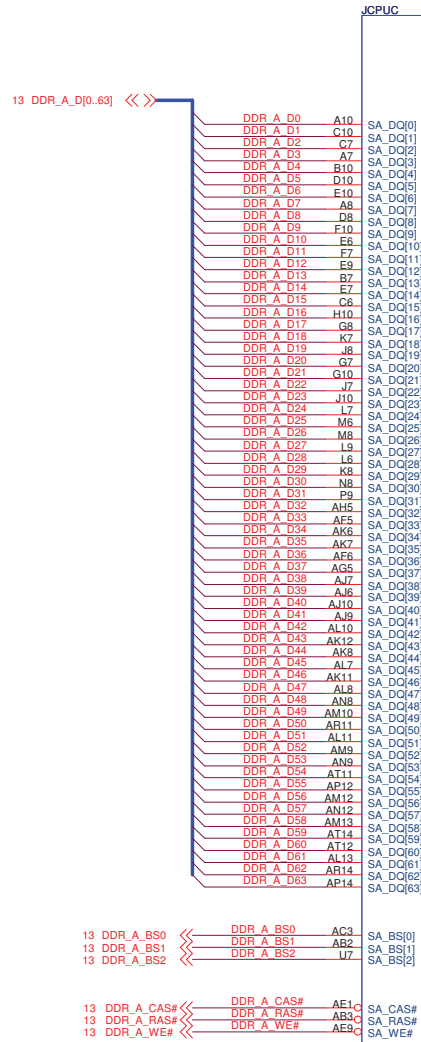


Place near JXDPI

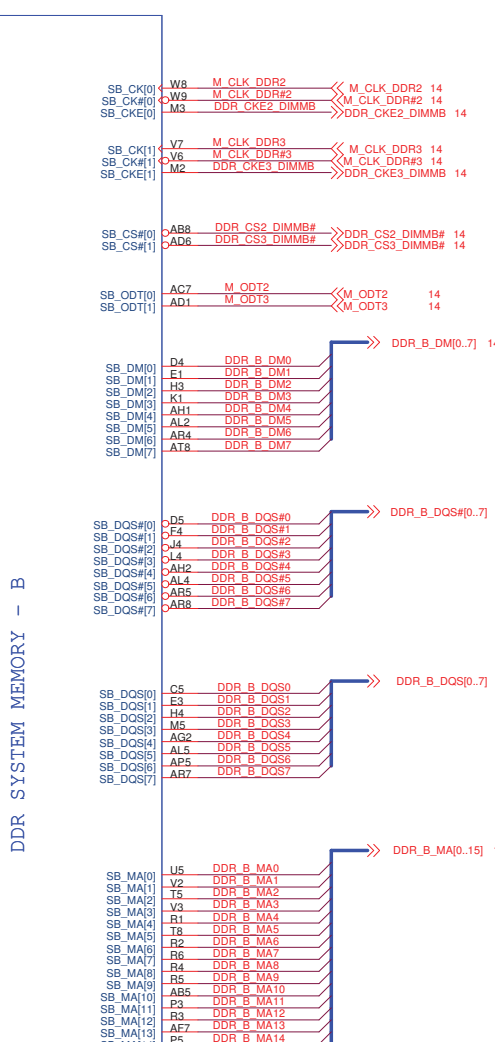
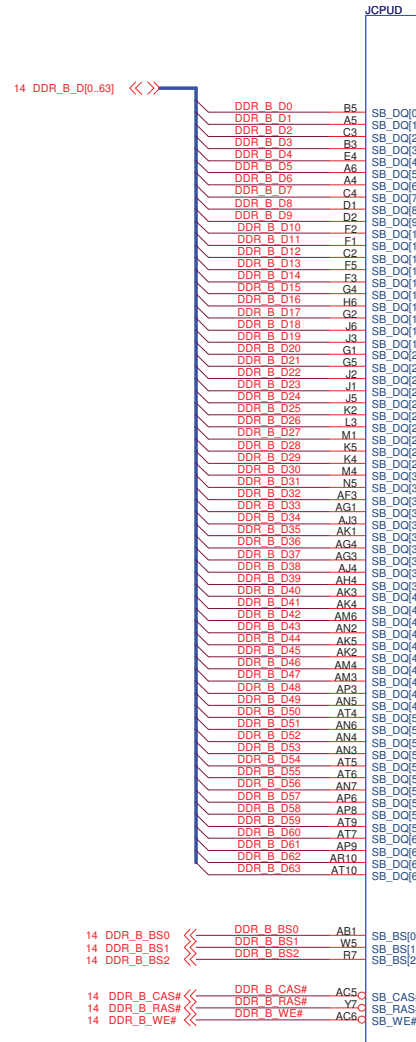


JTAG MAPPING





REV1.0
TYCO_CALPELLA_AUBURNDALE



REV1.0
TYCO_CALPELLA_AUBURNDALE

13 DDR_A_D[0..63] <<<

14 DDR_B_D[0..63] <<<

13 DDR_A_BS0 <<< DDR A BS0 AC3 SA_BS[0]
13 DDR_A_BS1 <<< DDR A BS1 AB2 SA_BS[1]
13 DDR_A_BS2 <<< DDR A BS2 U7 SA_BS[2]

14 DDR_B_BS0 <<< DDR B BS0 AB1 SB_BS[0]
14 DDR_B_BS1 <<< DDR B BS1 WS SB_BS[1]
14 DDR_B_BS2 <<< DDR B BS2 R7 SB_BS[2]

13 DDR_A_CAS# <<< DDR A CAS# AE1C SA_CAS#
13 DDR_A_RAS# <<< DDR A RAS# AB3C SA_RAS#
13 DDR_A_WE# <<< DDR A WE# AE9C SA_WE#

14 DDR_B_CAS# <<< DDR B CAS# ACS SB_CAS#
14 DDR_B_RAS# <<< DDR B RAS# YC SB_RAS#
14 DDR_B_WE# <<< DDR B WE# ACCC SB_WE#

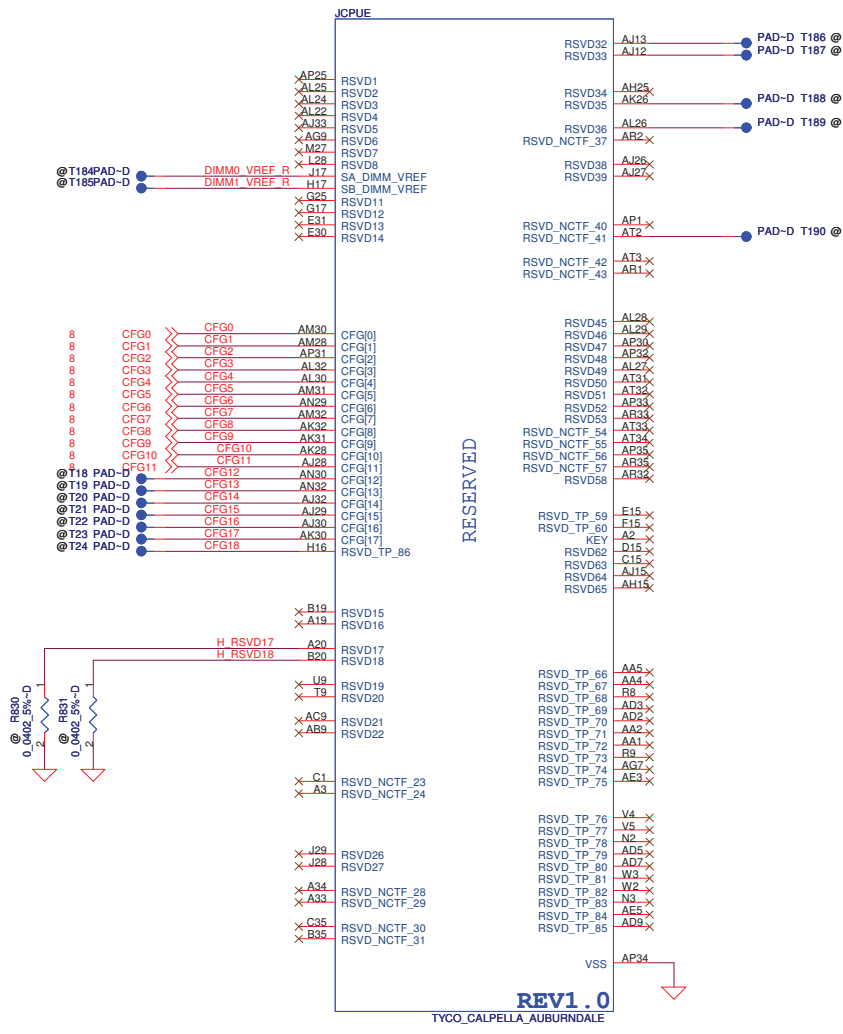
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REV1.0
TYCO_CALPELLA_AUBURNDALE

PCI-Express Configuration Select	
CFG0	1 : Single PEG 0 : Bifurcation enable

PCI-Express Static Lane Reversal	
CFG3	1 : Normal Operation 0 : Lane Number Reversed 15->0, 14->1 ...

Display Port Presence	
CFG4	1 : Disabled; No Physical Display Port attached to Embedded Display Port 0 : Enabled; An external Display Port device is connected to the Embedded Display Port

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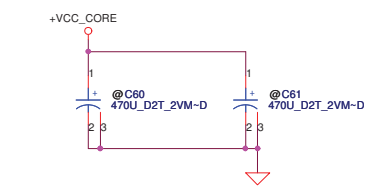
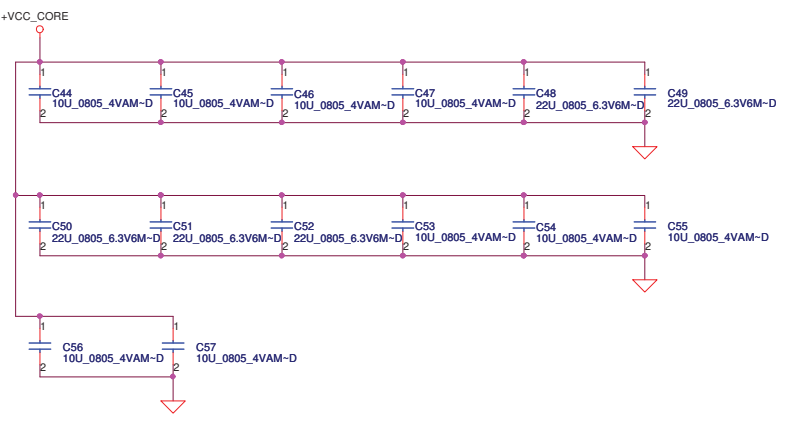
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Arrandale (4/6)



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JCPUF

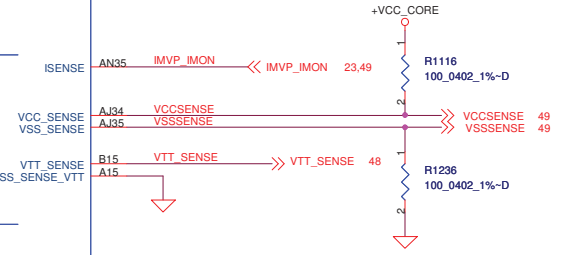
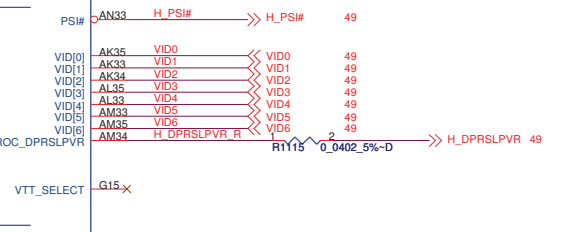
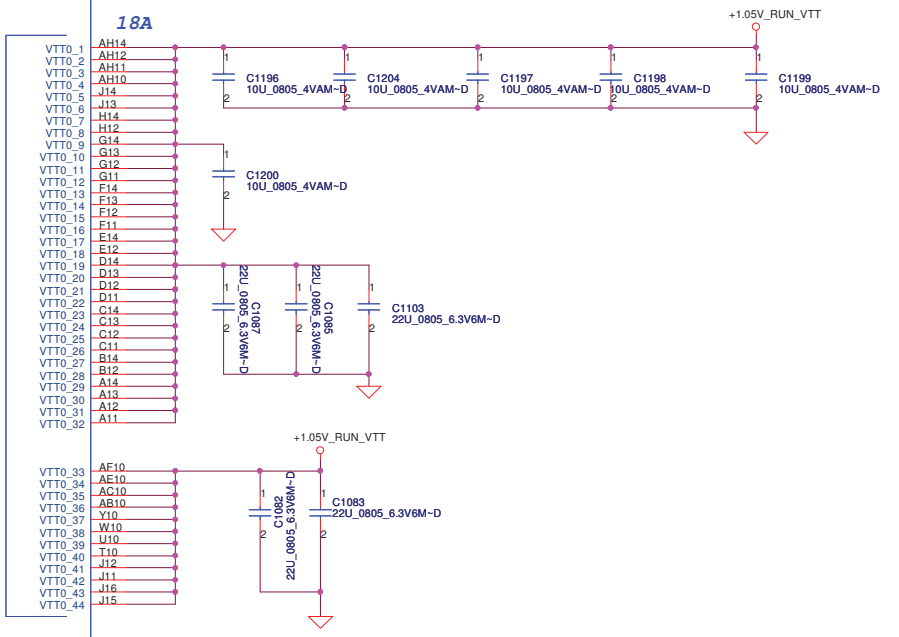
+VCC_CORE	48A
AG35	VCC1
AG34	VCC2
AG33	VCC3
AG32	VCC4
AG31	VCC5
AG30	VCC6
AG29	VCC7
AG28	VCC8
AG27	VCC9
AG26	VCC10
AF35	VCC11
AF34	VCC12
AF33	VCC13
AF32	VCC14
AF31	VCC15
AF30	VCC16
AF29	VCC17
AF28	VCC18
AF27	VCC19
AF26	VCC20
AD35	VCC21
AD34	VCC22
AD33	VCC23
AD32	VCC24
AD31	VCC25
AD30	VCC26
AD29	VCC27
AD28	VCC28
AD27	VCC29
AD26	VCC30
AC35	VCC31
AC34	VCC32
AC33	VCC33
AC32	VCC34
AC31	VCC35
AC30	VCC36
AC29	VCC37
AC28	VCC38
AC27	VCC39
AC26	VCC40
AA35	VCC41
AA34	VCC42
AA33	VCC43
AA32	VCC44
AA31	VCC45
AA30	VCC46
AA29	VCC47
AA28	VCC48
AA27	VCC49
AA26	VCC50
Y35	VCC51
Y34	VCC52
Y33	VCC53
Y32	VCC54
Y31	VCC55
Y30	VCC56
Y29	VCC57
Y28	VCC58
Y27	VCC59
Y26	VCC60
Y25	VCC61
Y24	VCC62
Y23	VCC63
Y22	VCC64
Y21	VCC65
Y20	VCC66
Y19	VCC67
Y18	VCC68
Y17	VCC69
Y16	VCC70
U35	VCC71
U34	VCC72
U33	VCC73
U32	VCC74
U31	VCC75
U30	VCC76
U29	VCC77
U28	VCC78
U27	VCC79
U26	VCC80
R35	VCC81
R34	VCC82
R33	VCC83
R32	VCC84
R31	VCC85
R30	VCC86
R29	VCC87
R28	VCC88
R27	VCC89
R26	VCC90
P34	VCC91
P33	VCC92
P32	VCC93
P31	VCC94
P30	VCC95
P29	VCC96
P28	VCC97
P27	VCC98
P26	VCC99
P25	VCC100

POWER

CPU CORE SUPPLY

SENSE LINES

1.1V RAIL POWER



REV1.0
TYCO_CALPELLA_AUBURNDALE

VTT_SELECT = low, 1.1V
VTT_SELECT = high, 1.05V

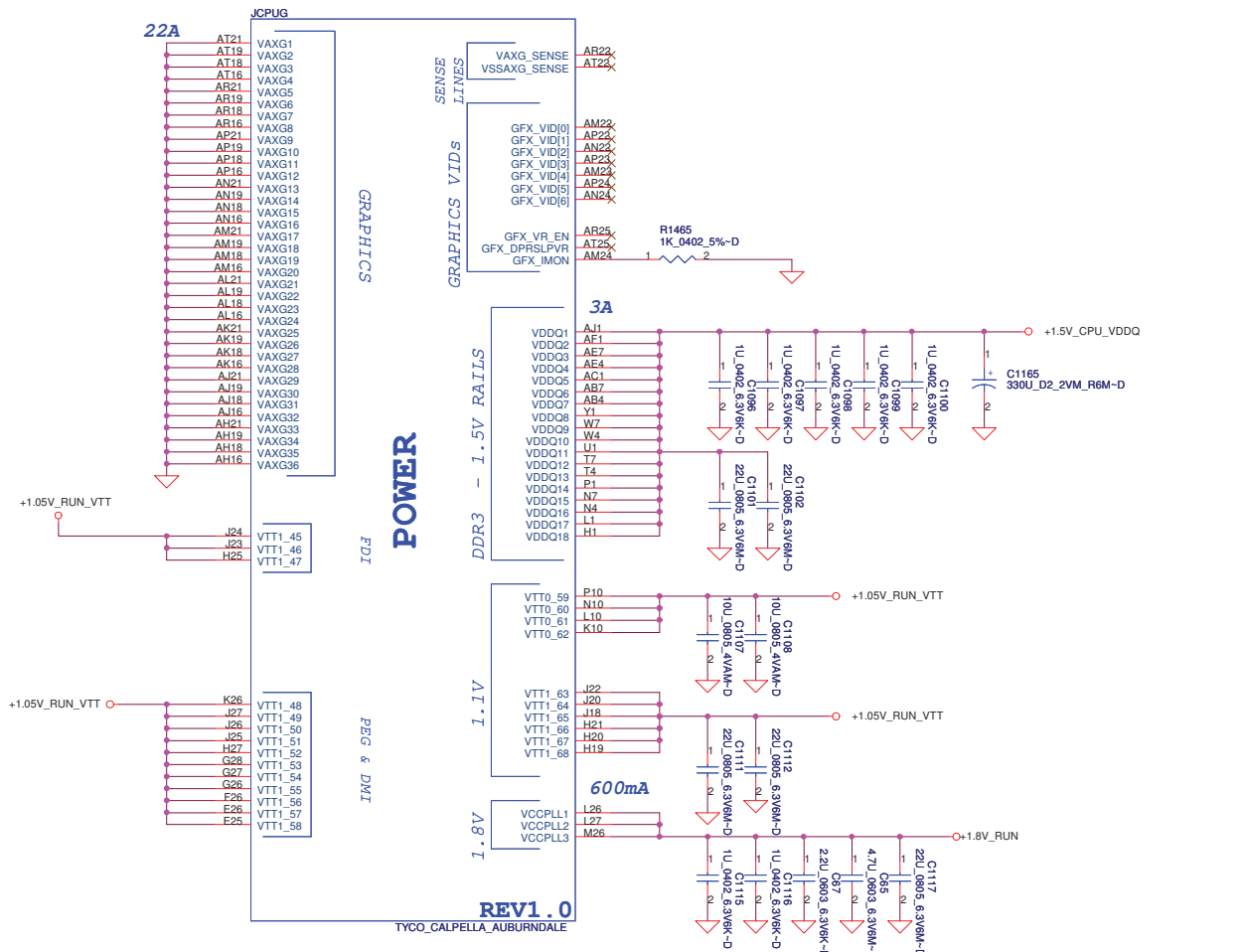
Place R1116 and R1117 near CPU
Route VCCSENSE and VSSSENSE trace at 27.4 ohms, 7 mils spacing

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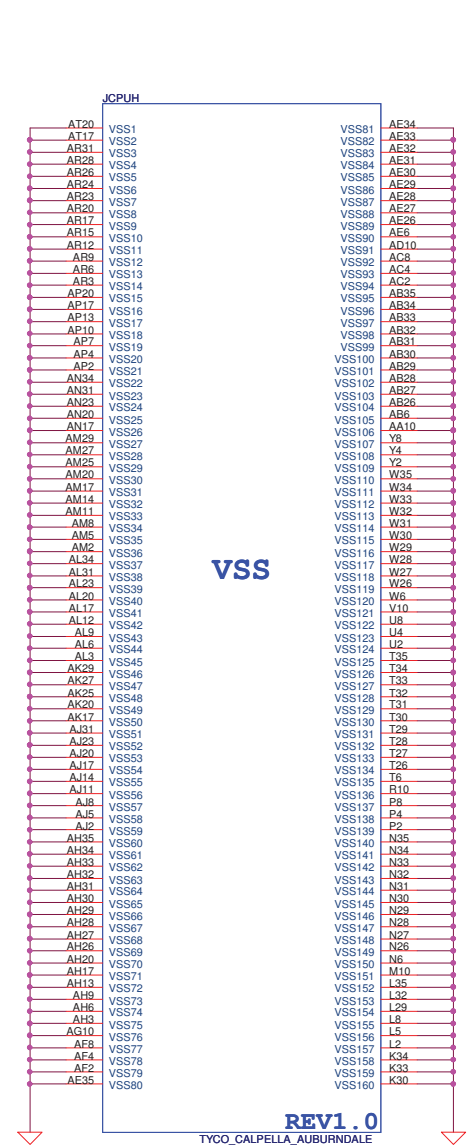
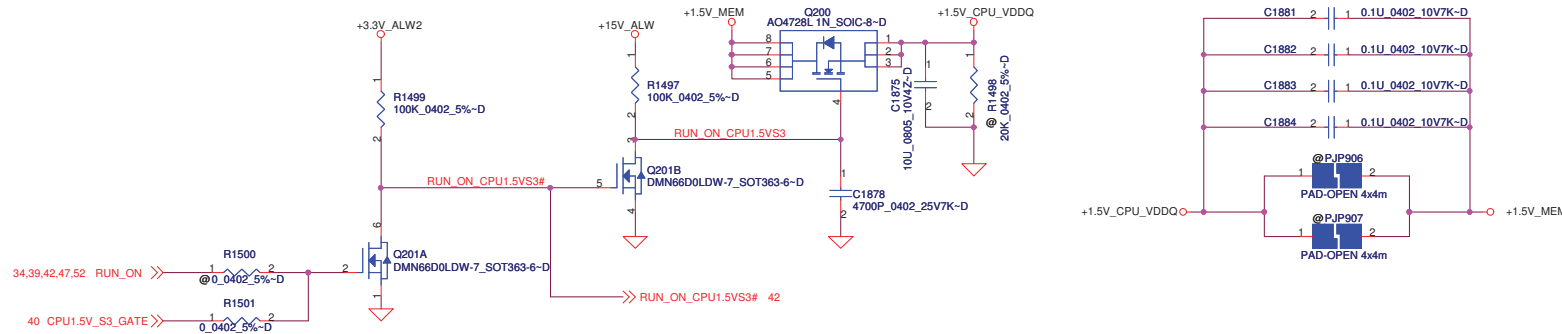
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+1.5V_CPU_VDDQ Source



REV1_0
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REV1_0
TYCO_CALPELLA_AUBURNDALE

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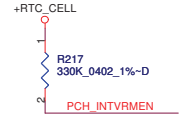
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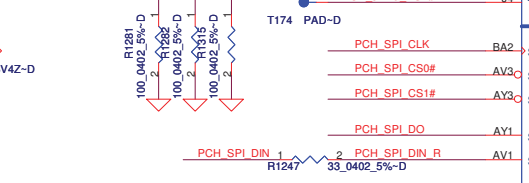
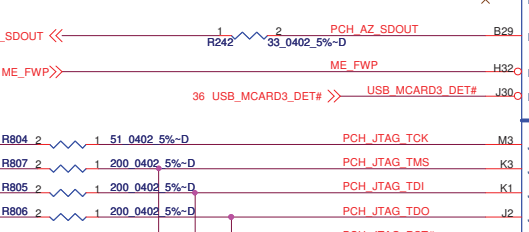
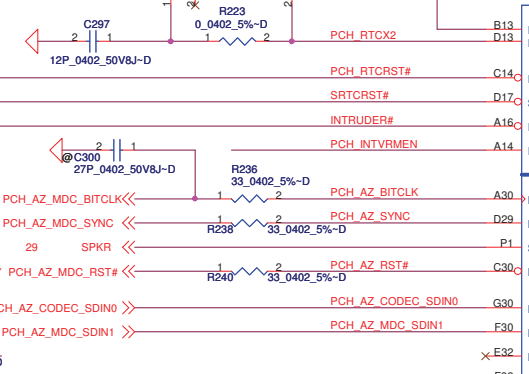
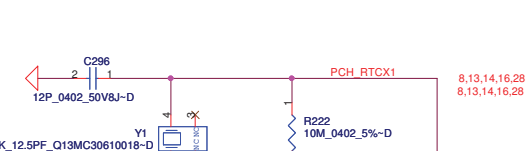
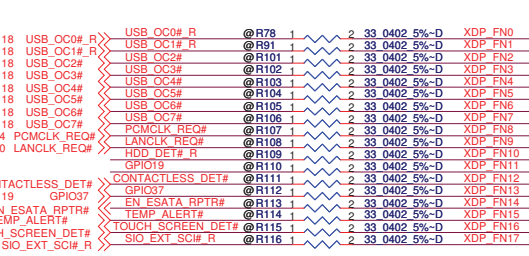
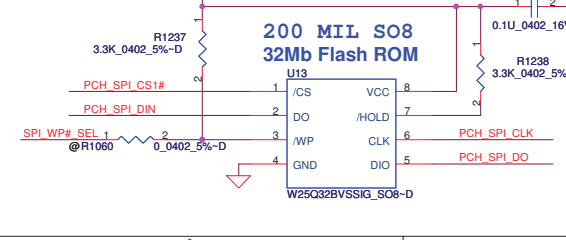
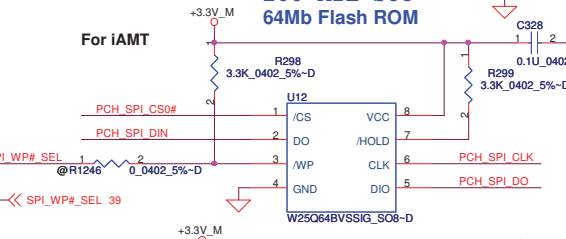
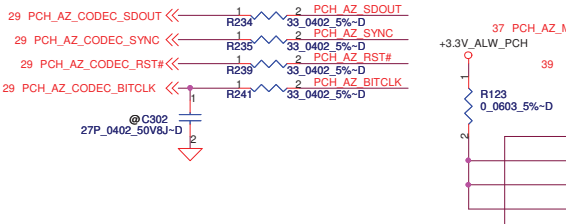
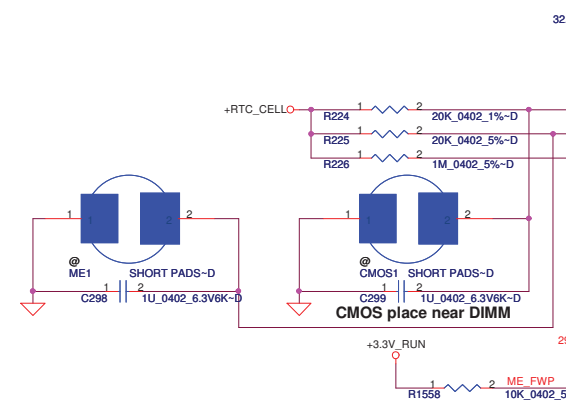
CMOS_CLR1	CMOS setting
Shunt	Clear CMOS
Open	Keep CMOS

ME_CLR1	TPM setting
Shunt	Clear ME RTC Registers
Open	Keep ME RTC Registers

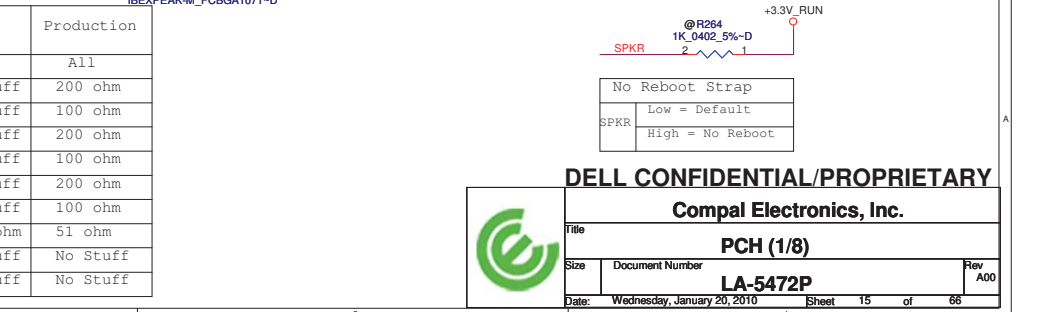
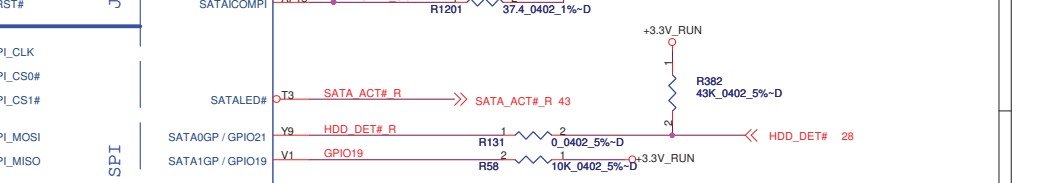
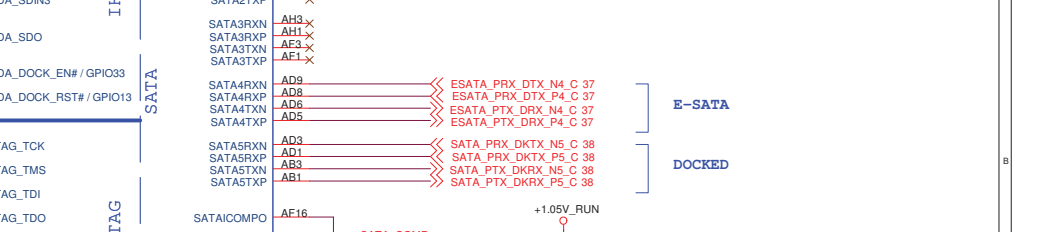
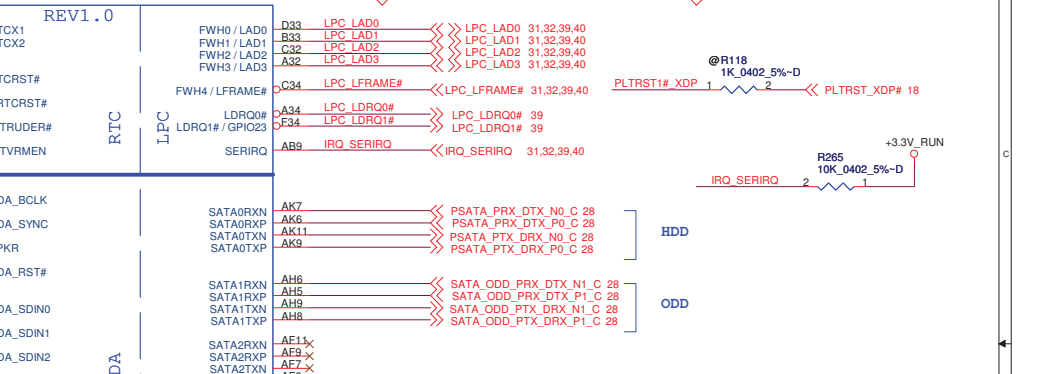
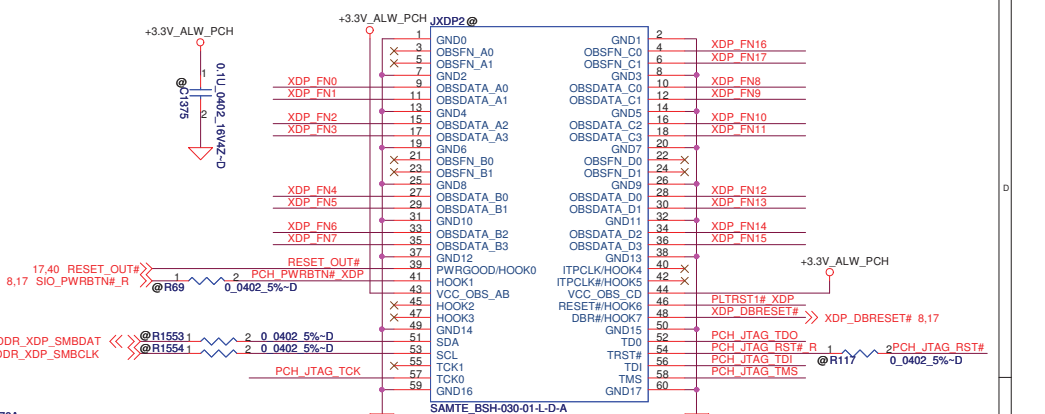


INTVRMEN- Integrated SUS
 1.1V VRM Enable
 High - Enable Internal VRs

On Die PLL VR is supplied by
 1.5V when sampled high, 1.8 V
 when sampled low



PCH Pin	Ref.	PCH JTAG Enable		PCH JTAG Disable		Production
		ES1	ES2	ES1	ES2	
TDO	R806	No Stuff	200 ohm	No Stuff	No Stuff	200 ohm
	R1315	No Stuff	100 ohm	No Stuff	No Stuff	100 ohm
TMS	R807	200 ohm	200 ohm	No Stuff	No Stuff	200 ohm
	R1281	100 ohm	100 ohm	No Stuff	No Stuff	100 ohm
TDI	R805	200 ohm	200 ohm	20K ohm	No Stuff	200 ohm
	R1282	100 ohm	100 ohm	10K ohm	No Stuff	100 ohm
TCK	R804	4.7K ohm	4.7K ohm	4.7K ohm	4.7K ohm	51 ohm
TRST#	R808	20K ohm	No Stuff	No Stuff	No Stuff	No Stuff
	R1316	10K ohm	No Stuff	No Stuff	No Stuff	No Stuff



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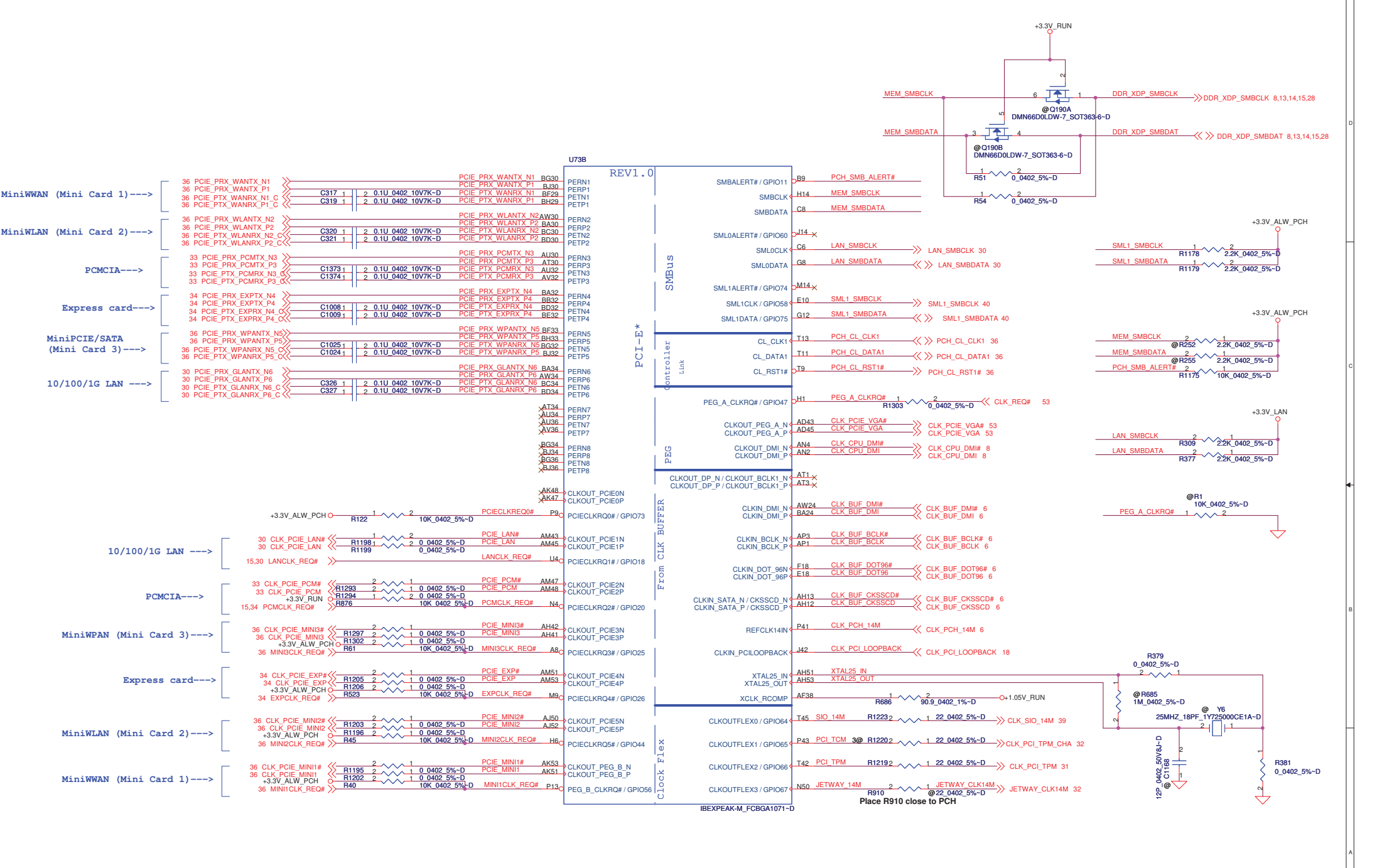
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PCH (1/8)

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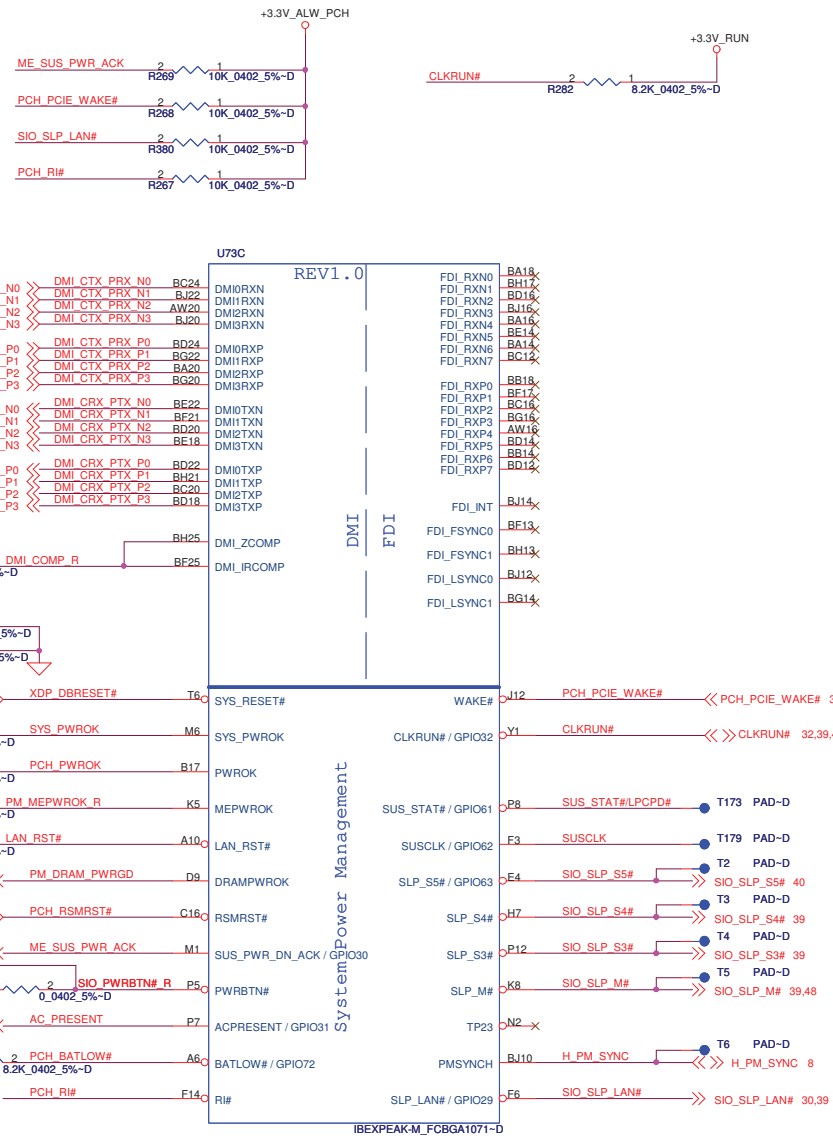
Title: PCH (2/8)

Size: Document Number LA-5472P

Date: Wednesday, January 20, 2010

Rev: A00

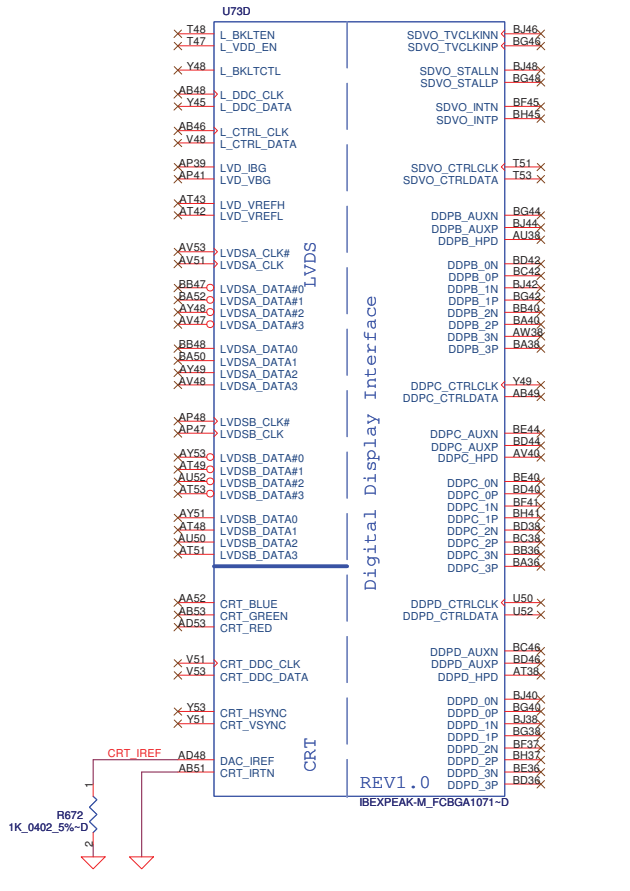
Sheet 16 of 66

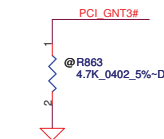
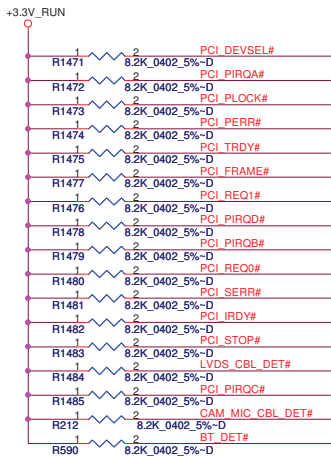


Intel WW18 Strapping option

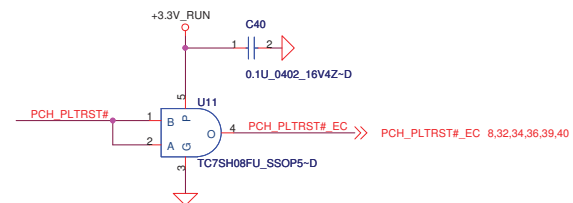
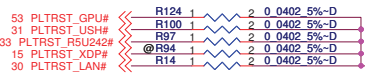
PORT	STRAP	ENABLE	DISABLE
LVDS	L_DDC_DATA	PU to 3.3V through 2.2Kohm	NC
PORT B	SDVO_CTRLDATA	PU to 3.3V through 2.2Kohm	NC
PORT B	DDPC_CTRLDATA	PU to 3.3V through 2.2Kohm	NC
PORT B	DDPD_CTRLDATA	PU to 3.3V through 2.2Kohm	NC
eDP on CPU	CFG[4] (at CPU)	PD to GND through 3.3Kohm	NC

Intel request DDPB can not support eDP

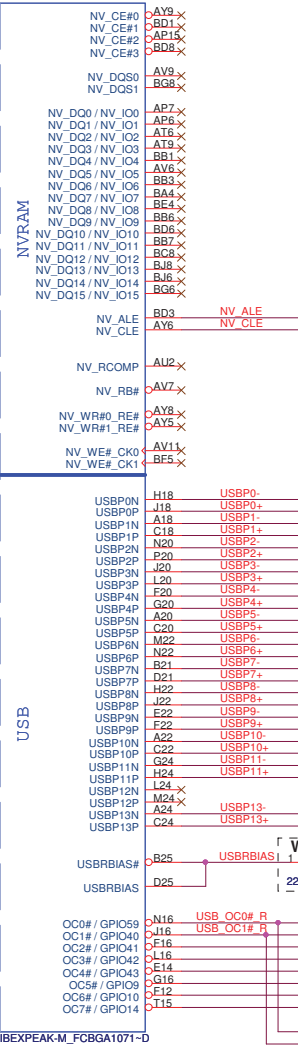
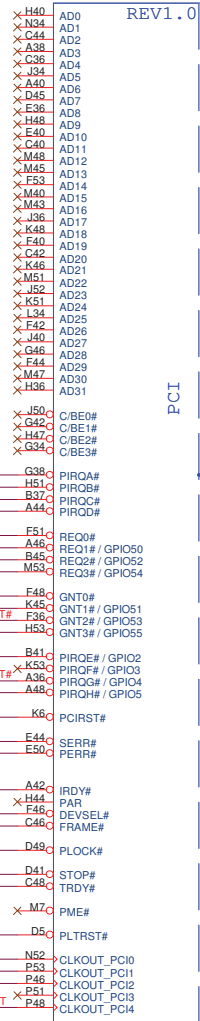




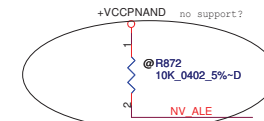
A16 swap override Strap/Top-Block Swap Override jumper	
PCI_GNT#3	Low = A16 swap High = Default



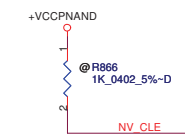
U73E
REV 1.0



PCH XDP ENABLE	Stuff: R78,R89,R101~R116
	No Stuff: R71,R77,RP1,RP2,R45,R40,R131,R58,R1242,R1243,R1244,R1245,R74,R130
PCH XDP DISABLE	Stuff: R71,R77,RP1,RP2,R45,R40,R131,R58,R1242,R1243,R1244,R1245,R74,R130
	No Stuff: R78,R89,R101~R116



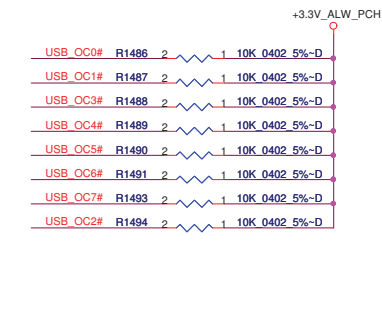
Danbury Technology Enabled	
NV_ALE	High = Enabled (Default) Low = Disabled



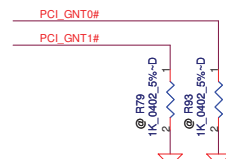
DMI Termination Voltage	
NV_CLE	Set to Vss when LOW Set to Vcc when HIGH

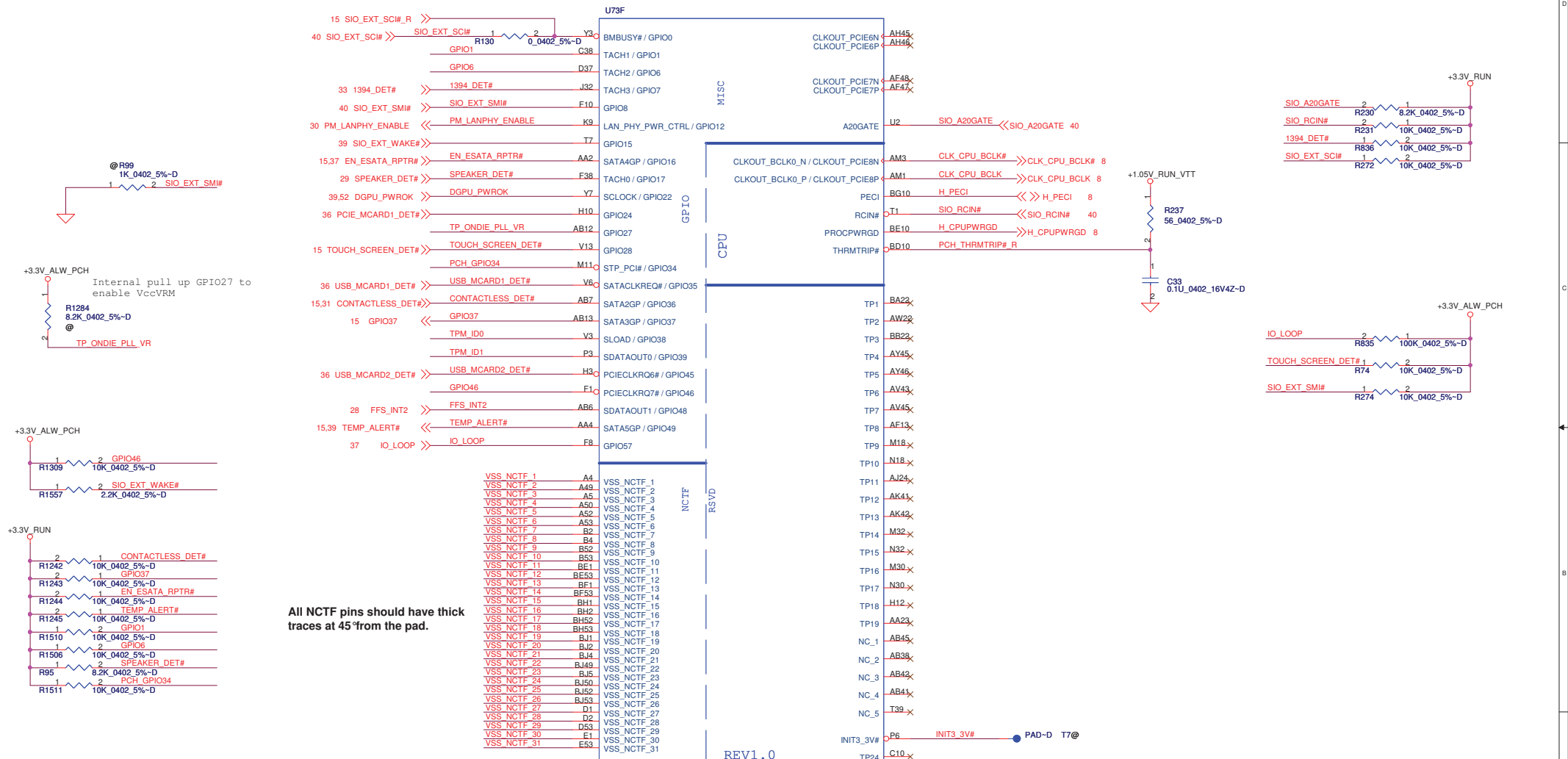
- >Right Side Top
- >Right Side Bottom
- >Left Side Top
- >Left Side Bottom
- >WLAN
- >Blue Tooth
- >BIO_USH
- >DOCK
- >Express Card
- >Camera
- >WPAN

change base on Rothschild layout concern.



PCI_GNT#1	PCI_GNT#0	Boot BIOS Location
0	0	LPC
0	1	Reserved (NAND)
1	0	PCI
1	1	SPI





All NCTF pins should have thick traces at 45° from the pad.

	TPM_ID0	TPM_ID1
China TPM	0	0
No TPM, No China TPM	0	1
Reserved	1	0
TPM	1	1

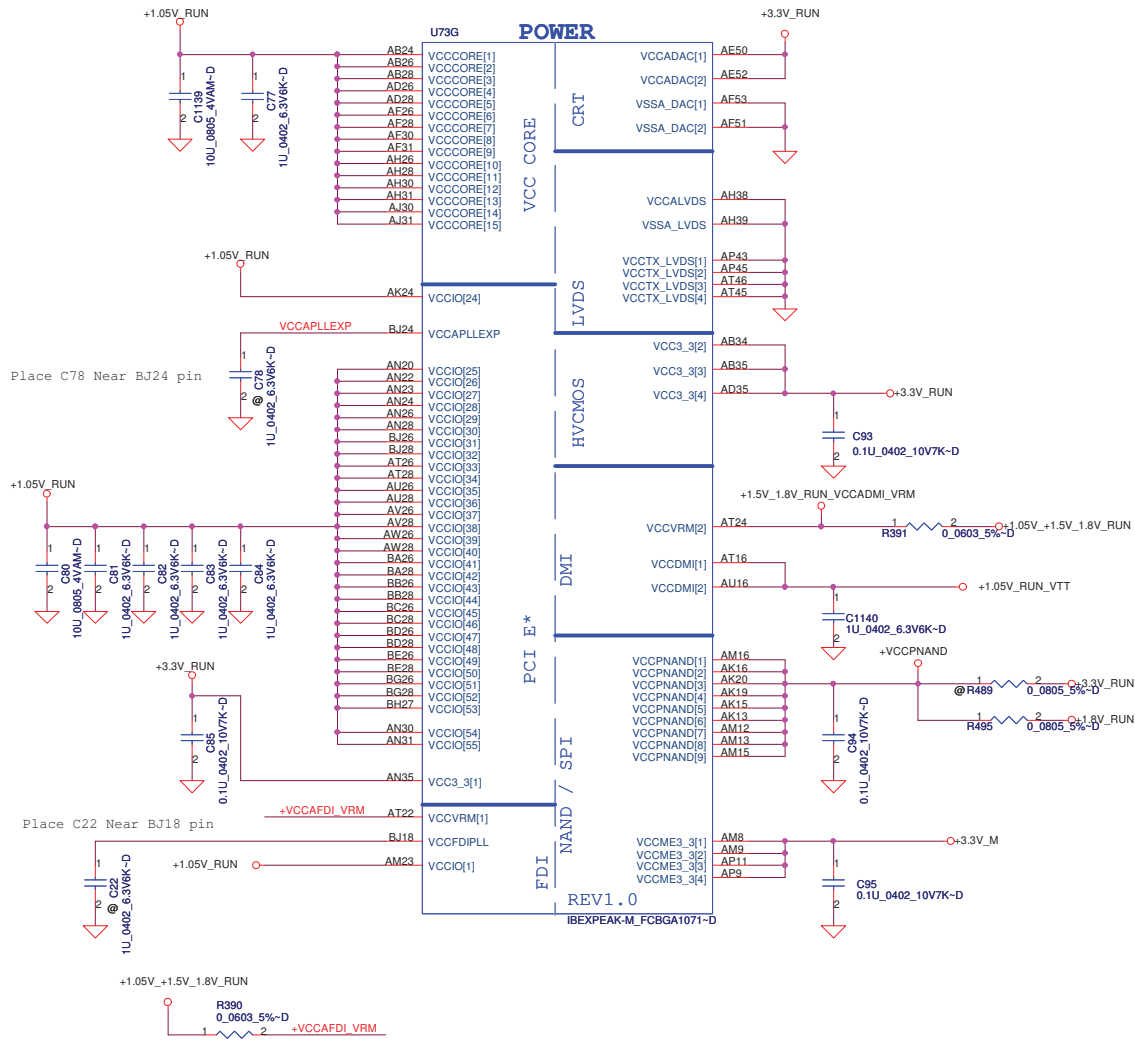


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PCH (5/8)

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NOTE: Refer to schematic check list rev2.0, VccVRM no support 1.5V and R96 can be removed.

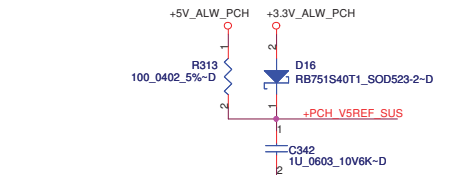
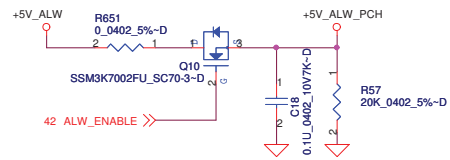
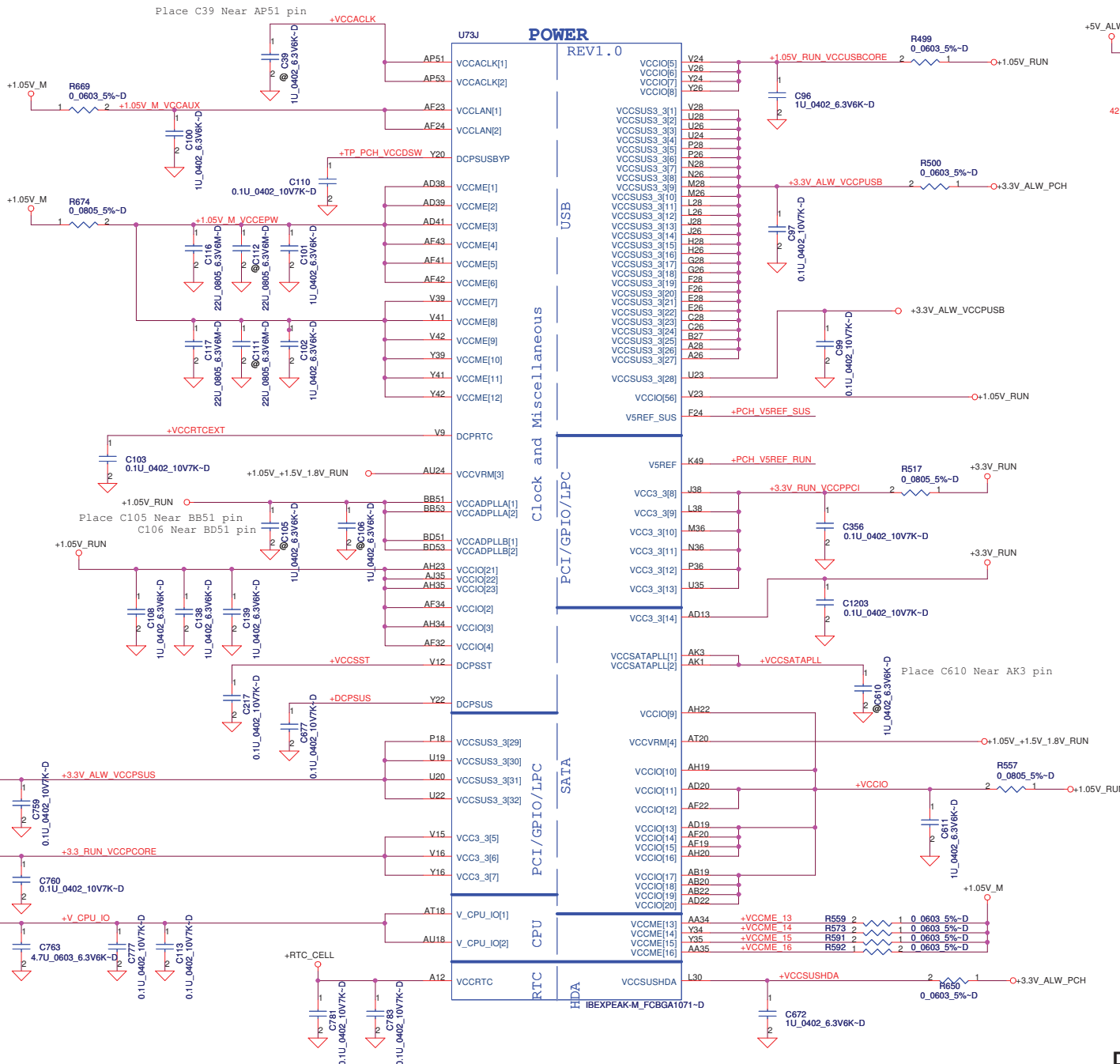
PCH Power Rail Table		
Voltage Rail	Voltage	SO Iccmax Current (A)
V_CPU_IO	1.1/1.05	< 1 (mA)
V5REF	5	< 1 (mA)
V5REF_Sus	5	< 1 (mA)
Vcc_3	3.3	0.357
VccAClk	1.1	0.052
VccADAC	3.3	0.069
VccADPLLA	1.1	0.068
VccADPLLB	1.1	0.069
Vccap11EXP	1.1	0.04
VccCore	1.1	1.432
VccDMI	1.1	0.058
VccDMI	1.1	0.061
VccFDIPLL	1.1	0.037
VccIO	1.1	3.062
VccLAN	1.1	0.32
VccME	1.1	1.849
VccME3_3	3.3	0.085
VccpNAND	1.8	0.156
VccRTC	3.3	2 (mA)
VccSATAPLL	1.1	0.031
VccSus_3_3	3.3	0.163
VccSusHDA	3.3	0.006
VccVRM	1.8 / 1.5	0.196
VccALVDS	3.3	< 1 (mA)
VccTX_LVDS	1.8	0.059



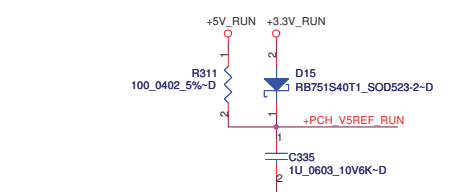
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U73H		U73H	
AB16	VSS[0]		
AA19	VSS[1]	AK30	VSS[90]
AA20	VSS[2]	AK31	VSS[91]
AA22	VSS[3]	AK32	VSS[92]
AM19	VSS[4]	AK34	VSS[93]
AA24	VSS[5]	AK35	VSS[94]
AA26	VSS[6]	AK38	VSS[95]
AA28	VSS[7]	AK43	VSS[96]
AA30	VSS[8]	AK46	VSS[97]
AA31	VSS[9]	AK49	VSS[98]
AA32	VSS[10]	AK5	VSS[99]
AB11	VSS[11]	AK6	VSS[100]
AB15	VSS[12]	AL2	VSS[91]
AB23	VSS[13]	AL52	VSS[92]
AB30	VSS[14]	AM11	VSS[93]
AB31	VSS[15]	BB44	VSS[94]
AB32	VSS[16]	AD24	VSS[95]
AB39	VSS[17]	AM20	VSS[96]
AB43	VSS[18]	AM22	VSS[97]
AB47	VSS[19]	AM24	VSS[98]
AB5	VSS[20]	AM26	VSS[99]
AB8	VSS[21]	AM28	VSS[100]
AC2	VSS[22]	BA42	VSS[101]
AC52	VSS[23]	AM30	VSS[102]
AD11	VSS[24]	AM31	VSS[103]
AD12	VSS[25]	AM32	VSS[104]
AD16	VSS[26]	AM34	VSS[105]
AD23	VSS[27]	AM35	VSS[106]
AD30	VSS[28]	AM38	VSS[107]
AD31	VSS[29]	AM39	VSS[108]
AD32	VSS[30]	AM42	VSS[109]
AD34	VSS[31]	AU20	VSS[110]
AU22	VSS[32]	AM46	VSS[111]
AD42	VSS[33]	AV22	VSS[112]
AD46	VSS[34]	AM49	VSS[113]
AD49	VSS[35]	AM7	VSS[114]
AD7	VSS[36]	AA50	VSS[115]
AE2	VSS[37]	BB10	VSS[116]
AE4	VSS[38]	AN48	VSS[117]
AF12	VSS[39]	AN50	VSS[118]
Y13	VSS[40]	AN52	VSS[119]
AH49	VSS[41]	AP12	VSS[120]
AU4	VSS[42]	AP23	VSS[121]
AF35	VSS[43]	AP46	VSS[122]
AP13	VSS[44]	AP49	VSS[123]
AN34	VSS[45]	AP24	VSS[124]
AF45	VSS[46]	AP2	VSS[125]
AF46	VSS[47]	AR2	VSS[126]
AF49	VSS[48]	AR52	VSS[127]
AF5	VSS[49]	AT11	VSS[128]
AF9	VSS[50]	BH12	VSS[129]
AG2	VSS[51]	AH48	VSS[130]
AG52	VSS[52]	AT32	VSS[131]
AH11	VSS[53]	AT36	VSS[132]
AH15	VSS[54]	AT41	VSS[133]
AH16	VSS[55]	AT47	VSS[134]
AH24	VSS[56]	AT7	VSS[135]
AH32	VSS[57]	AV12	VSS[136]
AV18	VSS[58]	AV16	VSS[137]
AH43	VSS[59]	AV20	VSS[138]
AH7	VSS[60]	AV24	VSS[139]
AJ19	VSS[61]	AV30	VSS[140]
AJ2	VSS[62]	AV34	VSS[141]
AJ20	VSS[63]	AV42	VSS[142]
AJ22	VSS[64]	AV46	VSS[143]
AJ23	VSS[65]	AV49	VSS[144]
AJ26	VSS[66]	AV5	VSS[145]
AJ28	VSS[67]	AV8	VSS[146]
AJ32	VSS[68]	AW14	VSS[147]
AJ34	VSS[69]	AW18	VSS[148]
AT5	VSS[70]	AW2	VSS[149]
AJ4	VSS[71]	BF9	VSS[150]
AK12	VSS[72]	AW32	VSS[151]
AM41	VSS[73]	AW36	VSS[152]
AN19	VSS[74]	AW40	VSS[153]
AK26	VSS[75]	AW52	VSS[154]
AK22	VSS[76]	AY11	VSS[155]
AK23	VSS[77]	AY43	VSS[156]
AK28	VSS[78]	AY47	VSS[157]
AK28	VSS[79]		VSS[158]

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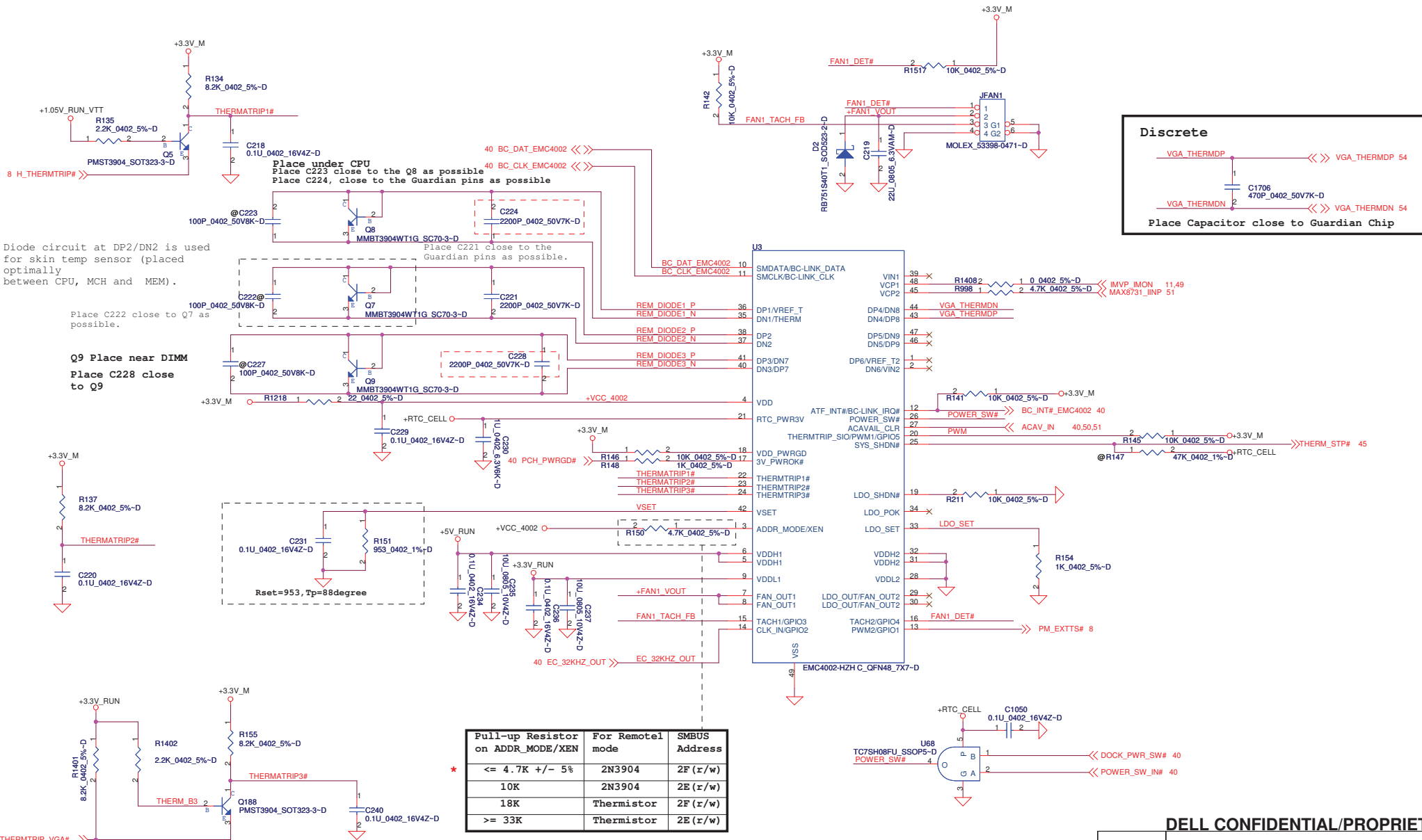
U73I		U73I	
AY7	VSS[159]	H49	VSS[258]
B11	VSS[160]	H5	VSS[260]
B15	VSS[161]	J24	VSS[261]
B19	VSS[162]	K11	VSS[262]
B23	VSS[163]	K43	VSS[263]
B31	VSS[164]	K47	VSS[264]
B35	VSS[165]	K7	VSS[265]
B39	VSS[166]	L14	VSS[266]
B43	VSS[167]	L18	VSS[267]
B47	VSS[168]	L2	VSS[268]
B7	VSS[169]	L22	VSS[269]
B12	VSS[170]	L36	VSS[270]
BB16	VSS[171]	L40	VSS[271]
BB20	VSS[172]	L52	VSS[272]
BB24	VSS[173]	M12	VSS[273]
BB30	VSS[174]	M16	VSS[274]
BB34	VSS[175]	M20	VSS[275]
BB38	VSS[176]	M38	VSS[276]
BB42	VSS[177]	M42	VSS[277]
BB49	VSS[178]	M44	VSS[278]
BB5	VSS[179]	M49	VSS[279]
BC10	VSS[180]	M5	VSS[280]
BC14	VSS[181]	M46	VSS[281]
BC18	VSS[182]	M49	VSS[282]
BC2	VSS[183]	M8	VSS[283]
BC22	VSS[184]	M5	VSS[284]
BC22	VSS[185]	N24	VSS[285]
BC32	VSS[186]	P11	VSS[286]
BC36	VSS[187]	AD15	VSS[287]
BC40	VSS[188]	P22	VSS[288]
BC44	VSS[189]	P30	VSS[289]
BC52	VSS[190]	P32	VSS[290]
BH9	VSS[191]	P4	VSS[291]
BD48	VSS[192]	P42	VSS[292]
BD49	VSS[193]	P45	VSS[293]
BD5	VSS[194]	P47	VSS[294]
BE12	VSS[195]	R2	VSS[295]
BE16	VSS[196]	R2	VSS[296]
BE20	VSS[197]	R52	VSS[297]
BE24	VSS[198]	T12	VSS[298]
BE30	VSS[199]	T41	VSS[299]
BE38	VSS[200]	T46	VSS[300]
BE42	VSS[201]	T49	VSS[301]
BE46	VSS[202]	T8	VSS[302]
BE49	VSS[203]	U30	VSS[303]
BE50	VSS[204]	U31	VSS[304]
BE50	VSS[205]	U32	VSS[305]
BE6	VSS[206]	U34	VSS[306]
BE8	VSS[207]	U38	VSS[307]
BE9	VSS[208]	P16	VSS[308]
BE9	VSS[209]	P18	VSS[309]
BG18	VSS[210]	V19	VSS[310]
BG18	VSS[211]	V20	VSS[311]
BG24	VSS[212]	V22	VSS[312]
BG4	VSS[213]	V30	VSS[313]
BG50	VSS[214]	V31	VSS[314]
BH11	VSS[215]	V32	VSS[315]
BH15	VSS[216]	V34	VSS[316]
BH19	VSS[217]	V36	VSS[317]
BH23	VSS[218]	V38	VSS[318]
BH31	VSS[219]	V43	VSS[319]
BH35	VSS[220]	V45	VSS[320]
BH39	VSS[221]	V46	VSS[321]
BH43	VSS[222]	V47	VSS[322]
BH47	VSS[223]	V49	VSS[323]
BH7	VSS[224]	V5	VSS[324]
C12	VSS[225]	V7	VSS[325]
C50	VSS[226]	V8	VSS[326]
D51	VSS[227]	W2	VSS[327]
E12	VSS[228]	W52	VSS[328]
E20	VSS[229]	Y11	VSS[329]
E24	VSS[230]	Y15	VSS[330]
E34	VSS[231]	Y19	VSS[331]
E38	VSS[232]	Y23	VSS[332]
E38	VSS[233]	Y28	VSS[333]
E42	VSS[234]	Y28	VSS[334]
E42	VSS[235]	Y30	VSS[335]
E46	VSS[236]	Y31	VSS[336]
E48	VSS[237]	Y32	VSS[337]
E8	VSS[238]	Y38	VSS[338]
F49	VSS[239]	Y43	VSS[339]
F5	VSS[240]	Y46	VSS[340]
G10	VSS[241]	Y49	VSS[341]
G14	VSS[242]	Y5	VSS[342]
G18	VSS[243]	Y6	VSS[343]
G2	VSS[244]	Y8	VSS[344]
G22	VSS[245]	P24	VSS[345]
G32	VSS[246]	T43	VSS[346]
G36	VSS[247]	AD51	VSS[347]
G40	VSS[248]	AT8	VSS[348]
G44	VSS[249]	AD47	VSS[349]
G52	VSS[250]	Y47	VSS[350]
AF39	VSS[251]	AT12	VSS[351]
H16	VSS[252]	AM6	VSS[352]
H20	VSS[253]	AT13	VSS[353]
H30	VSS[254]	AM5	VSS[354]
H34	VSS[255]	AK45	VSS[355]
H38	VSS[256]	AK39	VSS[356]
H42	VSS[257]	AV14	VSS[366]
	VSS[258]		

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FAN & Thermal Sensor

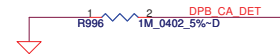
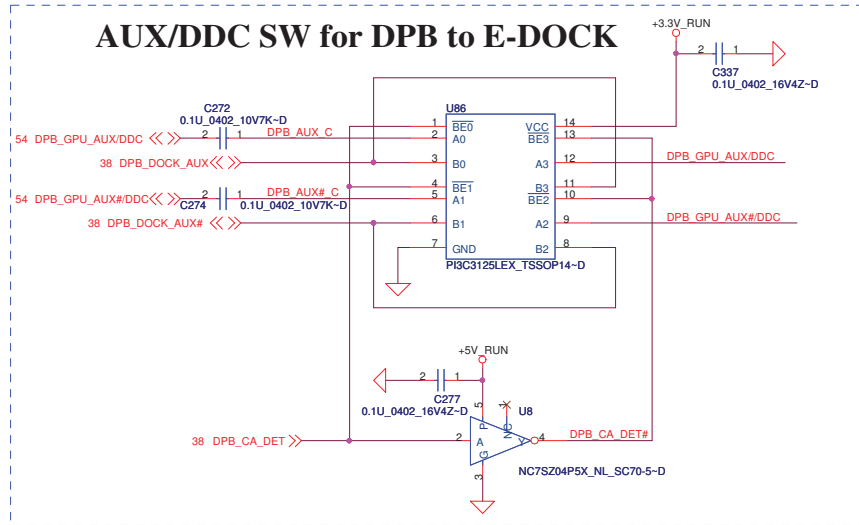
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AUX/DDC SW for DPB to E-DOCK



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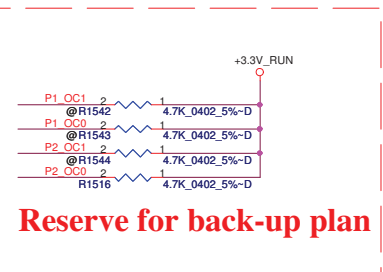
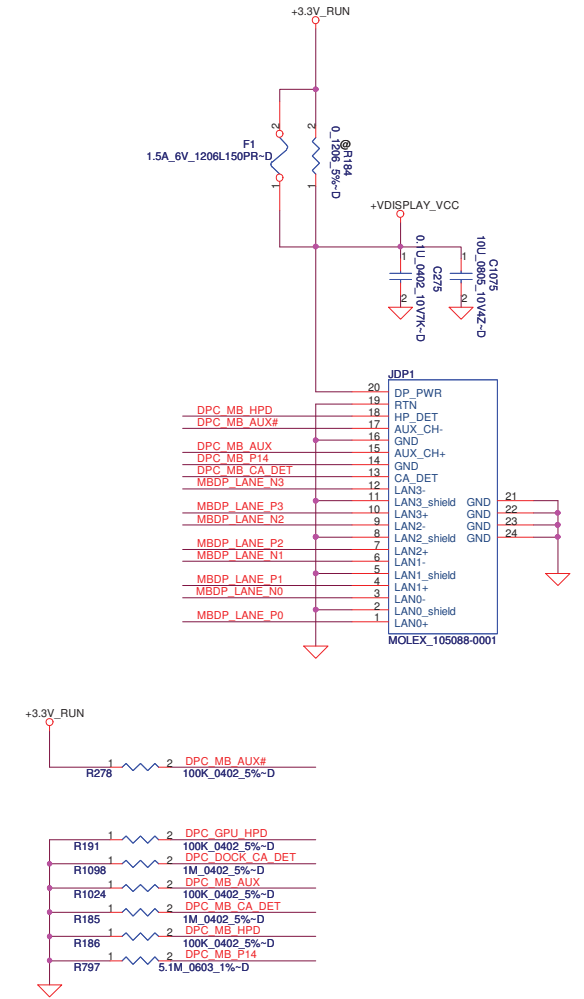
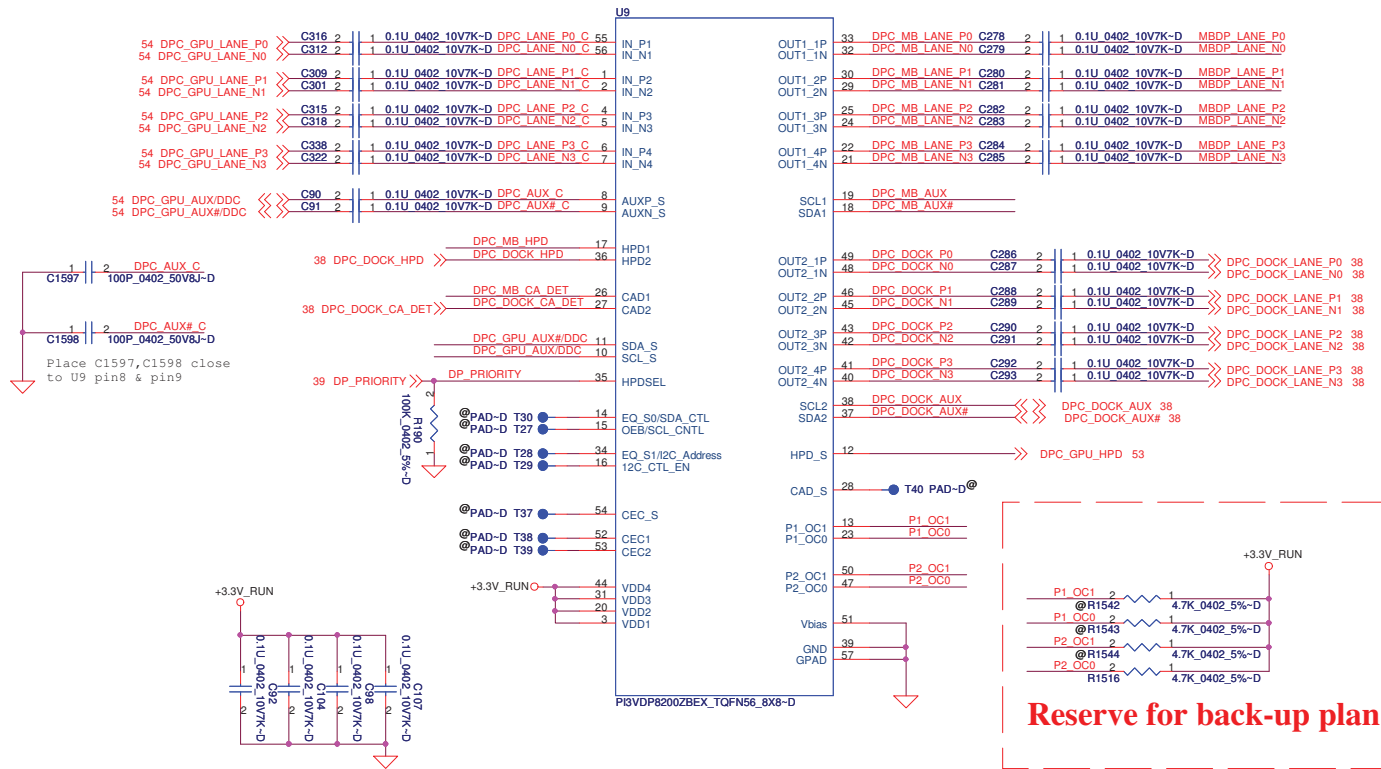
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DPB AUX SW for DOCK			A00		
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Display port Connector

DPB SW for MB & DOCK



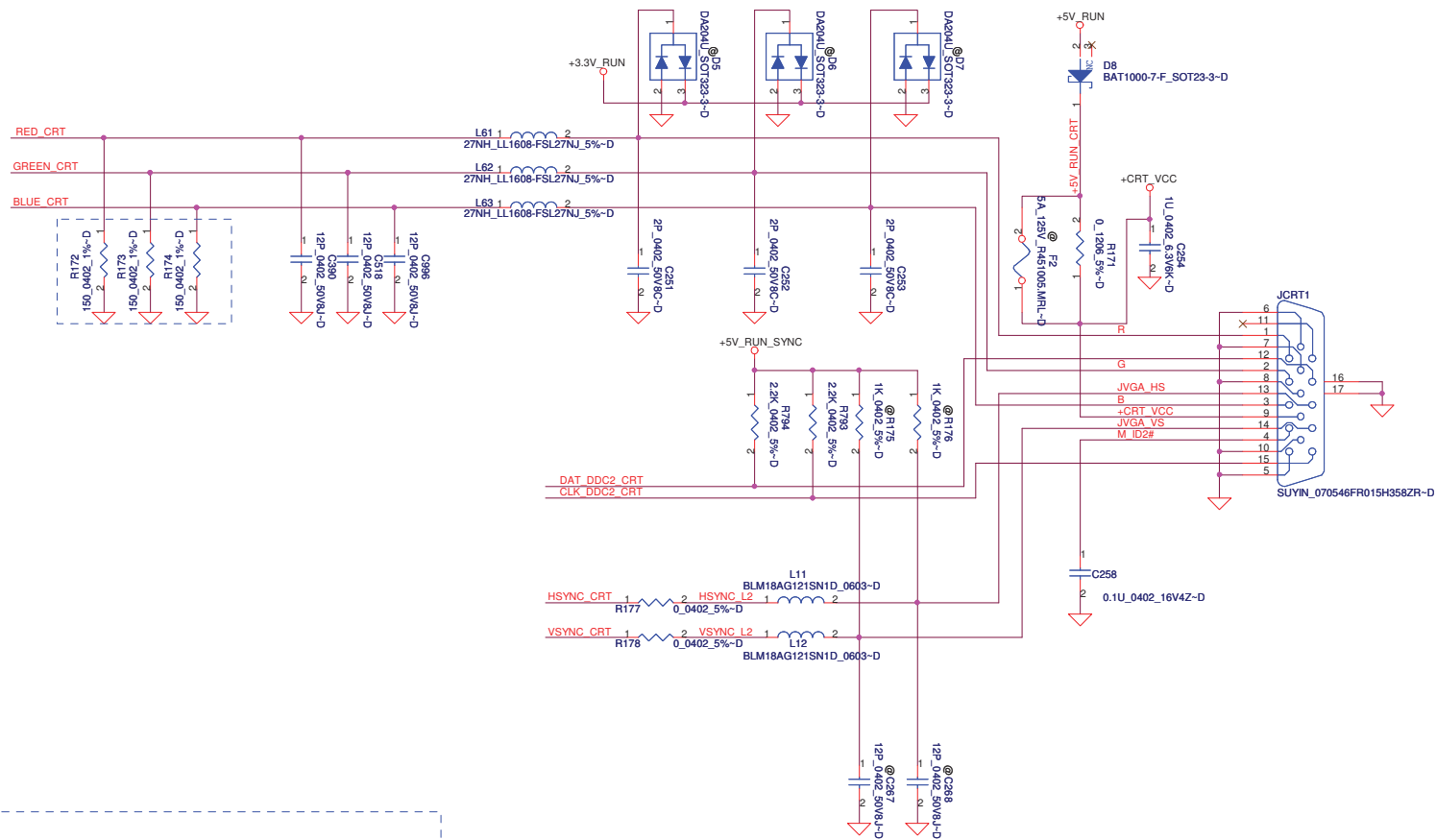
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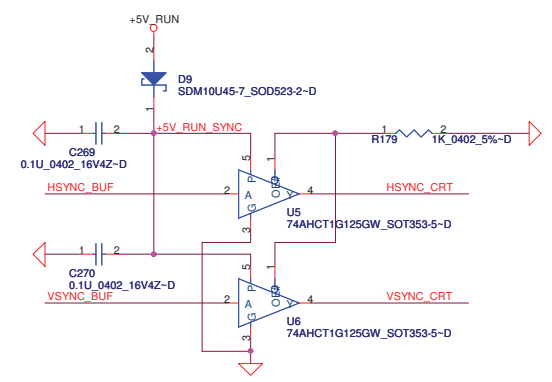
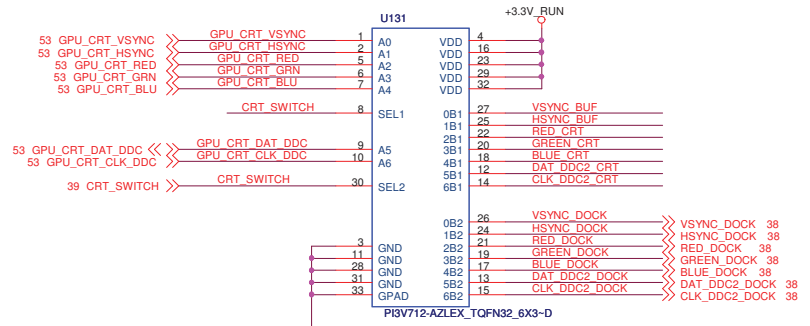
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Display port			
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VGA SW for MB/DOCK



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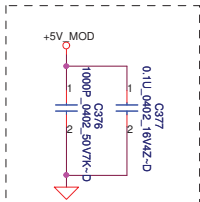
Compal Electronics, Inc.

Title: **CRT/Video switch**

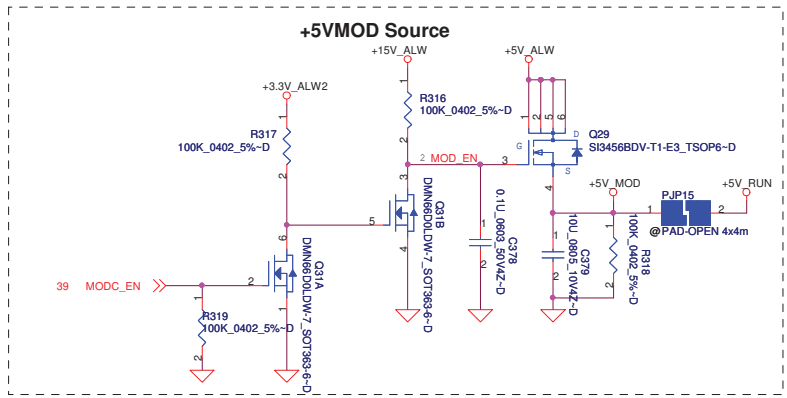
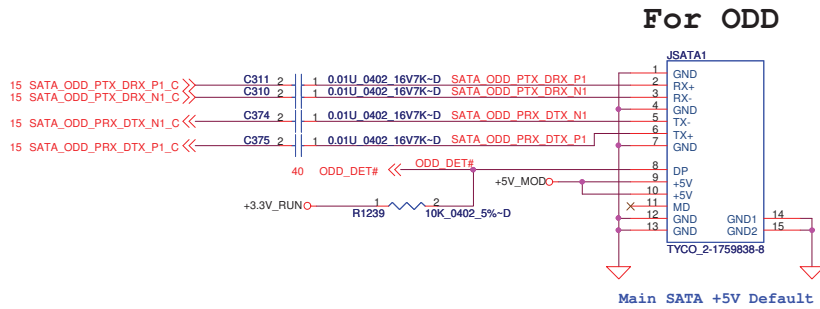
Size: **LA-5472P**

Date: **Wednesday, January 20, 2010**

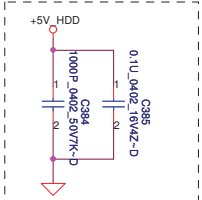
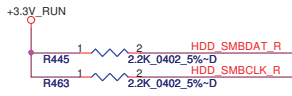
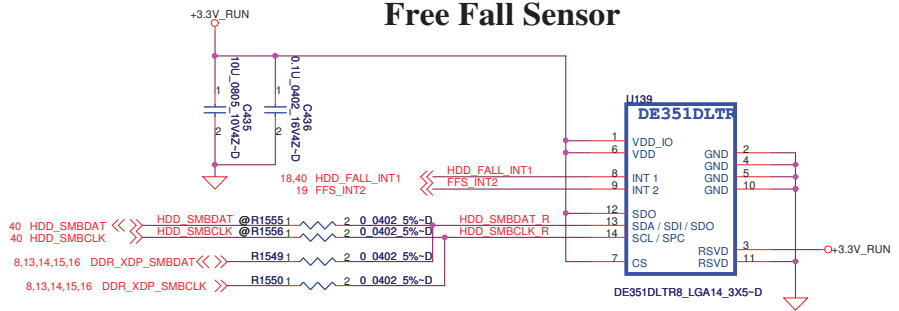
Document Number	Rev
LA-5472P	A00
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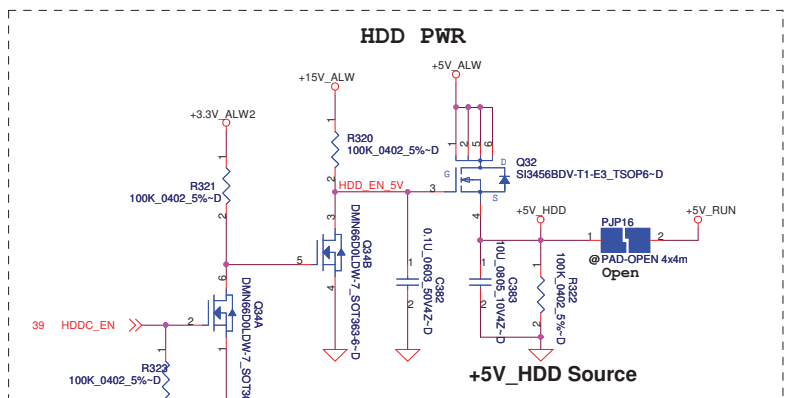
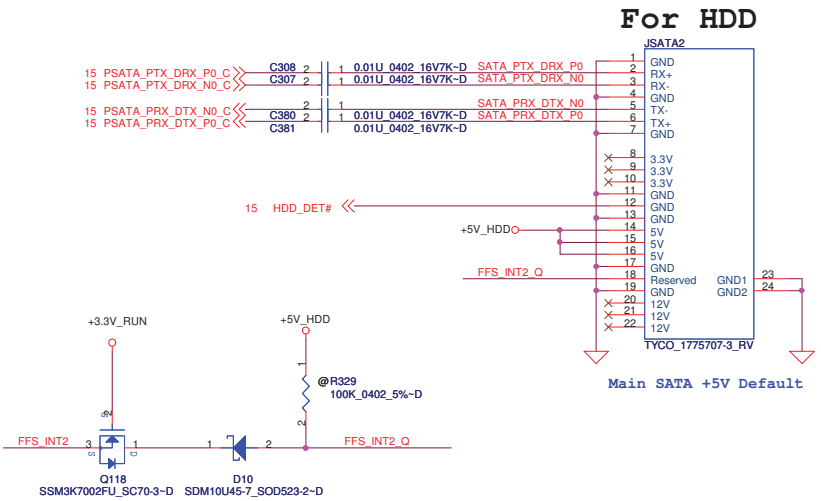
Please near ODD CONN



Free Fall Sensor



Please near HDD CONN



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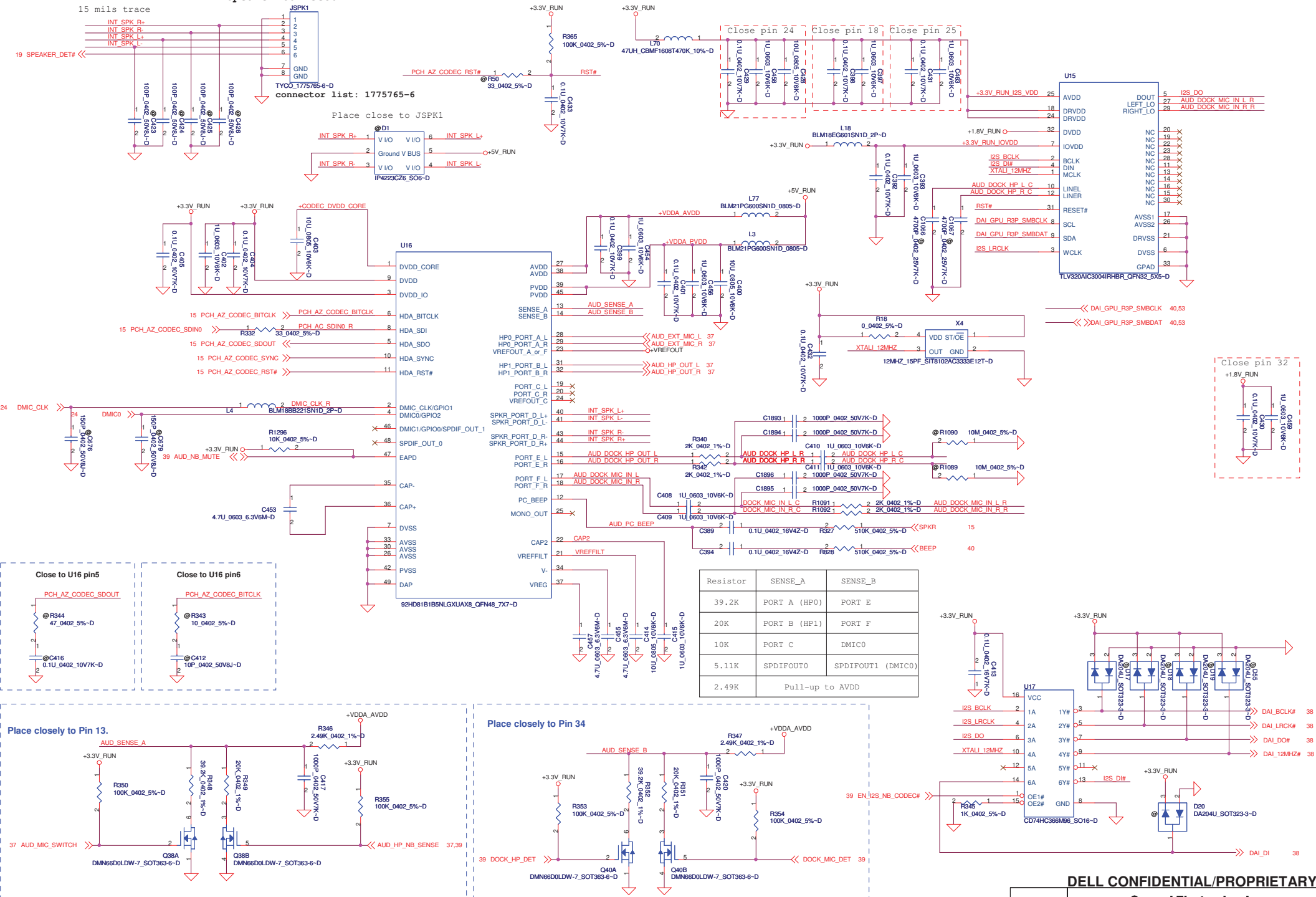
Title			Rev		
Size			Document Number		
Date			Wednesday, January 20, 2010		
Sheet			28 of 66		

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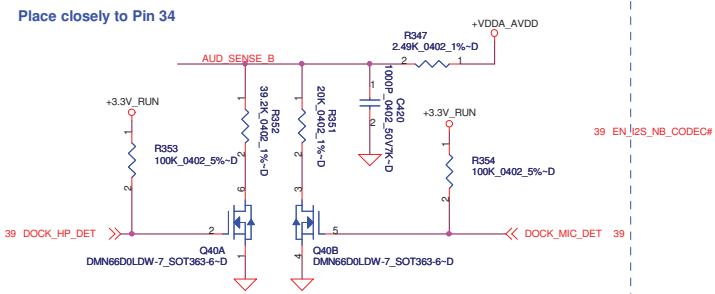
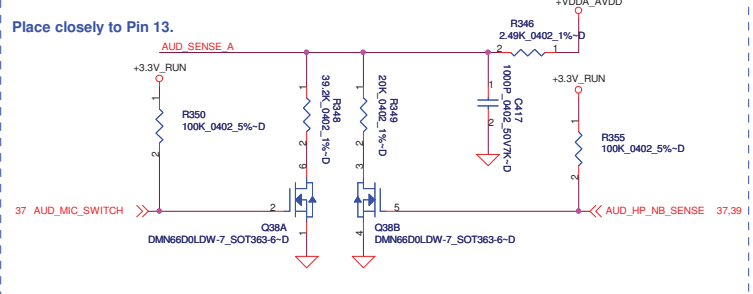
LA-5472P

ODD/HDD CONNECTOR

Speaker Connector



Resistor	SENSE_A	SENSE_B
39.2K	PORT A (HP0)	PORT E
20K	PORT B (HP1)	PORT F
10K	PORT C	DMIC0
5.11K	SPDIFOUT0	SPDIFOUT1 (DMIC0)
2.49K	Pull-up to AVDD	



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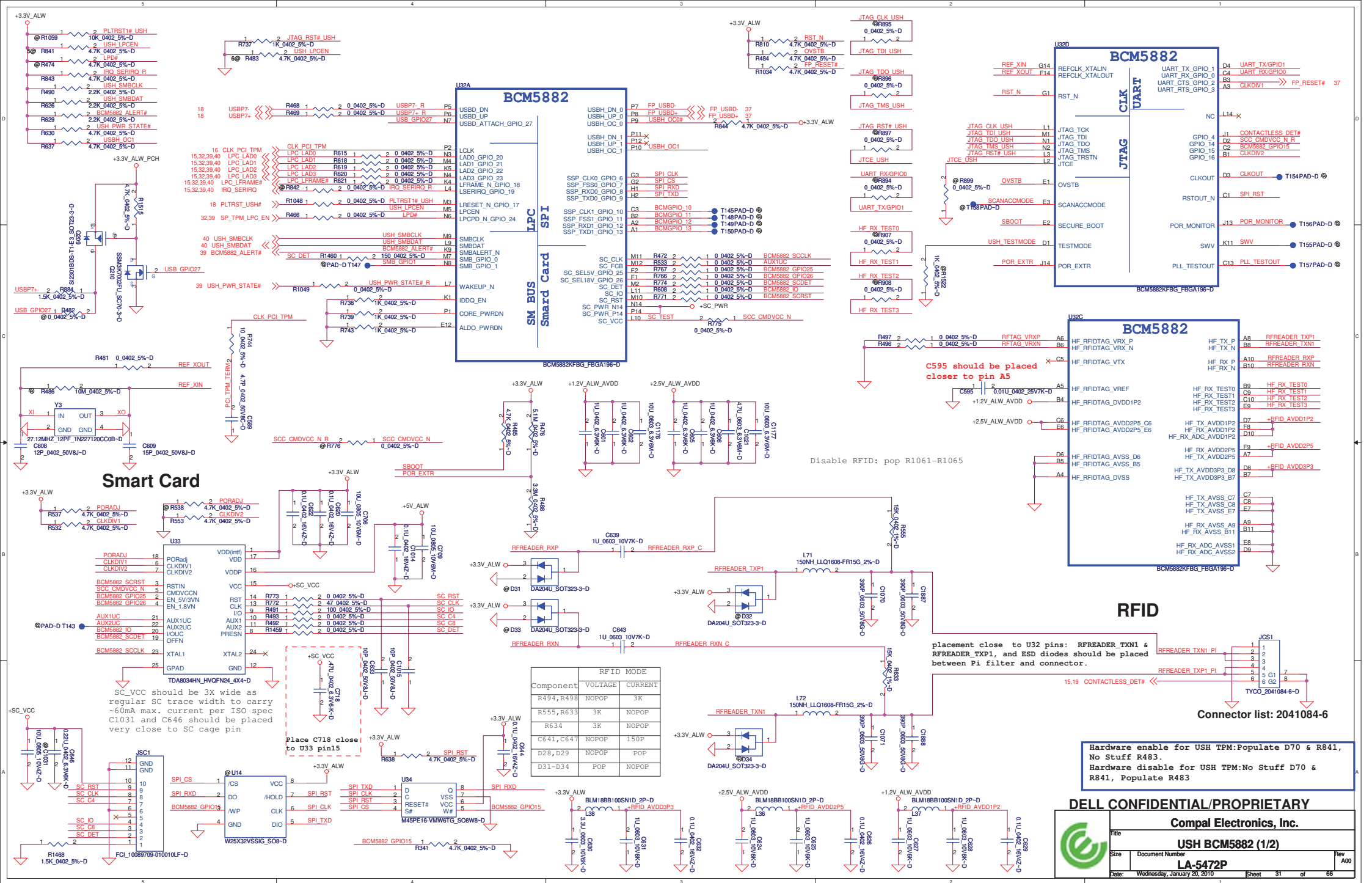
Compal Electronics, Inc.

Azalia (HD) Codec

LA-5472P

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15.32.39.40 LPC_LAD0
15.32.39.40 LPC_LAD1
15.32.39.40 LPC_LAD2
15.32.39.40 LPC_LAD3
15.32.39.40 LPC_LFRAME#
15.32.39.40 IRO_SERIRQ

18 PLTRST_USH#
32.39 SP_TPM_LPC_EN

40 USH_SMBCLK
40 USH_SMBDAT
39 BCM5882_ALERT#

39 USH_PWR_STATE#

SCC_CMDVCC N R

SC VCC

SC RST

SC CLK

SC C4

SC CB

SC DET

SPI CS

SPI RD

SPI TXD

LCLK

LAD1 GPIO_21

LAD2 GPIO_22

LAD3 GPIO_23

LFRAME_N GPIO_18

LSEIRIQ_GPIO_19

LRESET_N_GPIO_17

LPCEN

LPCPD_N_GPIO_24

SMBCLK

SMBALERT_N

SMB_GPIO_1

WAKEUP_N

IDDD_EN

CORE_PWRDN

ALDO_PWRDN

SC_RST

SC_VCC

SC_CLK

SC_C4

SC_CB

SC_DET

SPI_CS

SPI_RD

SPI_TXD

SPI_CLK

SPI_RST

RESET#

VCC W#

SPI_CS

SPI_RD

SPI_TXD

SPI_CLK

SPI_RST

RESET#

VCC W#

SPI_CS

SPI_RD

SPI_TXD

SPI_CLK

SPI_RST

RESET#

VCC W#

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SPI_TXD

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SPI_CLK

SPI_RST

RESET#

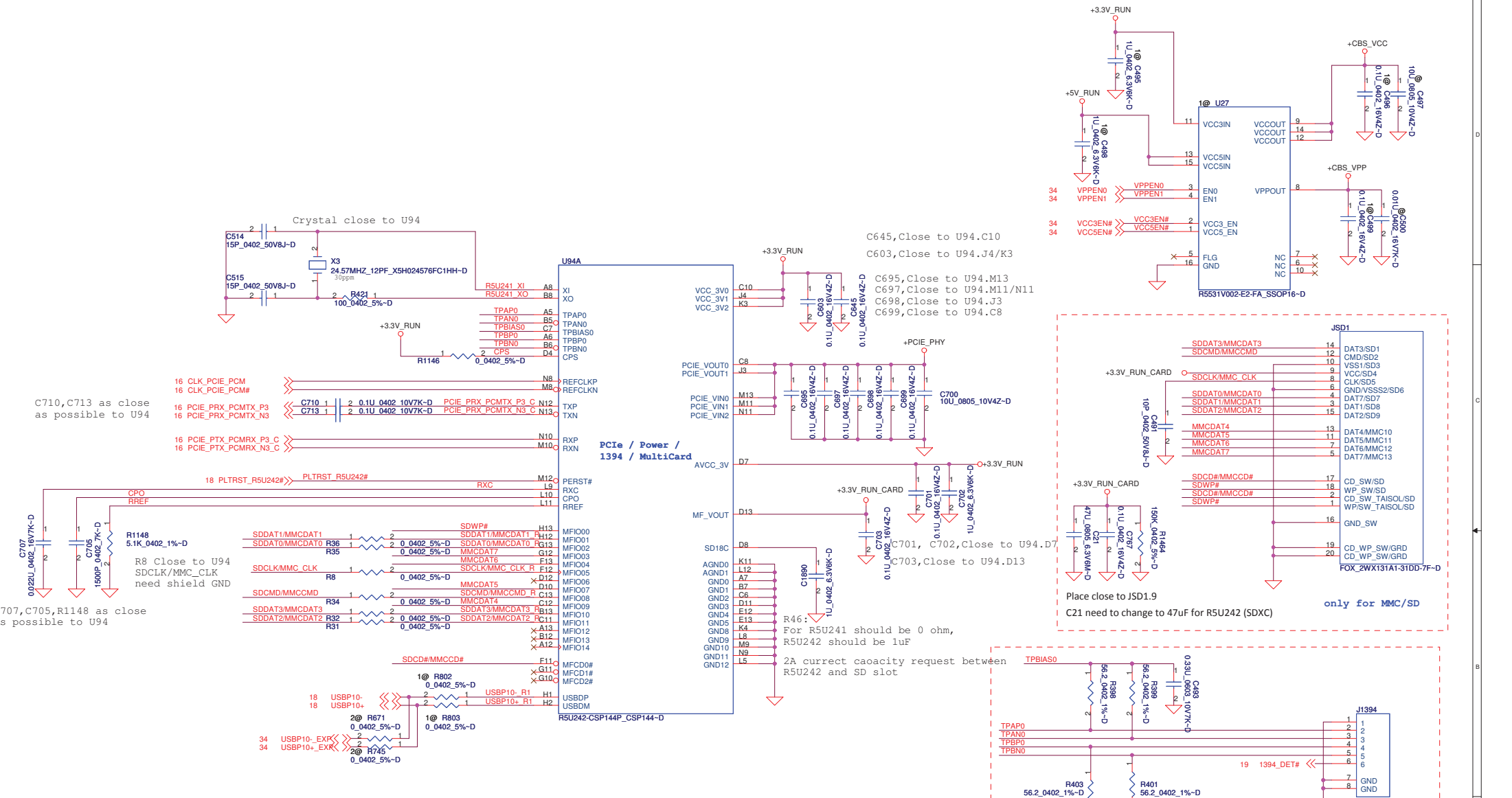
VCC W#

SPI_CS

SPI_RD

SPI_TXD

SPI_CLK



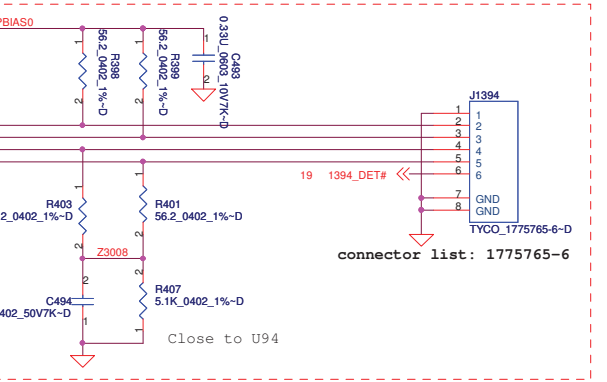
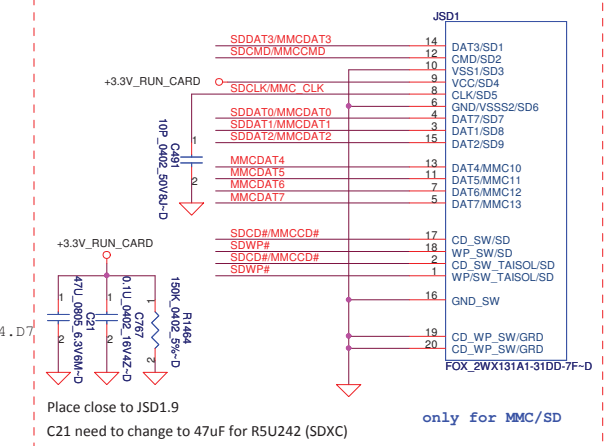
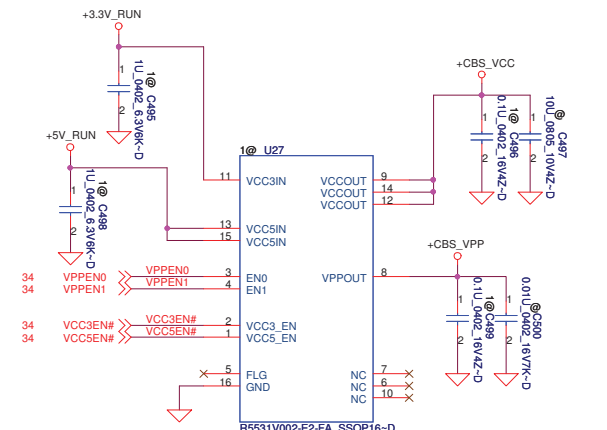
C710, C713 as close as possible to U94

C707, C705, R1148 as close as possible to U94

C707, C705, R1148 as close as possible to U94

MFIO Pin Assignment Table

MFIO	SD8	XD	MS8
00	WP	D7	BS
01	D1	D6	-
02	D0	D5	D1
03	D7	D4	-
04	D6	D3	D5
05	CLK	D2	D0
06	-	D1	-
07	D5	D0	D4
08	CMD	WP#	D2
09	D4	WE#	D6
10	D3	ALE	D3
11	D2	CLE	-
12	-	CE#	-
13	-	RE#	D7
14	-	R/B#	CLK



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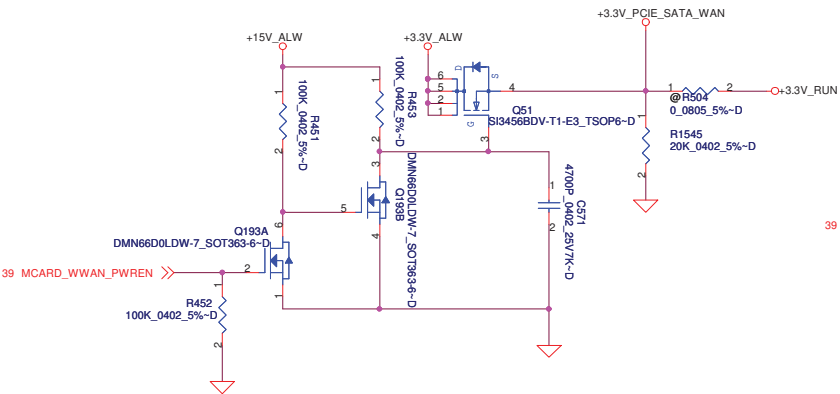
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R5U242 (1/2)

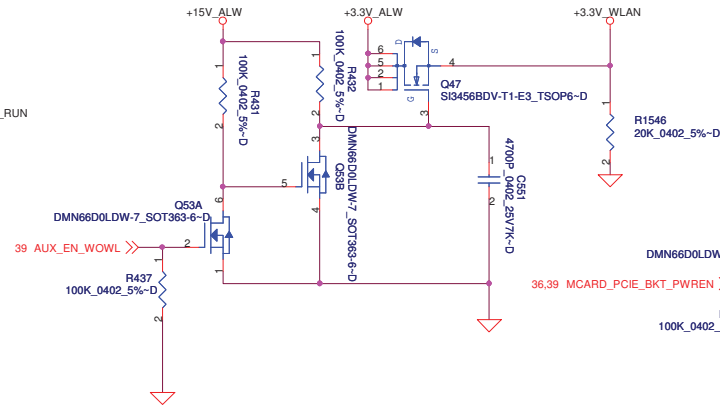
Size	Document Number	Rev
		A00

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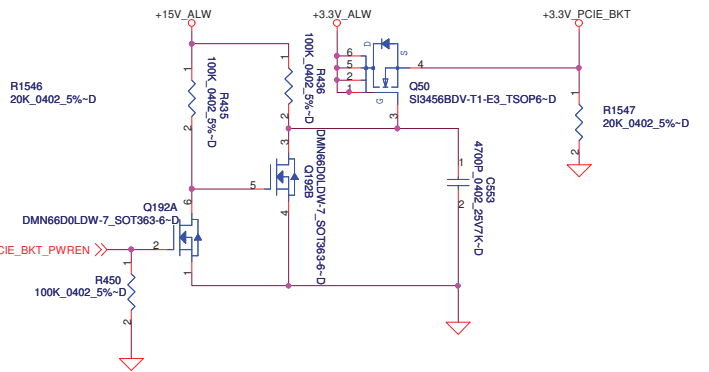
Power Control for Mini card1



Power Control for Mini card2



Power Control for Mini card3



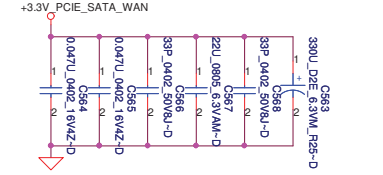
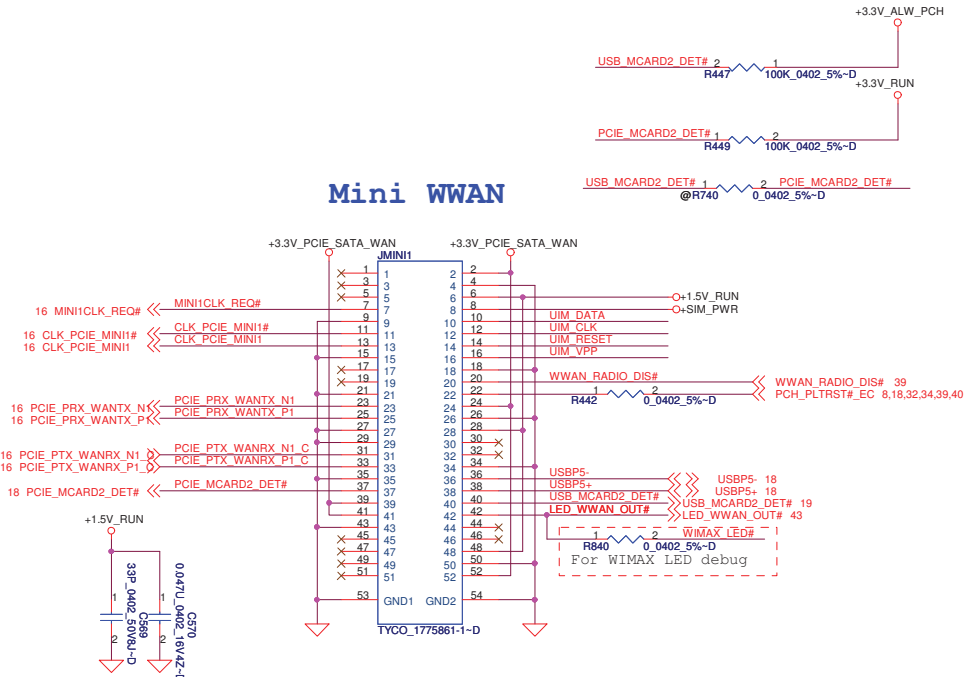
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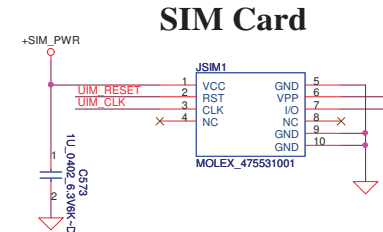
Title			PCIE PWR		
Size	Document Number	Rev		A00	
	LA-5472P				
Date:	Wednesday, January 20, 2010	Sheet	35	of	66

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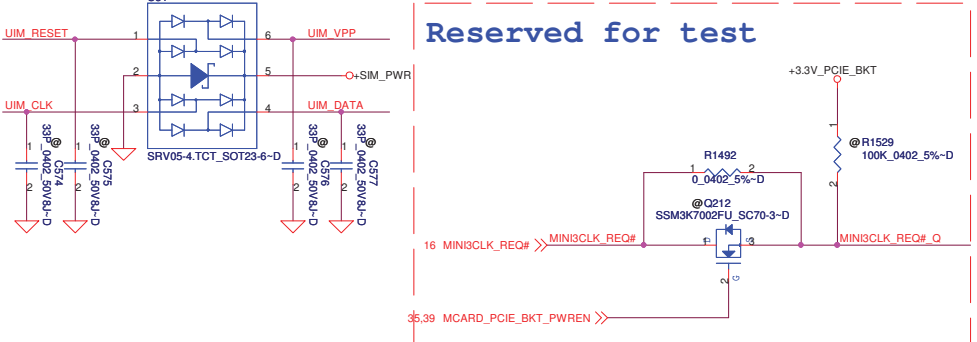
Mini WWAN



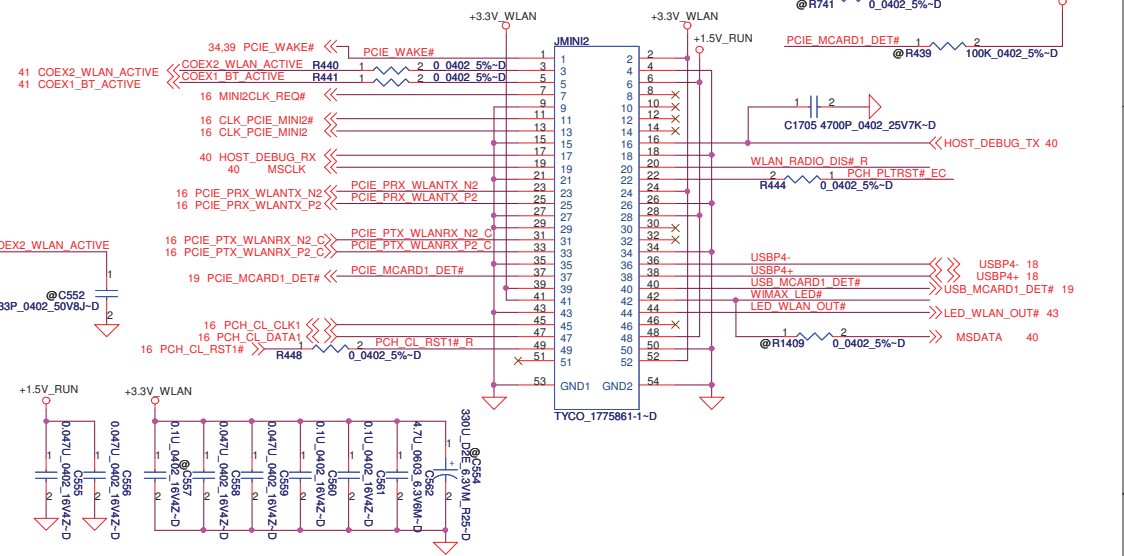
PWR Rail	Voltage Tolerance	Primary Power		Aux Power
		Peak	Normal	Normal
+3.3V	+9%	1000	750	
+3.3Vaux	+9%	330	250	250 (Wake enable) 5 (Not wake enable)
+1.5V	+5%	500	375	NA



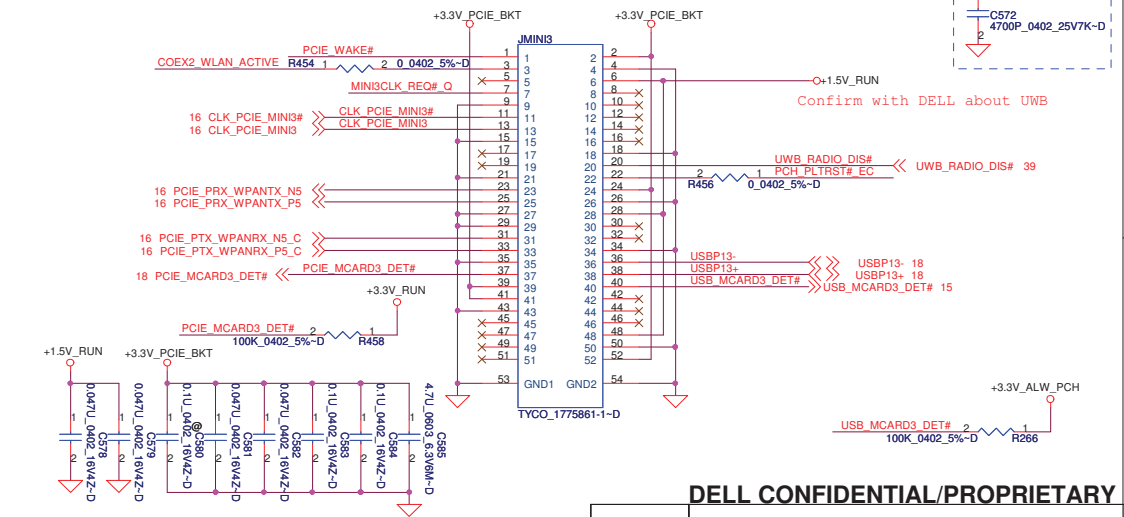
Reserved for test



Mini WLAN



PCIE/BKT Card



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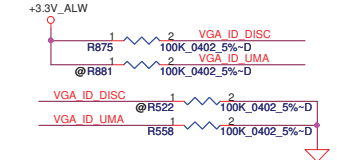
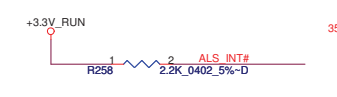
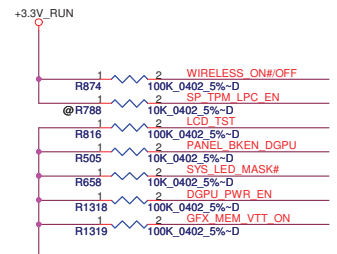
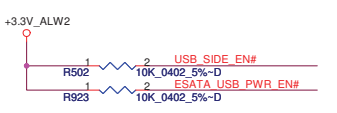
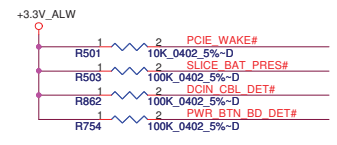
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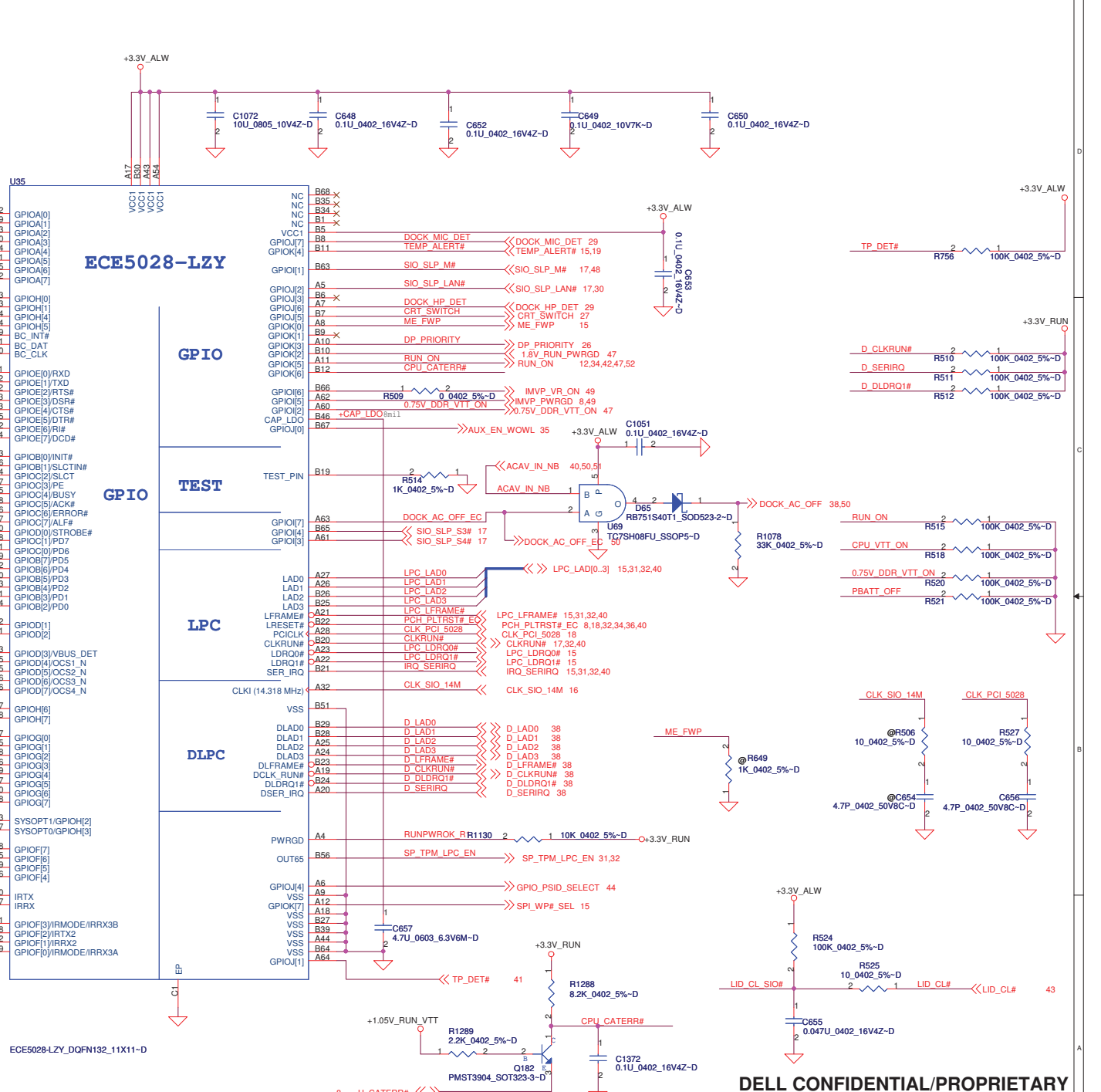
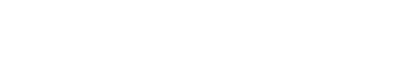
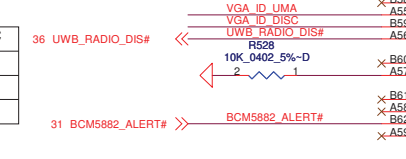
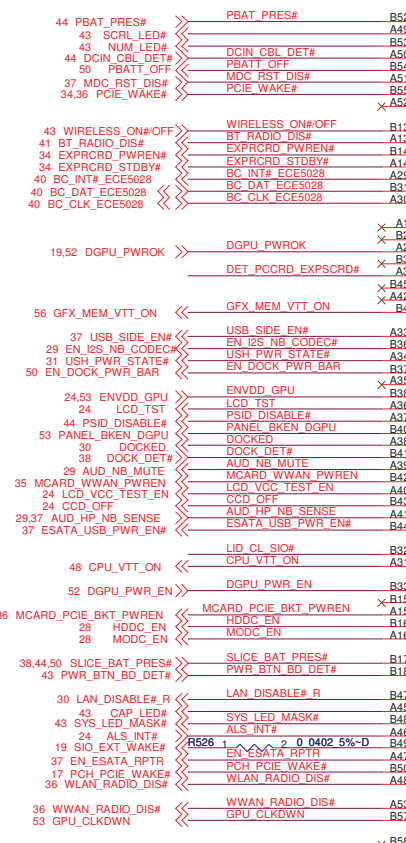
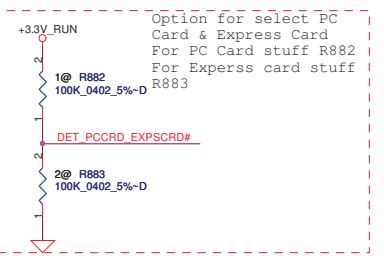
Mini Card

LA-5472P

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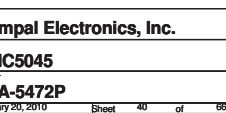
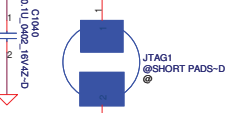
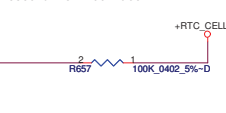
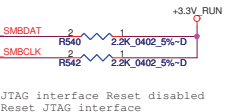
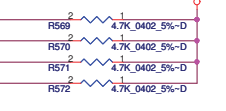
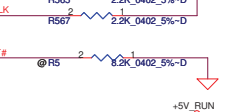
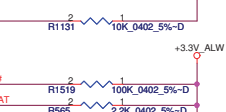
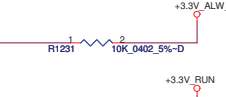
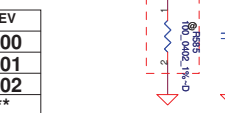
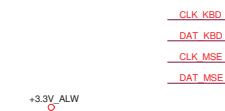
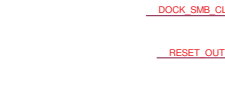
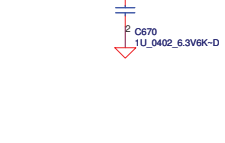
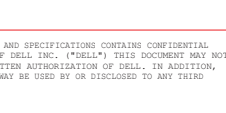
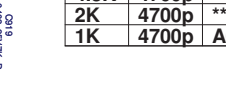
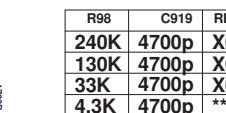
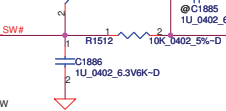
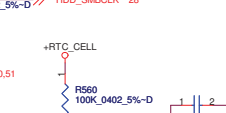
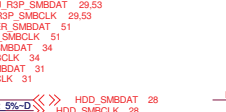
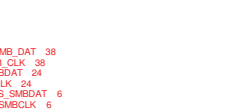
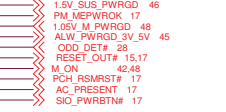
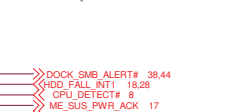
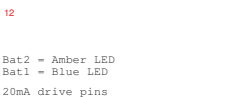
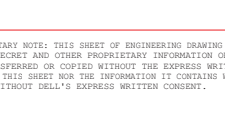
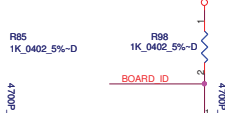
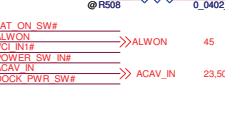
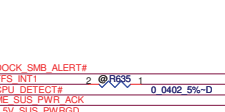
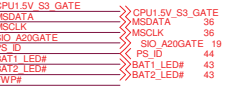
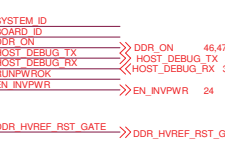
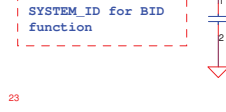
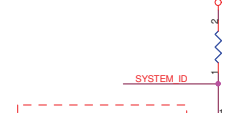
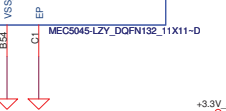
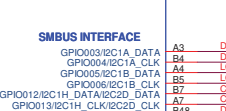
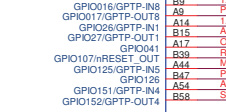
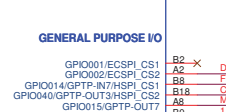
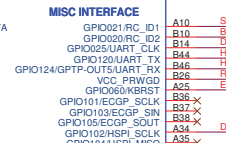
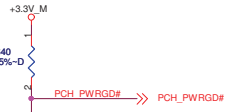
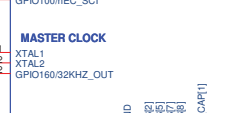
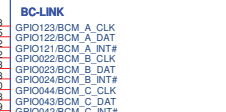
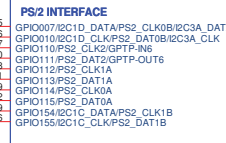
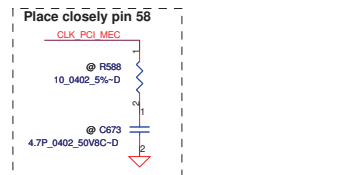
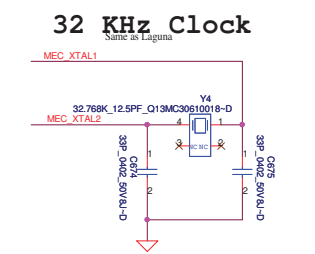
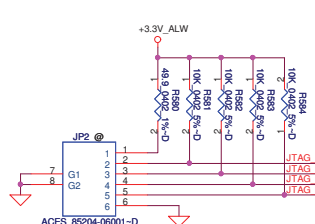
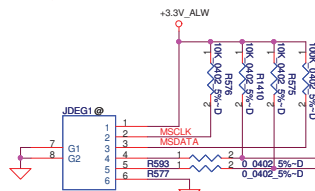
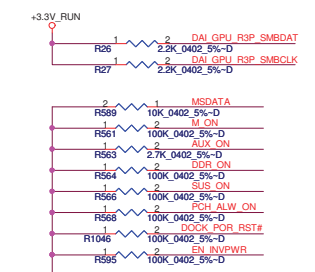
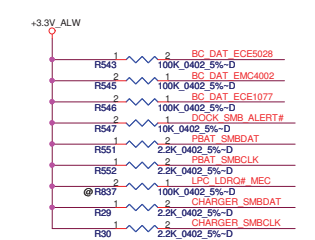
	VGA_ID_UMA	VGA_ID_DISC
Discrete	0	1
UMA	1	0
SG	1	1



ECE5028-LZY_DQFN132_11X11-D


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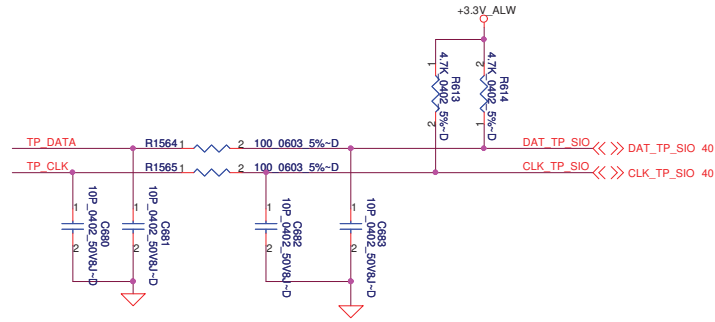
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240K	4700p	X00
130K	4700p	X01
33K	4700p	X02
4.3K	4700p	***
2K	4700p	***
1K	4700p	A00

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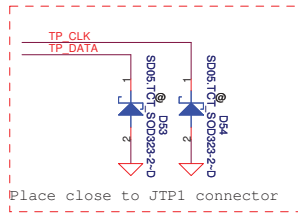
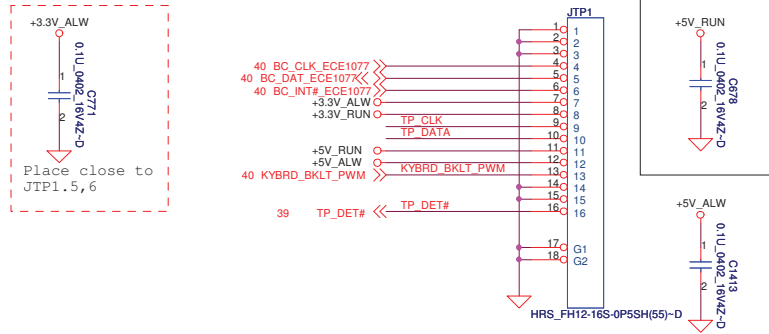

Compaq Electronics, Inc.
 File: **EMC5045**
 Size: **Document Number**
LA-5472P
 Date: **Wednesday, January 20, 2010** Sheet **40** of **66**
 Rev **A00**

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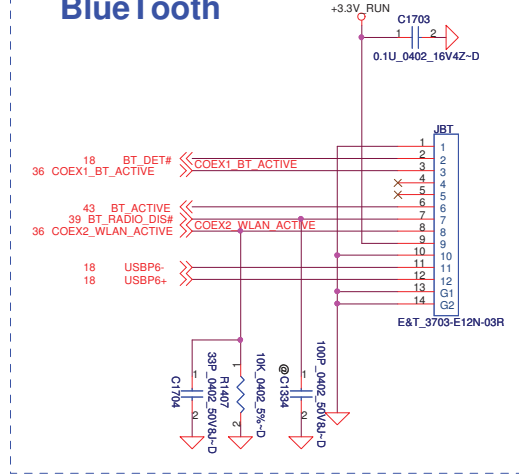
Touch Pad



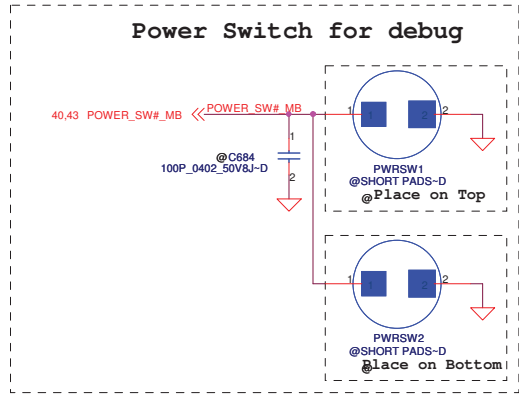
Touch Pad Conn. Pitch=0.5



BlueTooth



Power Switch for debug



Part Number	Description
DC28A000800	FAN SET DAQ20 DC5V AB7405HB-HB3 ADDA
PK230003Q0L	SPK PACK 2JX 2.0W 4 OHM FG
SP070007V0L	SOCKET TYCO I770551-1 10P H5.9 SWART
DC000001Q0L	PCMCIA TYCO 1759096-1
DC02000CS0L	H-COHN SET ZGX MB-MDC
DC02000840L	H-COHN SET ZJX MB-B/T-TP-FP
DC020003Y0L	H-COHN SET ZJX MB-LCD 14 WXGA+(-1ch)
DC02000870L	H-COHN SET ZJX MB-LCD 14 WXGA+(-2ch)
GC20323MX00	BATT CR2032 3V 220MAH MAXELL

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Touch Pad/Int KB/LID

LA-5472P

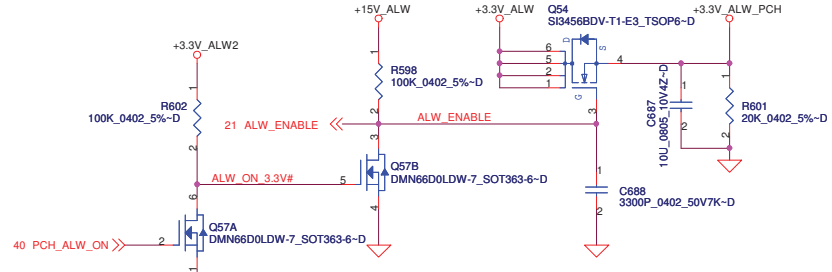
Size	Document Number	Rev
		A00

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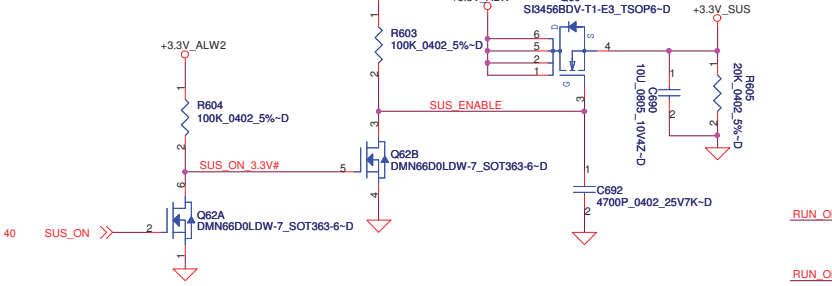
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DC/DC Interface

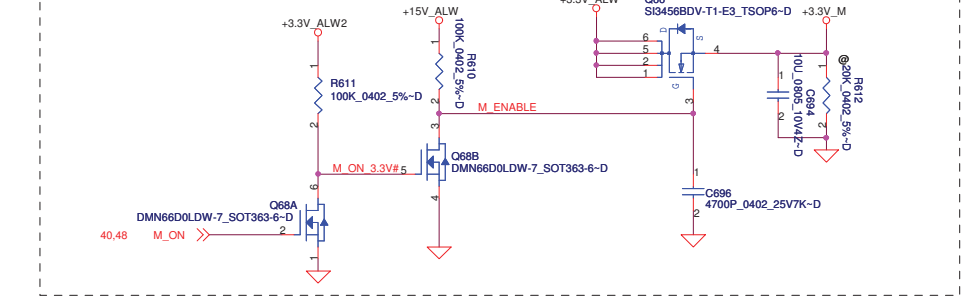
+3.3V_ALW_PCH Source



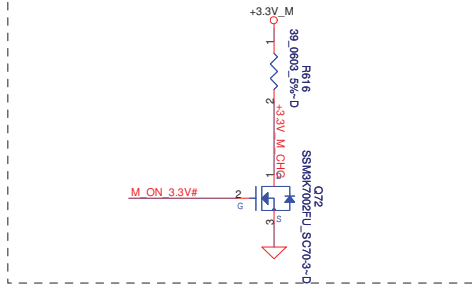
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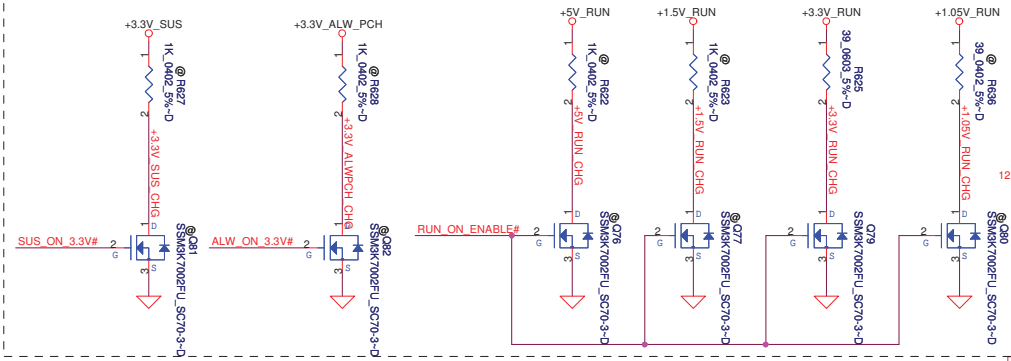
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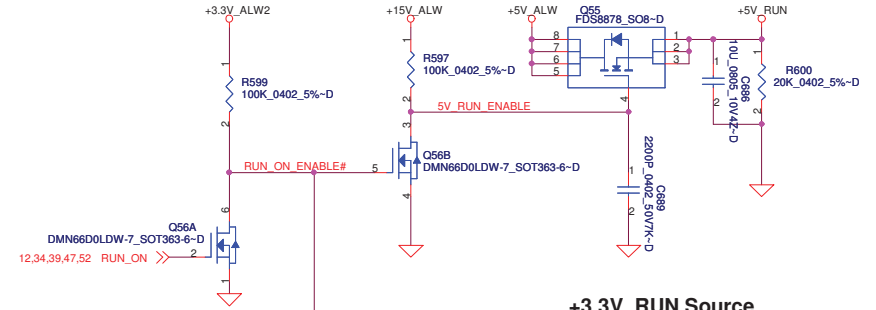
Discharg Circuit



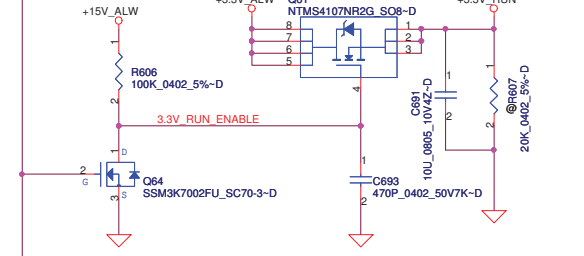
Discharg Circuit



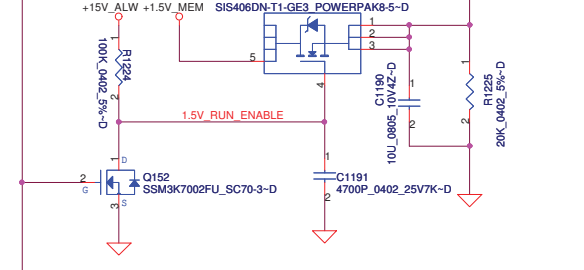
+5VRUN Source



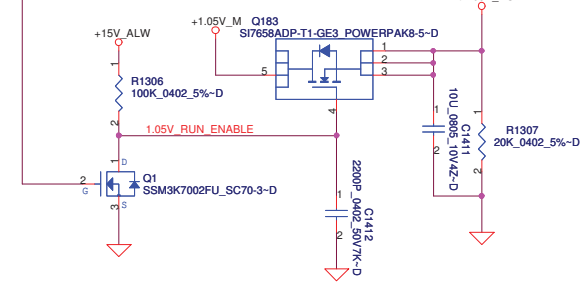
+3.3V_RUN Source



+1.5V_RUN Source



+1.05V_RUN Source



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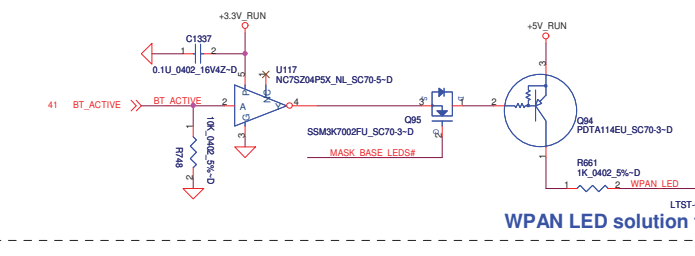
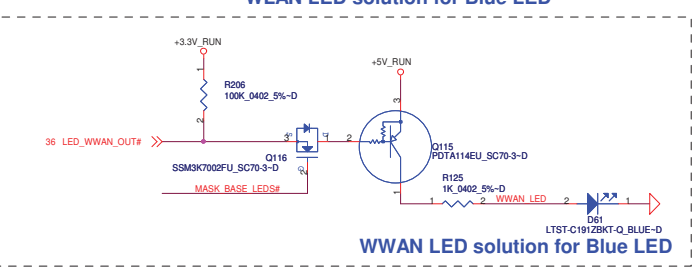
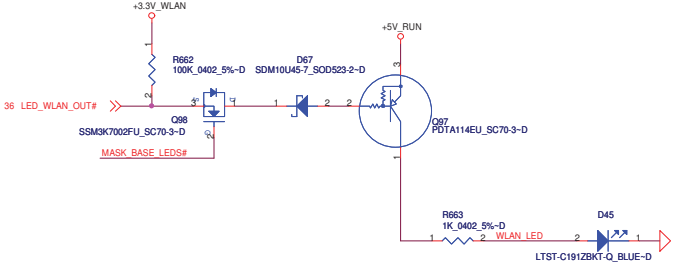
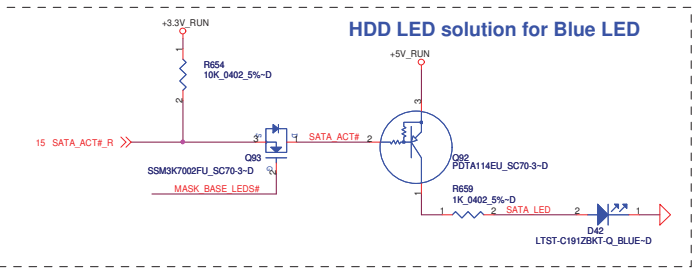
Compal Electronics, Inc.

POWER CONTROL

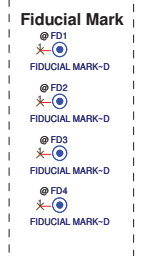
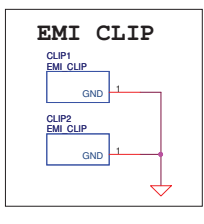
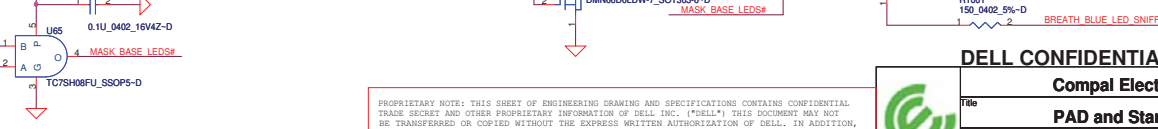
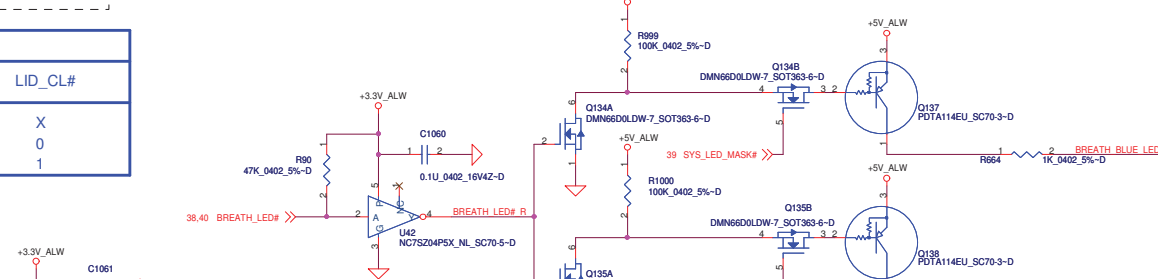
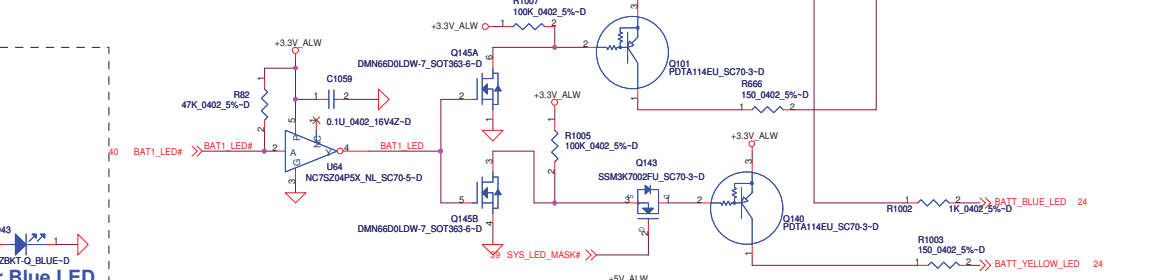
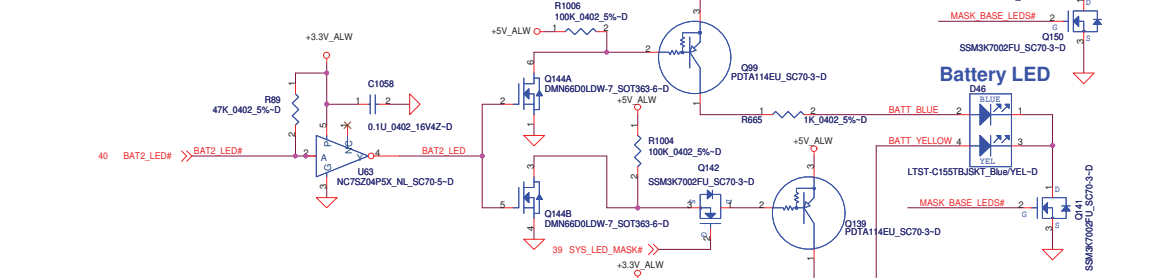
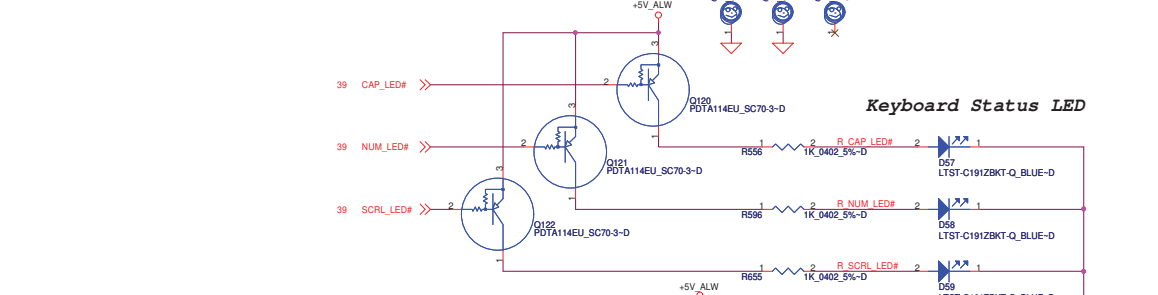
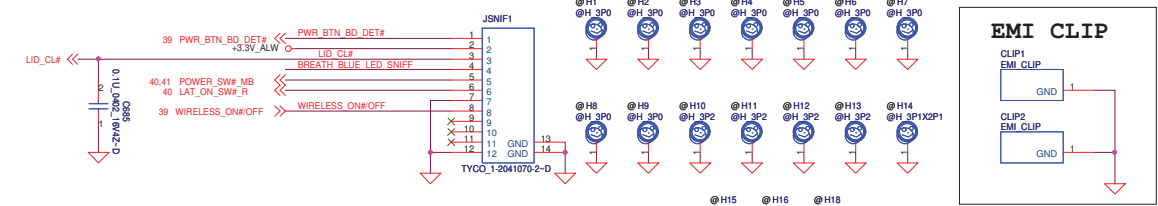
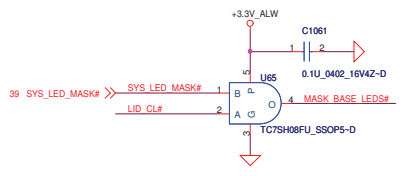
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	SYS_LED_MASK#	LID_CL#
Mask All LEDs (Sniffer Function)	0	X
Mask Base MB LEDs (Lid Closed)	1	0
Do not Mask LEDs (Lid Opened)	1	1



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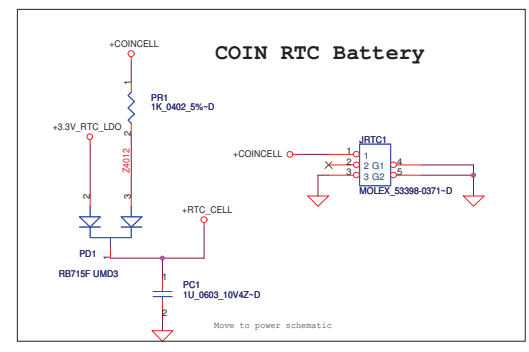
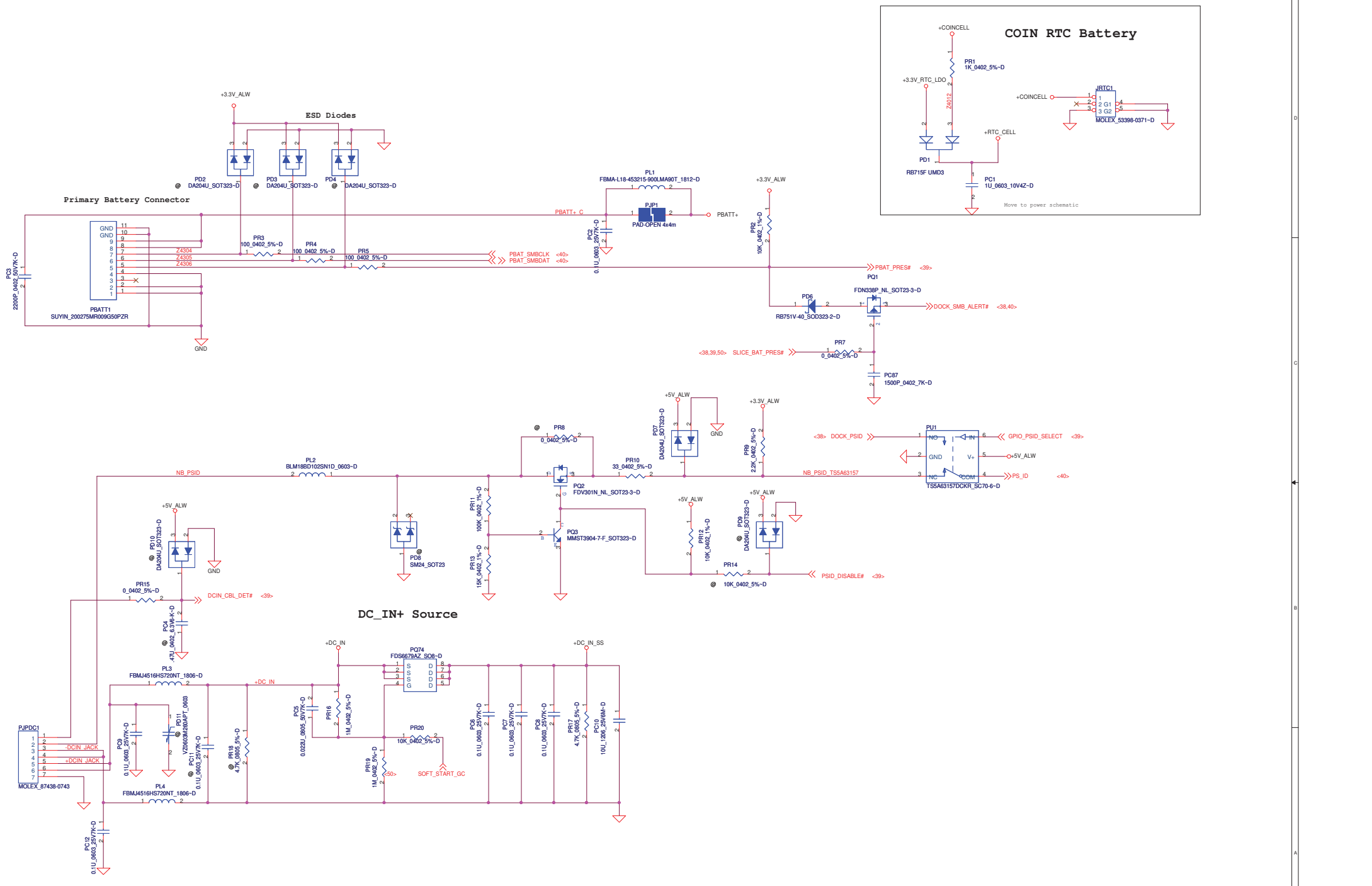
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PAD and Standoff

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+DCIN

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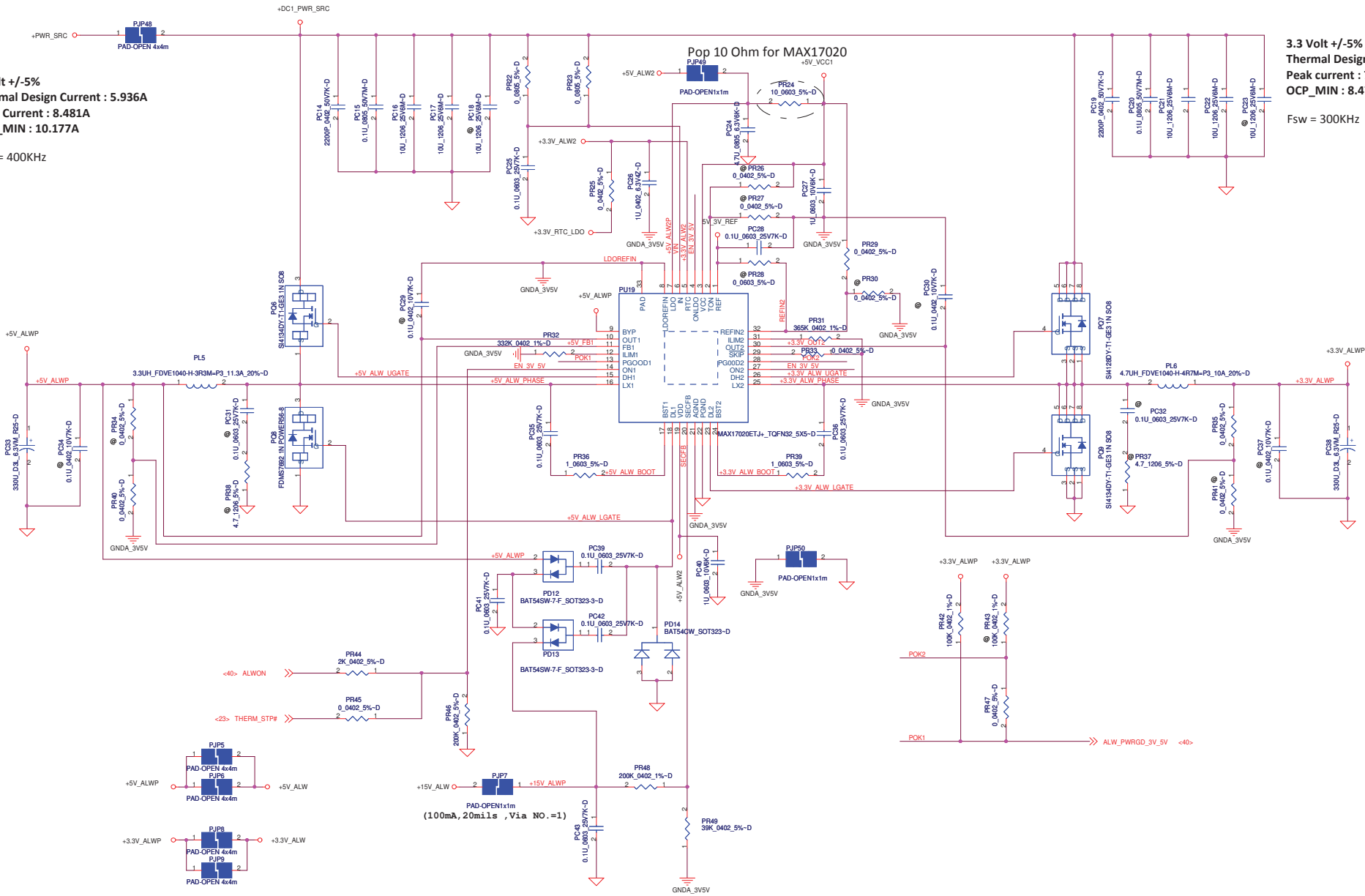
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+3.3V_ALWP / +5V_ALWP / +5V_ALW2 / +15V_ALWP / +3.3V_RTC_LDO


5 Volt +/-5%
 Thermal Design Current : 5.936A
 Peak Current : 8.481A
 OCP_MIN : 10.177A

Fsw = 400KHz

3.3 Volt +/-5%
 Thermal Design Current : 4.942A
 Peak current : 7.061A
 OCP_MIN : 8.473A
 Fsw = 300KHz

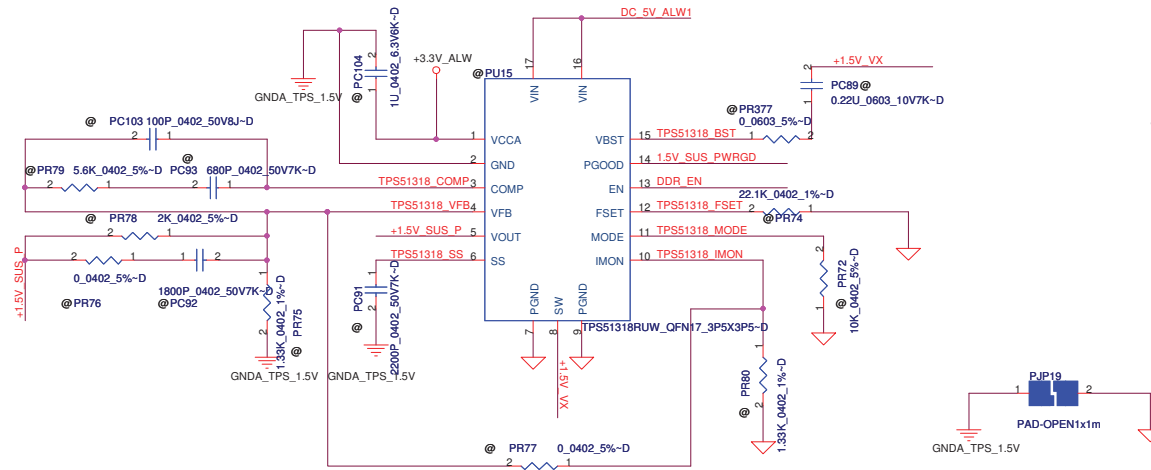


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		Compal Electronics, Inc.	
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Size	Document Number	LA-5472P	
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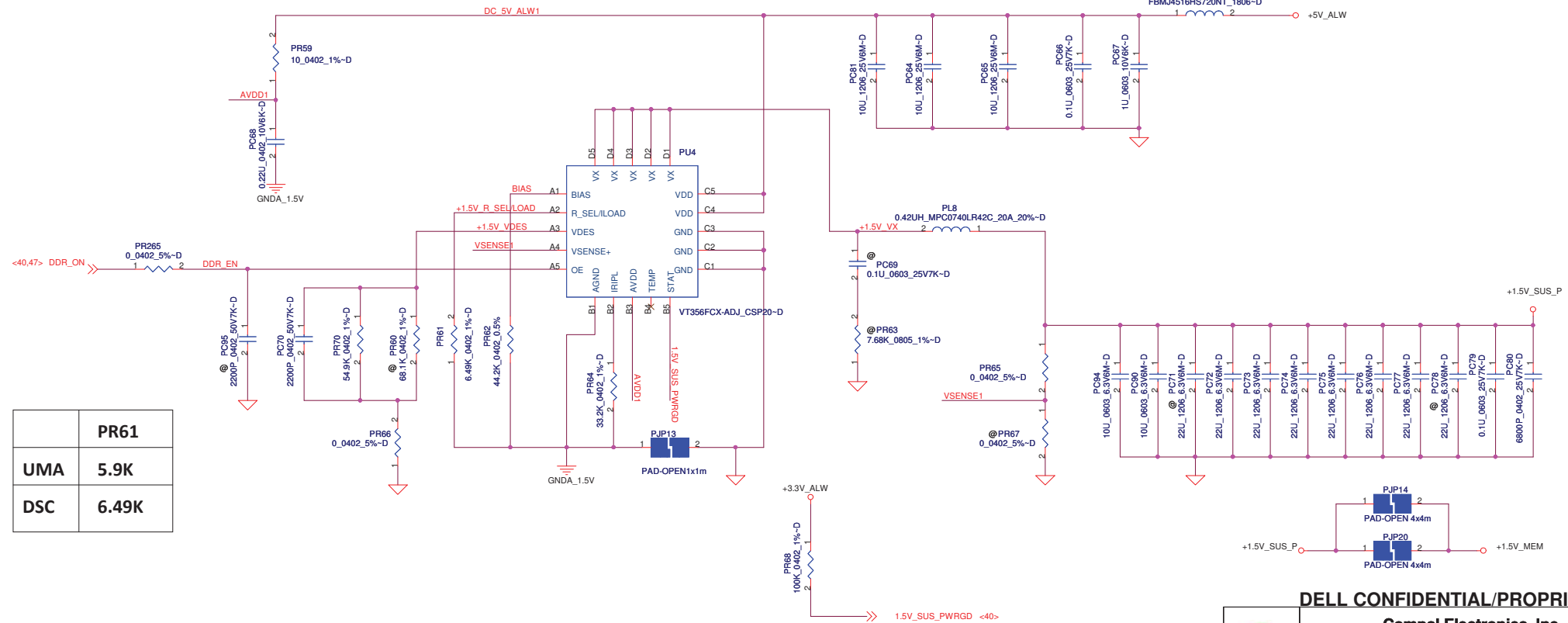
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+1.5V_SUS_P (TPS51318)



1.5 Volt +/-5%
Thermal Design Current : 7.876A
Peak current : 11.251A
OCP_MIN : 13.501A

+1.5V_SUS_P (VT356)



	PR61
UMA	5.9K
DSC	6.49K

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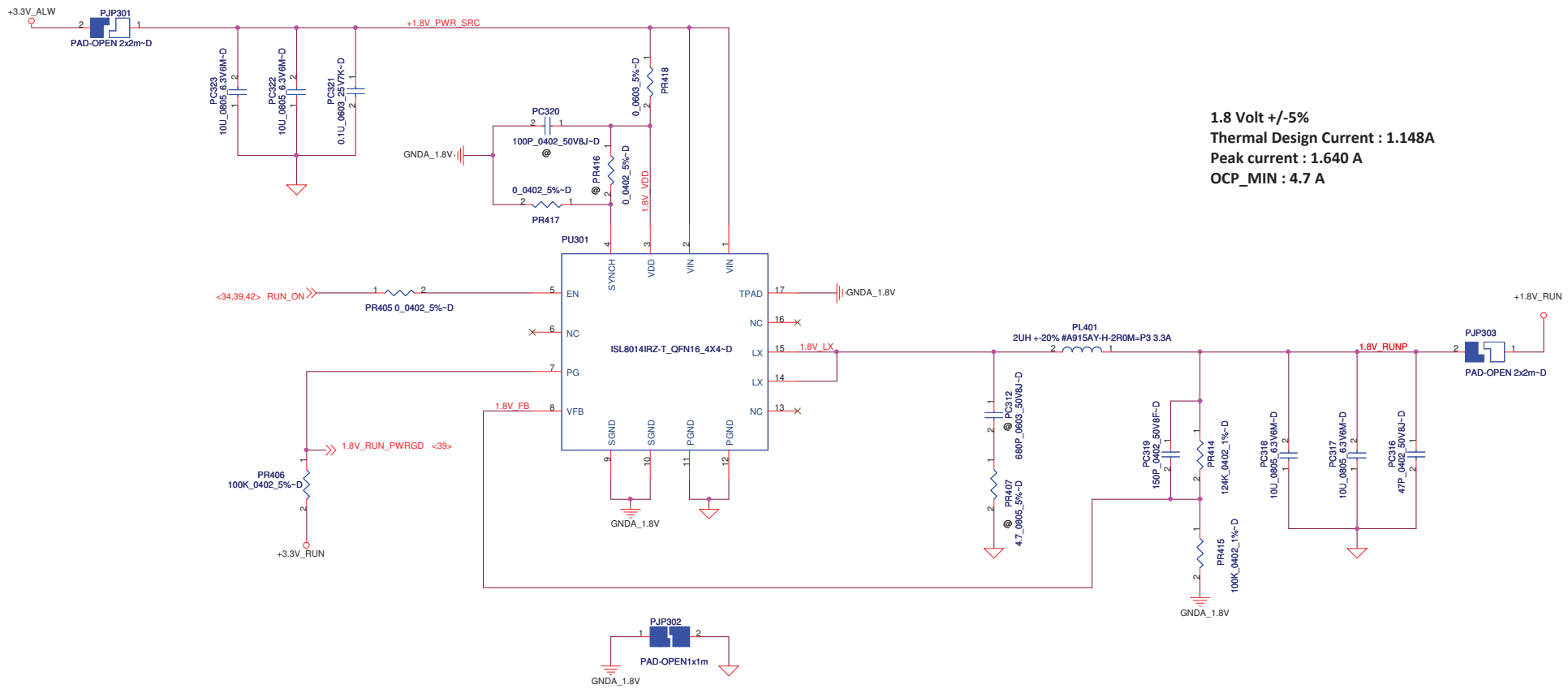


Title		+1.5V MEM	
Size	Document Number	Rev A00	
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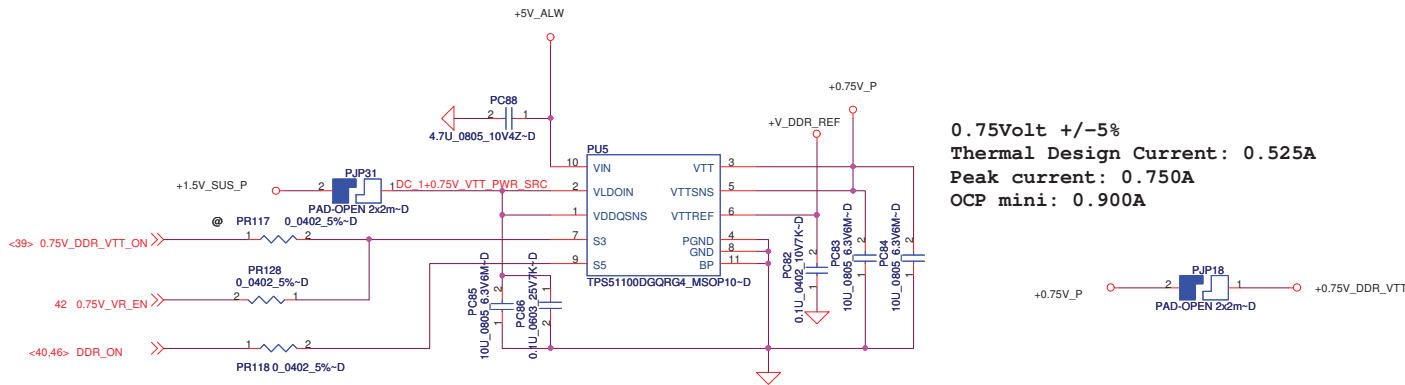
+1.8V_RUN



1.8 Volt +/-5%
 Thermal Design Current : 1.148A
 Peak current : 1.640 A
 OCP_MIN : 4.7 A

+0.75V_DDR_VTT

DDR3 Termination



0.75Volt +/-5%
 Thermal Design Current: 0.525A
 Peak current: 0.750A
 OCP mini: 0.900A

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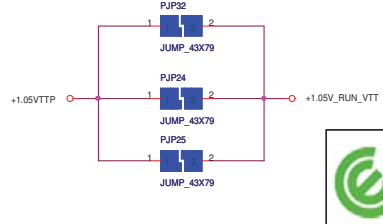
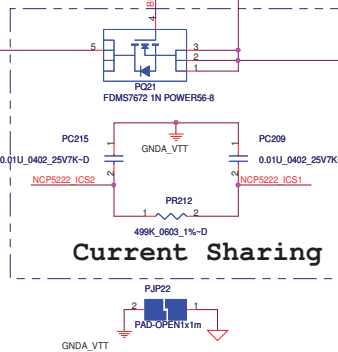
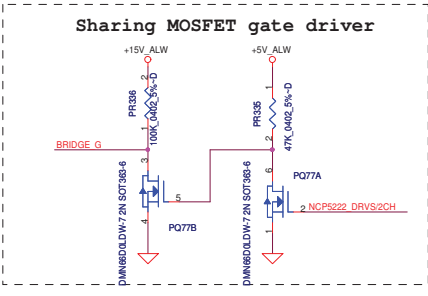
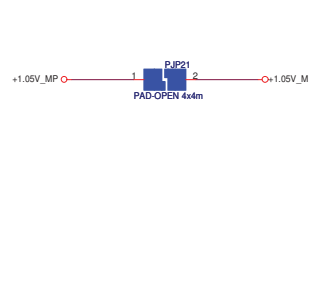
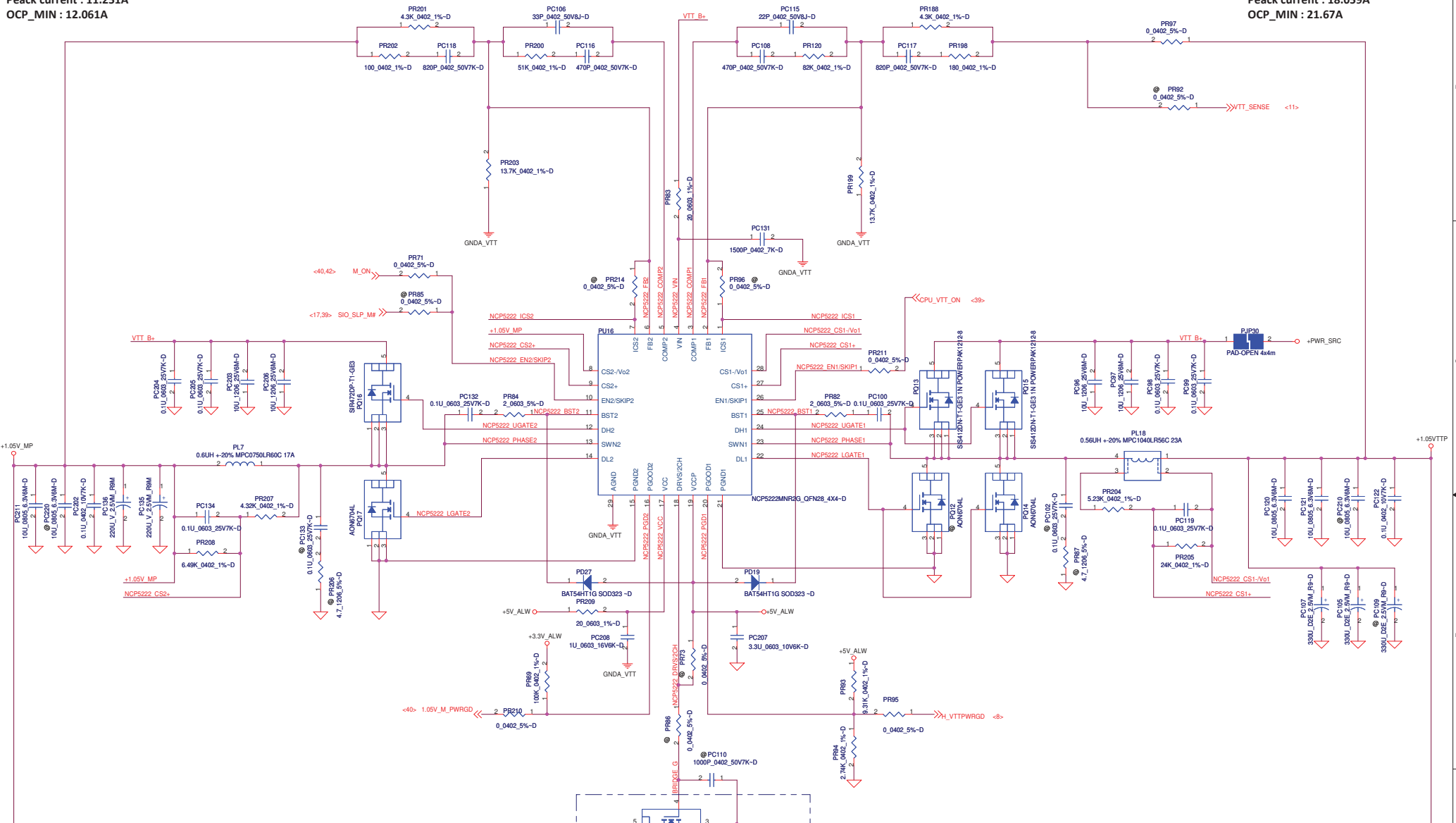
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1.05 Volt +/-5%
 Thermal Design Current : 7.876A
 Peak current : 11.251A
 OCP_MIN : 12.061A

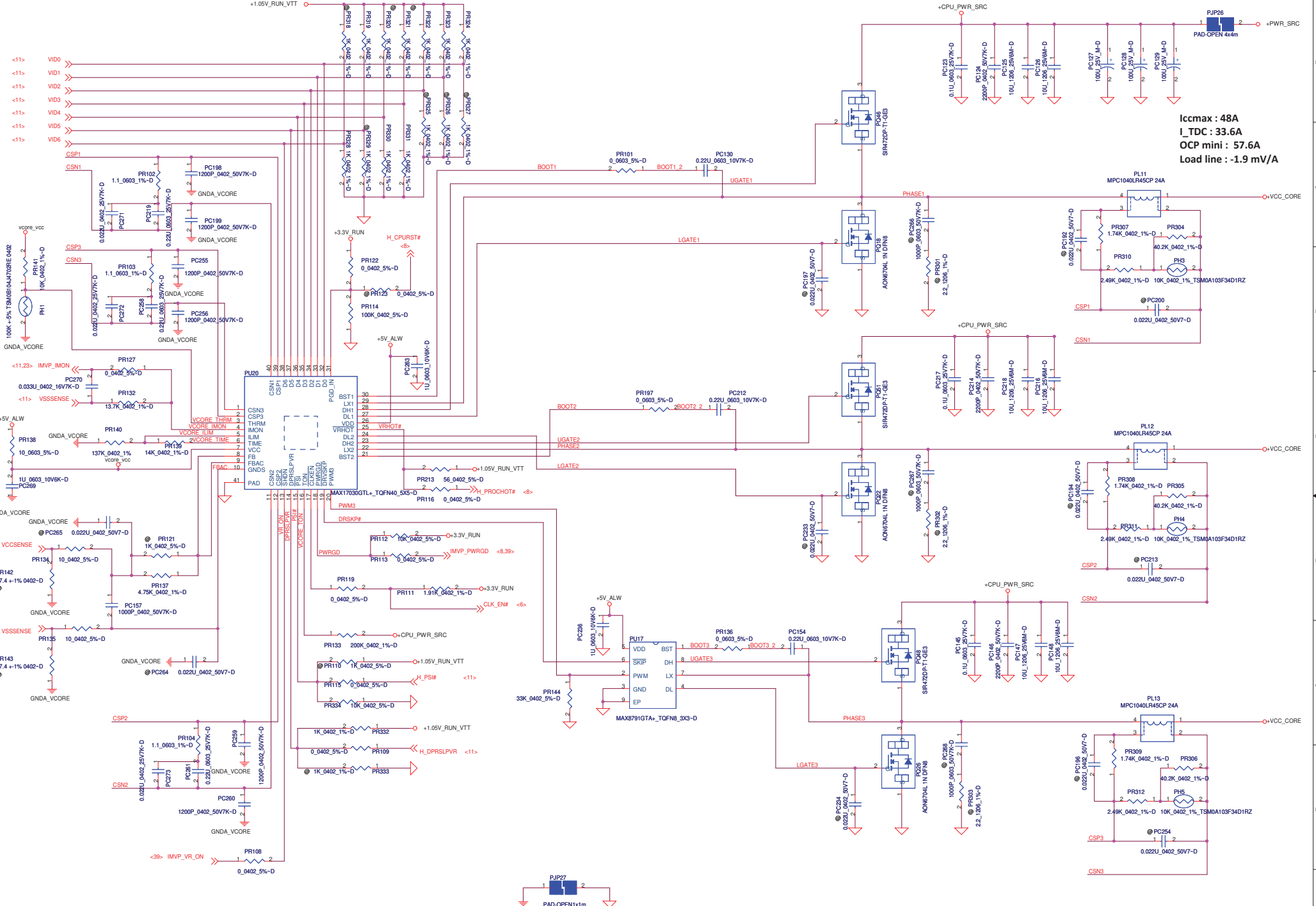
+1.05V_M/+1.05VTT_RUN

1.05Volt +/-5%
 Thermal Design Current : 18A
 Peak current : 18.059A
 OCP_MIN : 21.67A



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		+1.05V_M/+1.05VTT_RUN	
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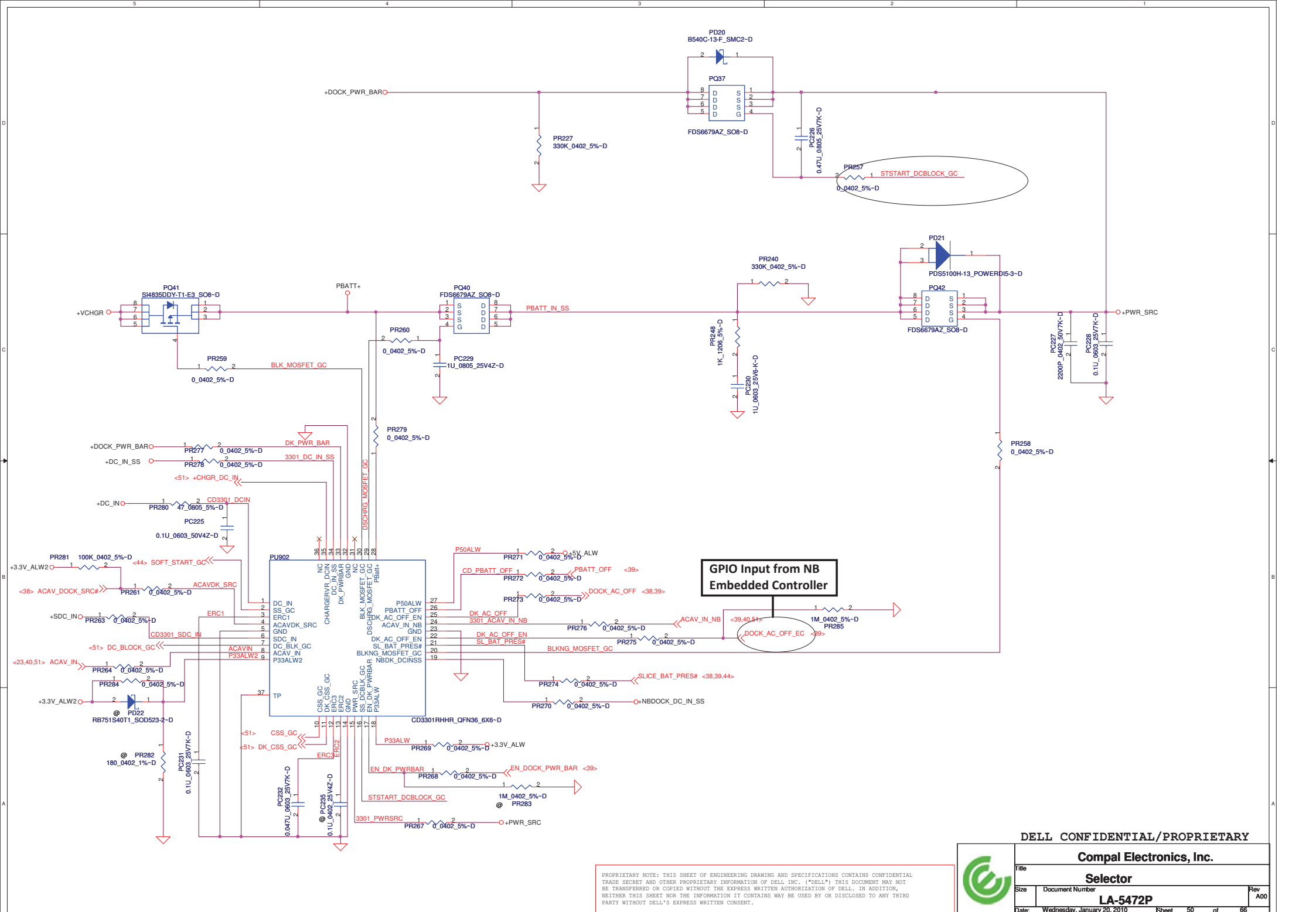


Iccmax : 48A
I_TDC : 33.6A
OCP mini : 57.6A
Load line : -1.9 mV/A

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		Compal Electronics, Inc.	
		+Vcore	
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Selector

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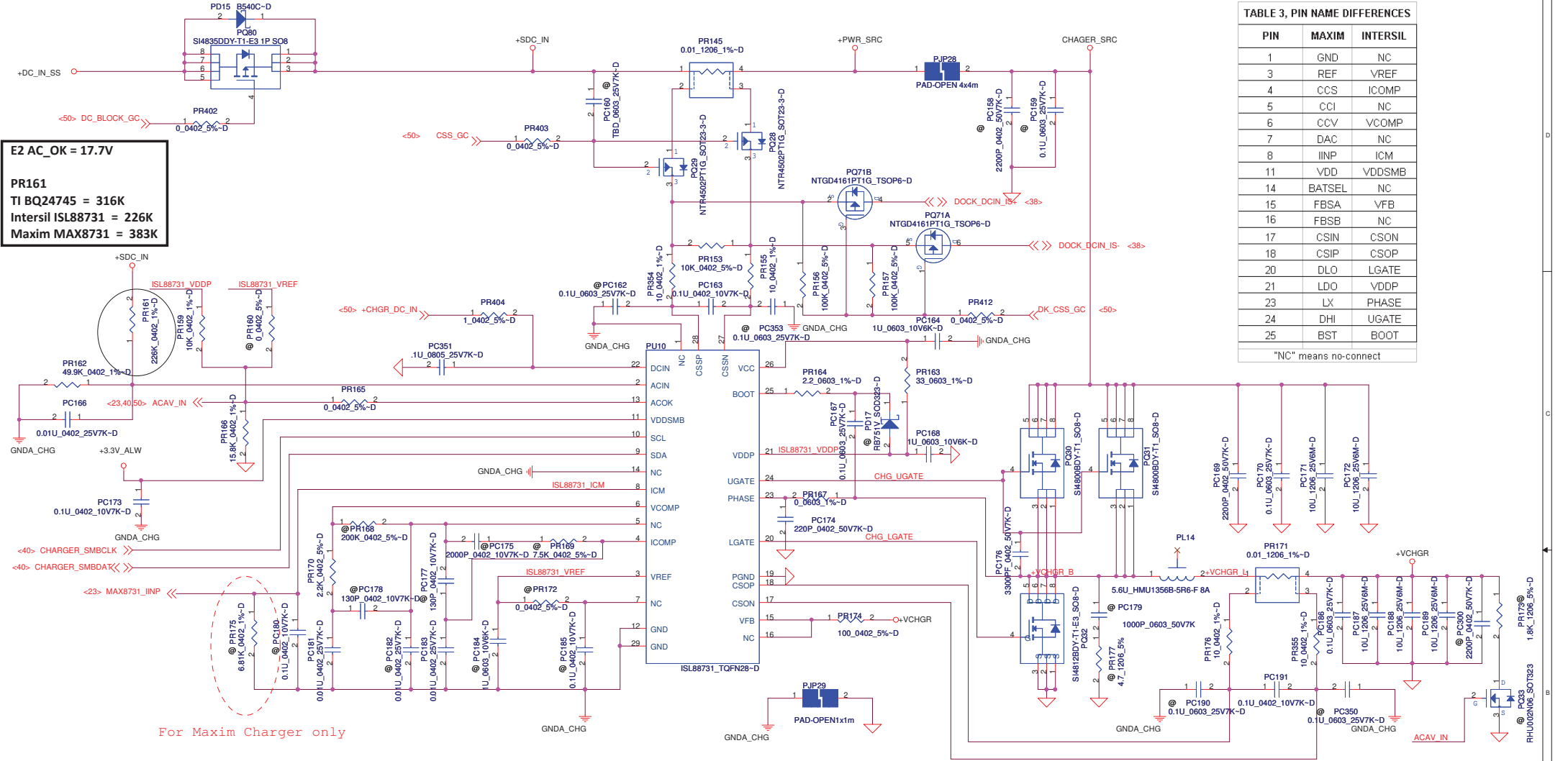
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E2 AC_OK = 17.7V
PR161
TI BQ24745 = 316K
Intersil ISL88731 = 226K
Maxim MAX8731 = 383K

TABLE 3, PIN NAME DIFFERENCES

PIN	MAXIM	INTERSIL
1	GND	NC
3	REF	VREF
4	CCS	ICOMP
5	CCI	NC
6	CCV	VCOMP
7	DAC	NC
8	IINP	ICM
11	VDD	VDDSMB
14	BATSEL	NC
15	FBSA	VFB
16	FBSB	NC
17	CSIN	CSOIN
18	CSIP	CSOP
20	DLO	LGATE
21	LDO	VDDP
23	LX	PHASE
24	DHI	UGATE
25	BST	BOOT

"NC" means no-connect



For Maxim Charger only

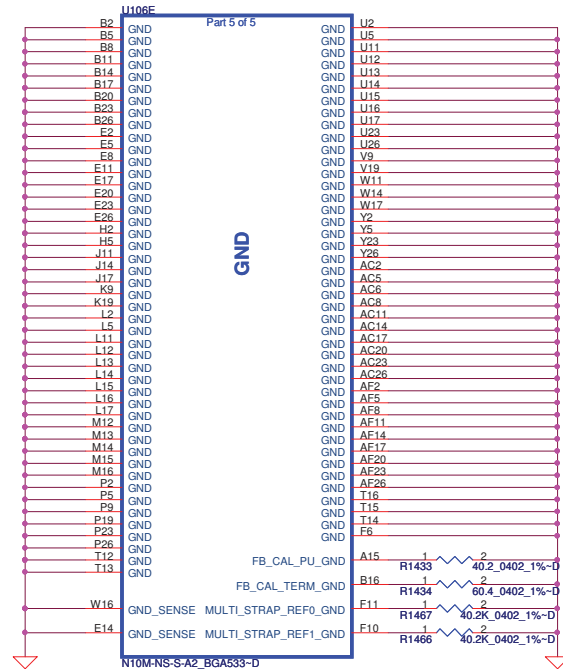
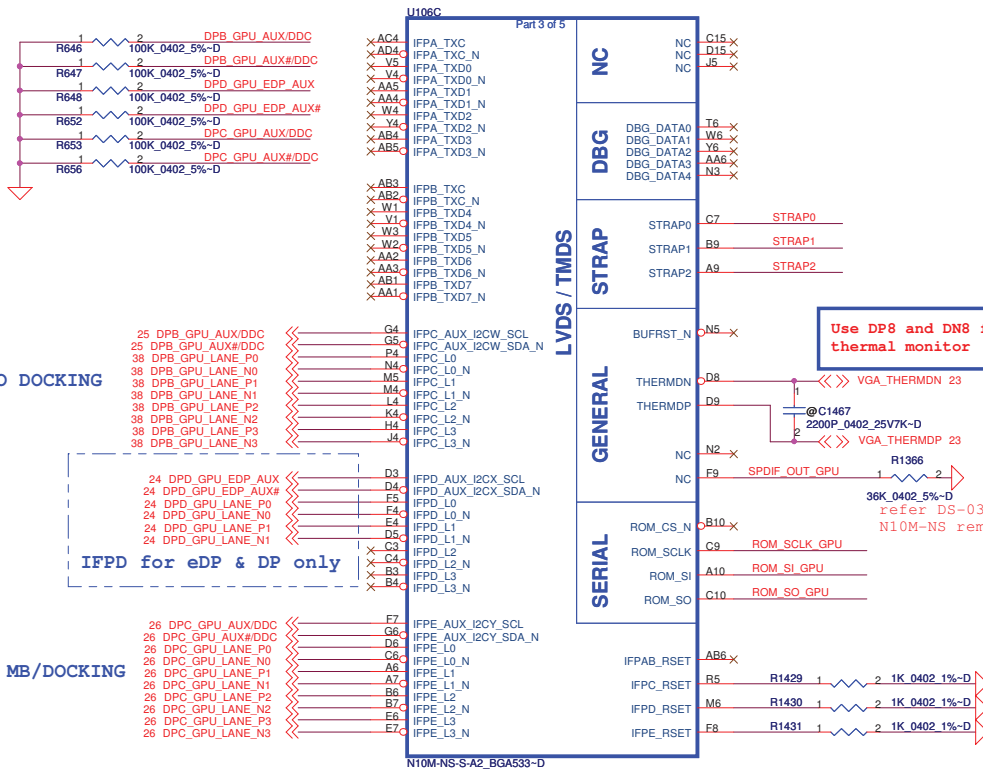
Maximum charging current is 6.24A

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Charger
LA-5472P

TI BQ24745 (PU11A) and Intersil ISL88731 (PU10) are shown with their respective pin connections and component values. The diagram includes a table of pin name differences and a Dell Confidential/Proprietary notice.

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Resistor Values	Pull-up to +3V	Pull-down to Gnd
5K	01111	11111
10K	01110	11110
15K	01011	11011
20K	01001	11001
25K	00111	10111
30K	00110	10110
35K	00011	10011
45K	00000	10000

X7620431001:for Hynix 64Mx16 DDR3 part stuff R1343=15K
 X7620431002:For Samsung 64Mx16 DDR3 part stuff R1343=20K

STRAP0	USER[3:0]
STRAP1	3GIO_PADCFG_LUT_ADR[3:0]
STRAP2	PCI_DEVID[3:0]

ROM_SCLK	PCIDEVID_EXT, SUB_VENDOR, SLOT_CLK, PEX_PLL_EN
ROM_SI	RAM_CFG[3:0]
ROM_SO	XLCK_417, FB_0_BAR_SIZE, ALT_ADOOR, VGA_DEVICE

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N10M DP, STRAP, GND

Size: **LA-5472P**

Date: Wednesday, January 20, 2010

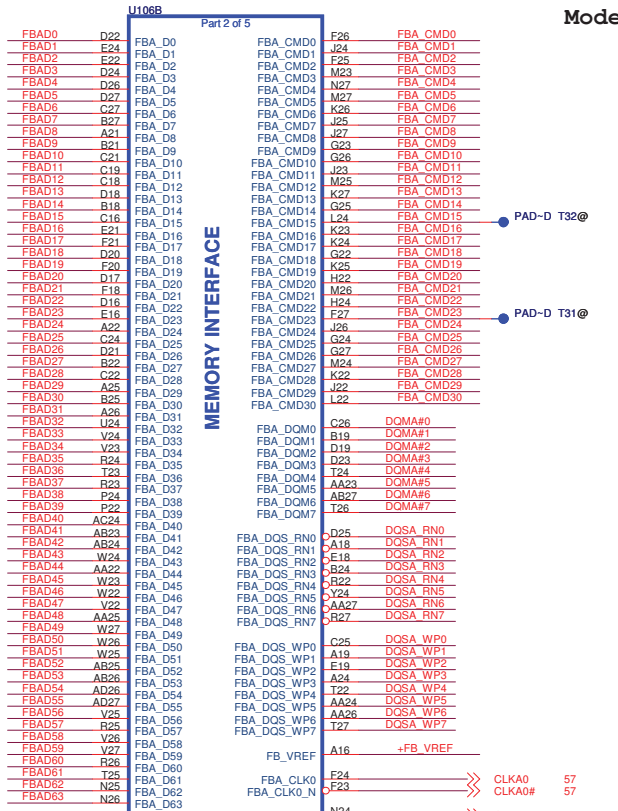
Rev: **A00**

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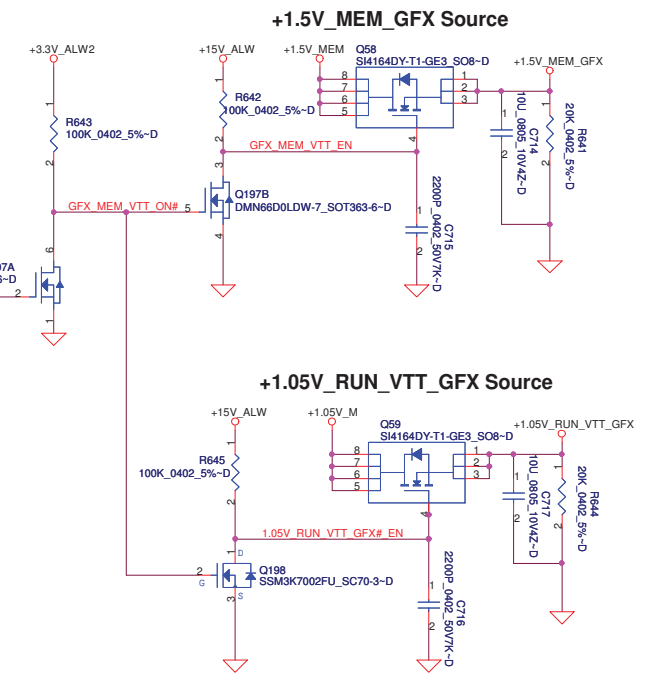
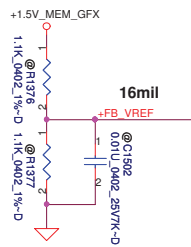
FBAD[0..63] <<>> FBAD[0..63] 57.58
 FBA_CMD[0..30] <<>> FBA_CMD[0..30] 57.58
 DQMA#[0..7] <<>> DQMA#[0..7] 57.58
 DQSA_RN[0..7] <<>> DQSA_RN[0..7] 57.58
 DQSA_WP[0..7] <<>> DQSA_WP[0..7] 57.58

Mode C - Mirror Mode Mapping

DATA Bus	
Address	0..31 32..63
CMD0	CKE_L
CMD1	A8 A8
CMD2	CS0#_L
CMD3	A7 A6
CMD4	A2 A1
CMD5	A11 A9
CMD6	A5 A4
CMD7	A0 A12
CMD8	CAS# CAS#
CMD9	BA1 A3
CMD10	A9 A11
CMD11	CS0#_H
CMD12	BA0 BA0
CMD13	BA2 A15
CMD14	A3 BA1
CMD15	CS1#_H
CMD16	ODT_H
CMD17	A4 A5
CMD18	A13 A14
CMD19	WE# A10
CMD20	A1 A2
CMD21	A10 WE#
CMD22	A12 A0
CMD23	CS1#_L
CMD24	RAS# RAS#
CMD25	ODT_L
CMD26	A6 A7
CMD27	CKE_H
CMD28	RST RST
CMD29	A14 A13
CMD30	A15 BA2



N10M-NS-S-A2_BGA533-D



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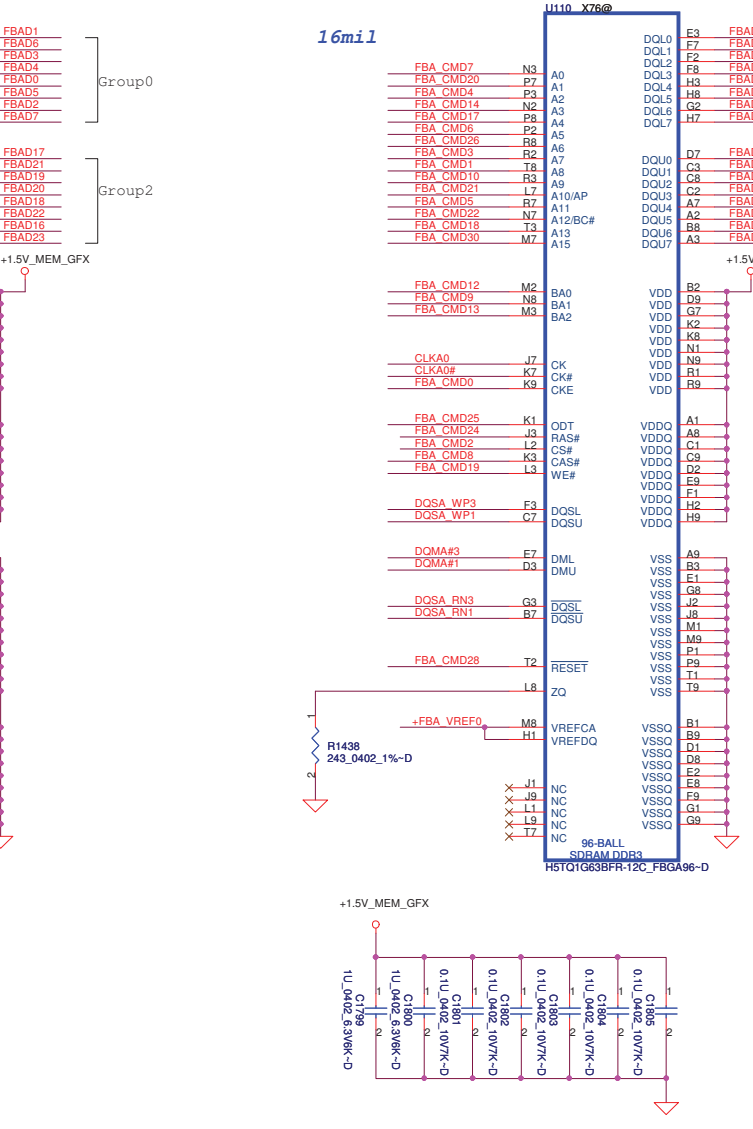
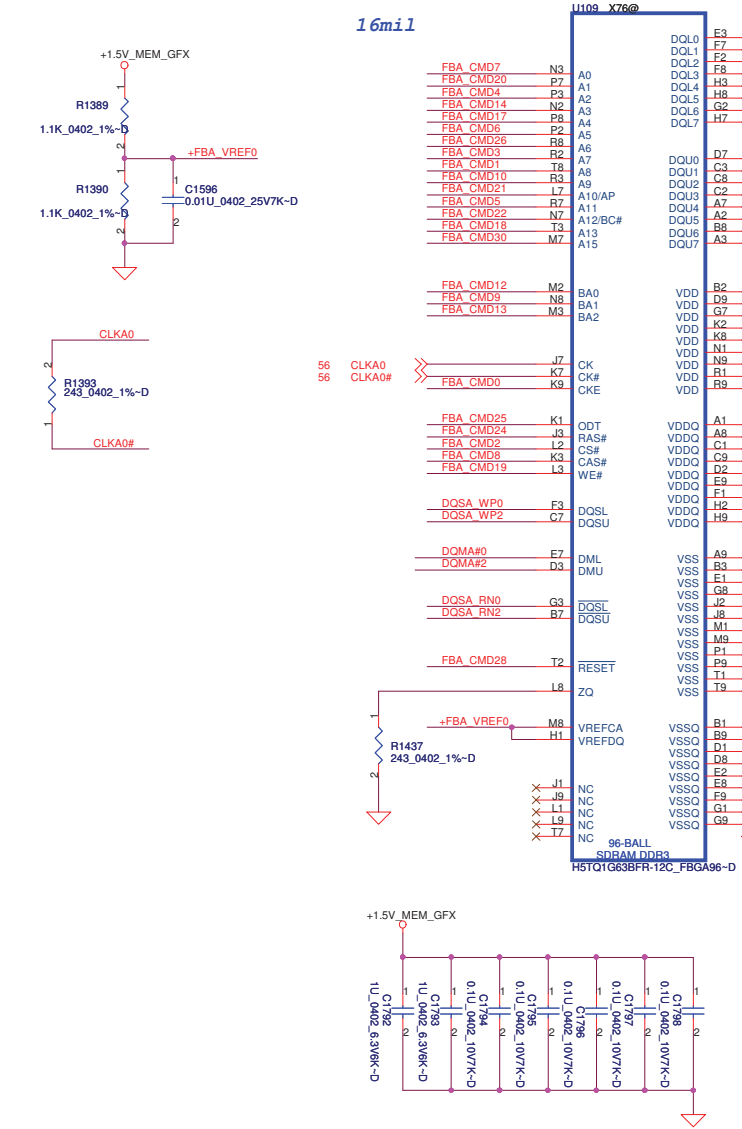
N10M Memory

Document Number
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Memory Partition A - Lower 32 bits

- FBA_CMD[0..30] <<< FBA_CMD[0..30] 56.58
- FBAD[0..63] <<<>> FBAD[0..63] 56.58
- DOMA#[0..7] <<<>> DOMA#[0..7] 56.58
- DOSA_RN[0..7] <<<>> DOSA_RN[0..7] 56.58
- DOSA_WP[0..7] <<<>> DOSA_WP[0..7] 56.58



Mode C - Mirror Mode Mapping

Address	DATA Bus	
	0..31	32..63
CMD0	CKE_L	
CMD1	A8	A8
CMD2	CS0#_L	
CMD3	A7	A6
CMD4	A2	A1
CMD5	A11	A9
CMD6	A5	A4
CMD7	A0	A12
CMD8	CAS#	CAS#
CMD9	BA1	A3
CMD10	A9	A11
CMD11		CS0#_H
CMD12	BA0	BA0
CMD13	BA2	A15
CMD14	A3	BA1
CMD15		CS1#_H
CMD16		ODT_H
CMD17	A4	A5
CMD18	A13	A14
CMD19	WE#	A10
CMD20	A1	A2
CMD21	A10	WE#
CMD22	A12	A0
CMD23	CS1#_L	
CMD24	RAS#	RAS#
CMD25	ODT_L	
CMD26	A6	A7
CMD27		CKE_H
CMD28	RST	RST
CMD29	A14	A13
CMD30	A15	BA2

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Title: **VRAM A Lower**

Size: **LA-5472P**

Date: **Wednesday, January 20, 2010**

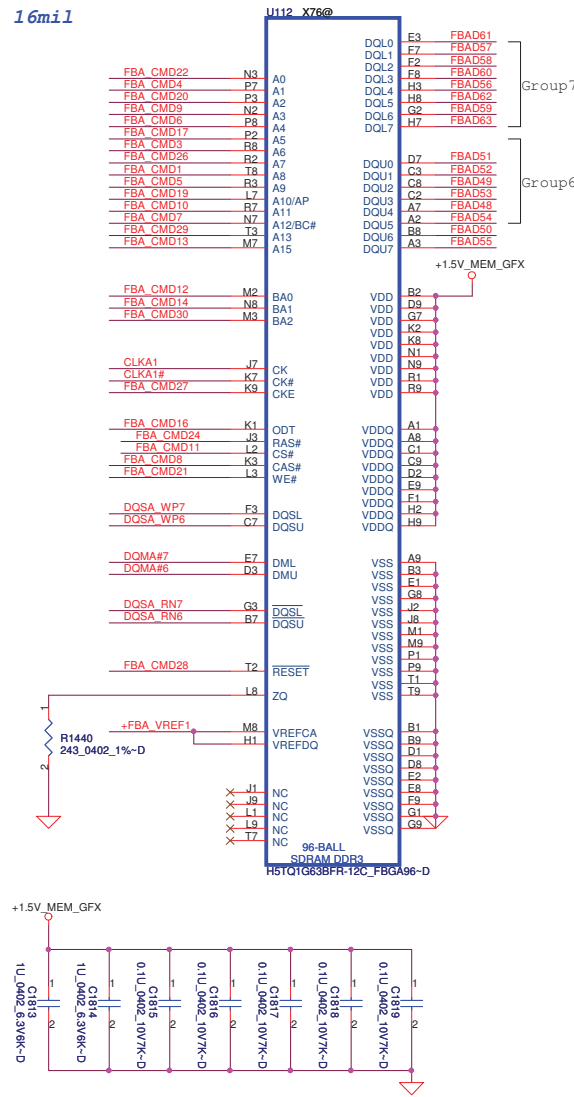
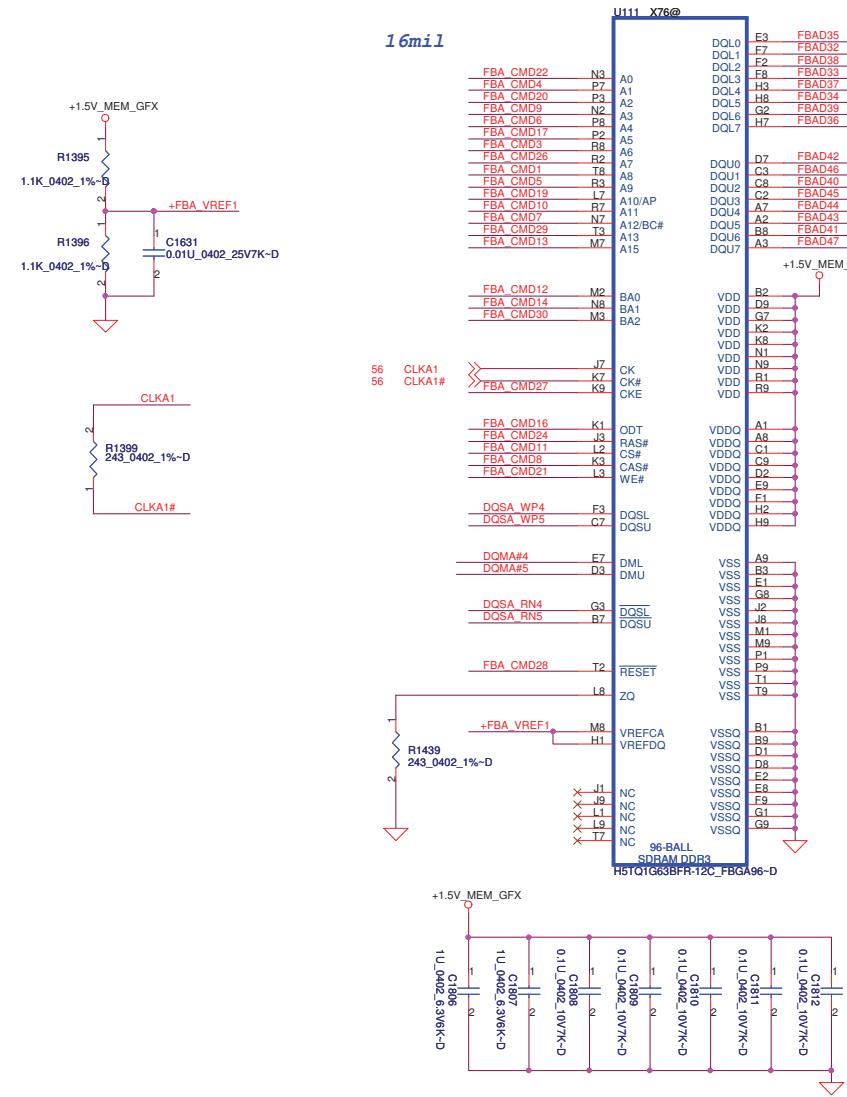
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Memory Partition A - Upper 32 bits

- FBAD[0..63] <<>> FBAD[0..63] 56..57
- FBA_CMD[0..30] <<>> FBA_CMD[0..30] 56..57
- DOMA#[0..7] <<>> DOMA#[0..7] 56..57
- DQSA_RN[0..7] <<>> DQSA_RN[0..7] 56..57
- DQSA_WP[0..7] <<>> DQSA_WP[0..7] 56..57



Mode C - Mirror Mode Mapping

Address	DATA Bus	
	0..31	32..63
CMD0	CKE_L	
CMD1	A8	A8
CMD2	CS0#_L	
CMD3	A7	A6
CMD4	A2	A1
CMD5	A11	A9
CMD6	A5	A4
CMD7	A0	A12
CMD8	CAS#	CAS#
CMD9	BA1	A3
CMD10	A9	A11
CMD11		CS0#_H
CMD12	BA0	BA0
CMD13	BA2	A15
CMD14	A3	BA1
CMD15		CS1#_H
CMD16		ODT_H
CMD17	A4	A5
CMD18	A13	A14
CMD19	WE#	A10
CMD20	A1	A2
CMD21	A10	WE#
CMD22	A12	A0
CMD23	CS1#_L	
CMD24	RAS#	RAS#
CMD25	ODT_L	
CMD26	A6	A7
CMD27		CKE_H
CMD28	RST	RST
CMD29	A14	A13
CMD30	A15	BA2

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VRAM A Upper

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Version Change List (P. I. R. List)

Item	Page#	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
1	40	HW	7/13/2009	COMPAL	Board ID	R98 change to 130k ohm	X01
2	30	HW	7/13/2009	COMPAL	follow M09 +3.3V_LAN enable control circuit	Depop R47	X01
3	8, 12, 13, 42	HW	7/13/2009	Intel	Intel S3 reduction circuit.	Add R1469, R1497~R1505, R1507~R1509, C1875, C1878~C1884, Q199~Q202, Q205, Q207, Q208, U141, PJP906, PJP907, change R879 to 1.5K, R880 to 750ohm, R624 to 22 ohm, change CPU CDDQ power source from +1.5V_MEM to +1.5V_CPU_VDDQ, change +.075_DDR_VTT discharge gate from RUN_ON_ENABLE# to RUN_ON_CPU1.5VS3#, add +1.5V_CPU_VDDQ discharge circuit, add net "DDR_HVREF_RST_GATE" from U36.A34 to Q119.2, "CPU1.5V_S3_GATE" from U36.A36 to R1501	X01
4	31	HW	7/23/2009	Broadcom	Change C718 value	Change C718 from .47uF to .22uF	X01
5	23	HW	7/23/2009	DELL	Follow DELL request to remove R3P circuit	Delete U140, R136, R138, R156,R507, R516, R519, R529, R531, R534~R536, R594, R1457, R1458, R1462, R1463, C434, C72, C73, C391, C406, pop R142, D2, C219	X01
6	41,37	HW	7/23/2009	Compal	Per M09 lesson learn request	Re-define JTP1, JBI01	X01
7	19	HW	7/23/2009	Intel	GPIO1, 6, 7 need to PU if no used.	Add R1506, R1510	X01
8	40 43	HW	7/23/2009	Compal	Follow SMSC5045 spec	Add R1512, @C1885, C1886, change R560 to 100Kohm, add net name LAT_ON_SW#_R	X01
9	31	HW	7/23/2009	Broadcom	Remove RFID disable circuit	Remove R1062~R1065	X01
10	24	HW	7/23/2009	Compal	CAM Module change from 7 pin to 8 pin	Change pin define for JEDP1	X01
11	31	HW	7/23/2009	Broadcom	R898 and R485 pop at the same time	Depop R898	X01
12	24	HW	7/29/2009	Compal	Nvidia BIA_PWM implementation	POP R165, de-pop R166	X01
13	8,15	HW	7/29/2009	Compal	Depop all related components where are located at 0 Z-high area	Depop JXDP1, JXDP2, JDEG1, JP2 connector	X01
14	42	HW	7/29/2009	Compal	For load switches Vout over 5% range concern by power team.	Change Q151 to SIS406D,Q183 to SI7658ADP,Q58 to SI4164DY	X01
15	42	HW	7/29/2009	Compal	Backdrive EA Failure on RAM	Pop R625 and Q79, change R625 to 0603 size.	X01
16	21	HW	7/29/2009	Intel	The PLLs aren't used in a DIS system	De-pop C105 & C106	X01
17	36,39	HW	7/29/2009	DELL	Reconnect the signal UWB_RADIO_DIS#	Connect UWB_RADIO_DIS# from EC5028.A56 to MINI3.20	X01
18	24	HW	7/29/2009	PERICOM	Pericom 8200 SW issue DVI can not work	Add R1516 to pull up U9 pin 23 (P1_OC0) of Pericom 8200 SW with a 4.7K ohm resistor to +3.3_RUN	X01
19	29	HW	7/29/2009	Compal	EMI solution.	Change R1295 to L4 (220ohm) and R1217 from 22ohm to 47ohm.	X01
20	42	HW	7/29/2009	Compal	Base on de-rating report.	Change Q61 from AO4456 to NTMS4107.	X01
21	37, 39	HW	7/29/2009	Compal	GPIO MAP update	Add reserved R1513 between U95.18 and +3.3V_RUN, add R1514 between U95.18 and 5028.A47 named EN_ESATA_RPTR.	X01

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Version Change List (P. I. R. List)

Item	Page#	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
22	31	HW	7/29/2009	Broadcom	Resolve 5882 leakage issue	Add R884, R1515, Q209, Q210	X01
23	31	HW	7/29/2009	Broadcom	Resolve smart cart can't work problem.	pop R775, R537, depop R776.	X01
24	36	HW	7/29/2009	Compal	Change PU power rail for USB_MCARD1_DET#	Change USB_MCARD1_DET# PU power rail to +3.3V_RUN	X01
25	31	HW	7/29/2009	Compal	Remove R1061 to avoid double PU and provide back-drive path.	Remove R1061	X01
26	21	HW	7/29/2009	Compal	Follow the pop option on CRB1.6 to depop C39 for +VCCACLK, C610 for +SATAPLL, C111 and C112 for +1.05V_M_VCEPW	Depop C610, C39, C111, C112	X01
27	15	HW	7/29/2009	Compal	Base on crystal EA result.	Change external Load Capacitor Value C296 and C297 to 12 pF of Y1.	X01
28	30	HW	7/29/2009	Compal	Base on crystal EA result.	Change external Load Capacitor Value C476 to 33 pF and C427 change to 200 ohm (R808) of Y2.	X01
29	40	HW	7/29/2009	Compal	Base on crystal EA result.	Change external Load Capacitor Value C674 and C675 to 33 pF of Y4.	X01
30	33	HW	7/29/2009	Compal	Base on crystal EA result.	Change external Load Capacitor Value C514 and C515 to 22 pF of X3.	X01
31	29	HW	7/29/2009	Compal	EMI solution.	Change R1215 from 22ohm to 47ohm.	X01
32	29	HW	7/29/2009	Compal	Prevent floating of PCH_GPIO34	Add R1511 10K PD.	X01
33	38	HW	7/29/2009	Compal	Based on DFX team request	Change docking connector from SP030000F0L(JAE_WD2F144WB1_144P-T) to SP030000F0L(JAE_WD2F144WB1R300_144P).	X01
34	36	HW	7/29/2009	Compal	Change PU power rail for PCIE_MCARD3_DET#	Change PCIE_MCARD3_DET# PU power rail to +3.3V_RUN	X01
35	18 35	HW	05/08/2009	Compal	Remove Braidwood circuit.	Delete R1411, R1453, JBW1	X01
36	36	HW	05/08/2009	Compal	Base on SATA EA result, need to trun off Pre-emphasis 0.	Depop R1298, pop R1301.	X01
37	33	HW	10/08/2009	Compal	Base on crystal EA result.	Change C514 C514 to 15pF and R421 to 100 ohm.	X01
38	38	HW	11/08/2009	Compal	Change VGA_ID_DISC & VGA_ID_UMA PU power rail	Change VGA_ID_DISC & VGA_ID_UMA PU power rail from +3.3V_RUN to +3.3V_ALW	X01
39	38	HW	11/08/2009	Compal	Change ODD_DET# PU power rail.	Change ODD_DET# PU power rail to +3.3V_RUN	X01
40	41	HW	11/08/2009	SMSC	Watch dog timer may not be reseted when EMC4002 VDD_PWRGD is not completely at Logic Low.	Add discharge circuit for +3.3V_M	X01
41	23	HW	11/08/2009	SMSC	SMSC review feedback	The pull-up source of the R150 should be changed to +VCC_4002	X01
42	39	HW	11/08/2009	SMSC	per SMSC 5045 AN 19.6, 4002 AN 16.11	R541, R554, R1512 should be 10K.	X01
43	23	HW	11/08/2009	Compal	FAN1_DET# should have 10K PU to +3.3V_M	Add R1517	X01
44	31	HW	11/08/2009	Broadcom	Follow Broadcom request	Delete T159, R494, R498, R631, R634, R898, C640, C641, C642 C647, C1026, L73, add R1522, C1887, C1888, change connection for R496, R497 to GND, change connection for JCS1pin3 and pin4	X01

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Version Change List (P. I. R. List)

Item	Page#	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
45	8	HW	11/08/2009	DELL	Fix the Intel S3 power up timing	Change C1880 from 0.01uF to 0.22uF 0402 cap.	X01
46	31	HW	11/08/2009	Broadcom	Follow Broadcom request	Change C646 to 220nF that was placed near the JSC1 pin 10 (+SC_VCC). And 470nF should be at C718 near U3 (TDA8034)	X01
47	31	HW	12/08/2009	Broadcom	Follow Broadcom request	Change R497 & R496 to 0 ohm, but depop	X01
48	27	HW	12/08/2009	Compal	RGB EA result	C251-C253 to 8.2pF; L61-L63 to 10-Ohm Bead ; De-pop C390,C518,C996	X01
49	29	HW	12/08/2009	DELL	Use the SiTimes part due to the cost savings	Change X4 from TXC to SiTimes SIT8102AC3333E12T	X01
50	8	HW	12/08/2009	Intel	Intel review schematic feedback	Add R529 and C1889	X01
51	33	HW	12/08/2009	Richo	Change pop option for R5U242	Change C21 from 10U to 47U, change R46 to C1889 (1uF)	X01
52	31	HW	12/08/2009	Broadcom	BCM5882 pin-C1 "RSTOUT_N" is an open drain I/O type, we need to have 4.7K pull-up to 3.3V_ALW	Add R638	X01
53	30 36	HW	13/08/2009	Compal	Disconnect IO & DOCK VCT	Delete R652 & C41, Rename IO VCT to +LOM_VCT_IO & reserve C712 pad for test.	X01
54	31	HW	13/08/2009	Compal	Broadcom review request	USB_GPIO27 Should have a 0ohm but de-pop resistor.	X01
55	39	HW	14/08/2009	SMSC	SMSC review	Change R561 and R1046 from 1M ohm to 100K ohm.	X01
56	39	HW	14/08/2009	SMSC	SMSC review	Remove R587, base on crystal EA result that only need to change caps value.	X01
57	10	HW	14/08/2009	Intel	Follow Intel recommand to add debug TP.	Add T186~T190	X01
58	31	HW	14/08/2009	Compal	Smart card EA result	Change R772 to 47 Ohm and C1015 to 10pF for resolving SC_CLK Rise/Fail timing issue and also change C633 to 10pF.	X01
59	31	HW	14/08/2009	DELL	Avoid a glitch for DDR_HVREF_RST_GATE, please add a 1.1K 1% no-stuff pull-up to +1.5V_CPU_VDDQ rail on the PM_DRAM_PWRGD_R signal for a back-up option	Change C1889 to 0.1u, add R1518 for PM_DRAM_PWRGD_R but depop.	X01
60	8 45	HW	14/08/2009	DELL	CPU detection since the edge diode has been removed from M'09	Delete T1 and add R1519 for CPU_DETECT# and connect JCPU.AH24 to U36.B18	X01
61	15 19 36	HW	14/08/2009	DELL	Invert the EN_ESATA_RPTR signal and connect this to SATAGP4/GPIO16	Add Q211 and R1520 but depop, pop R1513 and de-pop R1514 , change net name from GPIO16 to EN_ESATA_RPTR#	X01
62	34	HW	14/08/2009	Compal	By EMI request, pop common choke	Change Pop otion for express card, pop L64, depop R791 R792. For USB2,3 pop L65,L66 and reserve R1524,R1525,R1526 and R1527.	X01
63	30	HW	14/08/2009	Intel	By Intel request	Add R1528 for LAN_REQ#	X01
64	37	HW	17/08/2009	Intel	Adding stitching caps near the DOCK_LOM traces where it crosses over plane splits.	Add C1028	X01

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65	38	HW	8/19/2009	NV	Solve DVI issue	Add Q213~Q218, R1523, R1530~R1540	X01
66	26	HW	8/19/2009	Pericom	8200 pin 8,9 add caps to minimize noise	Add C1597 & C1598	X01
67	53	HW	8/19/2009	NV	Reserve crystal for 27M.	Add @R1541,@Y7, @C1891, @C1892	X01
68	24	HW	8/20/2009	Compal	Follow Marguax schematic	Depop R279,R1027	X01
69	53	HW	8/20/2009	Compal	Add PU/PD resistor for 8200 back-up plan	Add R1542~R1544, but depop.	X01
70	35	HW	8/24/2009	Compal	Add PD resistor for back-drive issue	Add R1545~R1547	X01
71	24	HW	8/25/2009	Compal	No need PD/PU resistors at EDP AUX channel	Delete R279 & R1027	X01
72	21	HW	8/25/2009	Compal	Add by pass caps	populate C39 & C610	X01
73	42	HW	8/25/2009	Compal	Un-populate pop option for double discharge path	Un-populate R612,R607 and R1498	X01
74	11	HW	8/25/2009	Compal	Base on power team FDIM test	Change C48,C49,C50,C51,and C52 to 22uF.	X01
75	30	HW	8/26/2009	Intel	Follow Intel WW35 `09	Change R808 to C427 10pF and change C475 to 33pF	X01
76	53	HW	8/27/2009	Compal	Follow Marguax to populate 27MHz crystal for PT build.	Populate Y7,C1891,C1892,R1541 and de-pop R631	X01
77	6,53	HW	9/28/2009	Compal	Populate 27MHz crystal.	Depop R43,R39,R1317, pop R1417	X02
78	17	HW	9/28/2009	Intel	Follow Intel DG 1.62	Change R672 to 1K_0402_5%.	X02
79	15,18	HW	9/28/2009	Compal	Depop XDP circuit component	Depop R118,R94	X02
80	53	HW	9/29/2009	NV	GPU_JTAG_TRST# should be pull down	Pop R1372 and cahnge to 1K 0hm.	X02
81	40	HW	10/20/2009	Compal	Depop R5	Depop R5 for double pull down	X02
82	33	HW	10/20/2009	Compal	Follow DFX recommendation change JSD1 footprint to modify screw hole.	Chnage FOX_2WX131A1-31DD-7F_20P-T to FOX_2WX131A1-31DD-7F_18P.	X02
83	36	HW	10/20/2009	Compal	Correct USB_MCARD2_DET# PU power rail	Chnage power rail from +3.3V_RUN to +3.3V_ALW_PCH	X02
84	17	HW	10/20/2009	Compal	Follow schematic check list 2.0, change resistor value	Chnage R268 from 1K to 10K	X02
85	16	HW	10/20/2009	Compal	Change R910 value and placement	Change R910 form 0 ohm to 22 ohm and place near PCH side.	X02
86	37	HW	10/26/2009	Compal	Chnage USB common choke by EMI request	Change L95 L96 from DLW21SN900SQ2_0805~D to HCMC0805-900MFS_4P~D	X02
87	23	HW	10/26/2009	Compal	Change OTP temperature	change R151 from 953ohm to 1.02Kohm	X02
88	53	HW	10/27/2009	Compal	To solve 27 Mhz noise issue	Connect Y7 pin 2 and 4 to GND.	X02
89	31	HW	10/27/2009	Broadcom	For 5882-B0 request	L71, L72 68nH, 2%, 400mA; C1070, C1071 1500pF, 2%, 50V; C1886, C1887 150pF, 2%, 50V	X02
90	15	HW	10/29/2009	Compal	Change flash ROM part number	Due to W25X32VSSIG will be EOL, change part number to W25Q32BVSSIG.	X02

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91	16	HW	10/29/2009	Dell	MEM SMBus design needs to change	Move Q190 connection, add R1549,R1550, add net name DDR_XDP_CLK/DAT	X02
92	29	HW	10/29/2009	Compal	Create a low pass filter with the pole set at 36kHz to filter out of band noise	De-pop C1066 & C1067, R1090, R1089 ; R340 & R342, R1091 & R1092 change to 2k, add C1893-C1896 1000pF.	X02
93	40	HW	11/02/2009	Compal	Change BID	Change R98 form 130K ohm to 33K ohm.	X02
94	8, 15	HW	11/02/2009	Compal	To avoid stub for SM bus EA quality XDP is not use.	Add R1551~R1556 but depop	X02
95	36	HW	11/02/2009	DELL	Support WiMax LED status	Need to populate R840	X02
96	43	HW	11/05/2009	Compal	To avoid golden finger was scraped on FFC.	Change sniffer connector from TYCO_1-1734820-2 to TYCO_1-2041070-2.	X02
97	41	HW	11/05/2009	Compal	Chnagne TP SMBus PU power rail.	Change power rail from +5V_ALW to +3.3V_ALW	X02
98	31	HW	11/05/2009	BRCM	Delete 2nd ROM for BRCN5882	By BRCM review result, delete U14.	X02
99	24	HW	11/10/2009	Compal	LCD power sequencing issue	change R161 from 470 to 100 ohm .	X02
100	19	HW	11/11/2009	DELL	PCH driving the siganl low at GPIO15 initial.	Add R1557 2.2K PU resistor to +3.3V_ALW_PCH on the SIO_EXT_WAKE# signal.	X02
101	15	HW	11/11/2009	DELL	To change the pin on the EC side to OD and add a pull-up to PCH's core well	Add R1558 10K PU resistor to +3.3V_RUN on the ME_FWP signal.	X02
102	15, 40	HW	11/11/2009	Compal	RTC timing issue	Y1 & Y4 change from 1TJS125DJ4A420P to Q13MC30610018. Opreating temperature should -40~+85 degree to meet test requirement.	X02
103	19	HW	11/17/2009	Compal	Chnagne GPIO34 of PCH from PD to PU	Change from PD to PU +3.3V_RUN	X02
104	31	HW	11/17/2009	Compal	Follow Marguax schmatic and it also could pass smart card EA.	To change R772 from 47 ohm to 22 ohm	X02
105	31	HW	11/17/2009	Compal	To solve touch pad ESD issue	Change L41 and L42 to 100 ohm (R1564 & R1565)	X02
106	15	HW	11/19/2009	Compal	Follow Intel check list rev2.0	Change R2244 to tolerance from 5% to 1%	X02
107	15	HW	11/19/2009	Compal	Follow DCU 414044 Rev2.0	Depop R123, R804-R807 and R1281, R1282, R1315.	X02
108	38	HW	12/22/2009	Compal	Simplo battery slice EMI issue	Add C1897 and C1898 (Depop, reserve for EMI test)	A00
109	37	HW	12/22/2009	Compal	DFB issue, finger printer connector will easy shift during reflow process.	Change finger printer connector from TYCO_1734242-6_6P-T to TYCO_2041070-6_6P-T	A00
110	31	HW	12/22/2009	Compal	By Broadcom recommend	Change L71, L72 from 68nH to 150nH, C1070, C1071 from 1500pF to 390pF. C1887, C1888 from 150pF to 390pF.	A00
111	32	HW	12/22/2009	Compal	Change TCM to T1 version	Change TCM from SSX44B-D-T to SSX44-D-T1	A00
112	40	HW	12/22/2009	Compal	Change BID	Change R98 form 33K ohm to 1K ohm.	A00
113	08	HW	12/22/2009	Compal	Depop CPU XDP and JTAG circuit for for production systems	Depop C19, C20, R6, R68, R19, R7, R3, R780~R785, R22, R24, R1153, R1156, R66, R1241, R1257	A00
114	15	HW	12/22/2009	Compal	Depop PCH JTAG circuit for for production systems	Depop R123, R804-R807, R1281, R1282, R1315	A00

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115	33, 34	HW	01/07/2010	Compal	Change R5U2542 form ES2 to ES3	Change part number from SA00003C21L to SA00003C22L	A00
116	27	HW	01/14/2010	Compal	RGB EMI issue	Change L61,L62,L63 from 10nH to 27nH, C251,C252,C253 from 8.2pF to 2pF and pop C390,C518,C996	A00
117	37	HW	01/15/2010	Compal	Change SATA repeater part to power saving part	Change U95 to SA00003P10L	A00
118	26	HW	01/19/2010	Pericom	Pericom DP SW DP8200 has new silicon W version in stead of Y version	Change U9 to SA00003CD2L	A00

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1	50	Selector	7/20	TI	CSS GC logic wrong issue	Add PR282 180_ohm to GND	X01
2	46	1.5V_MEM	7/20	Compal ADC Guangyong	Add droop resistor for TI solution	Add PR77	X01
3	45	+3.3V/+5V	8/17	Compal ADC Guangyong	Change 3V/5V choke for cost down	change PL5 from SH00000H90L to SH00000FN0L change PL6 from SH00000HB0L to SH00000HR0L	X01
4	50	Selector	8/17	Compal	Add 1M_ohm pull down to fix ACAV_IN_NB oscillation when battery mode S5	Add PR283	X01
5	50	Selector	8/17	TI	new version CD3301 (PG2.1) don't need PD22 and PR282	depop PD22 add PR282, pop PR430	X01
6	50	Selector	8/17	TI	DOCK_AC_OFF_EC floating issue	add PR285	X01
7	52	ISL62872_GPU	8/17	Dell / intersil	change PU901 to ISL62872 to support NV VID fixture	change PU901 to ISL62872 from ISL62870 and support circuit.	X01
8	49	+VCORE MAX17030	8/17	Compal	change thermistor package from 0603 to 0402 for cost down	Change PH3,PH4 and PH5 from SL200000B0L to SL200000W0L	X01
9	47	1.8V_RUN	8/18	MAXIM	Output ripple voltage unstable issue	Change PC314 from SE00000868L(22u/0805) to SE00000000L(100u/1206) Change PR409 from SD03480618L(8.06k) to SD03460418L(6.04k) Change PR410 from SD03440218L(4.02k) to SD03430118L(3.01k) Change PR408 from SD014402A8L(40.2 Ohm) to SD0000008H8L(51 Ohm) Change PC315 from SE000003W8L(820pF) to SE076333K8L(3300pF) Change PR411 from SD00000268L(6.98k) to SD03445318L(4.53k) Change PC310 from SE074102K8L(1000P) to SE074472K8L(4700pF) Change PC309 from SE071330J8L(33pF) to SE071560J8L(56pF) Change PC311 from SE042104K8L(0.1u/0603/25V) to SE076104K8L(.1u/0402/16V) Add PR413 SD02800008L(0 Ohm) Change PR102, PR103 and PR104 from SD013220B8L(2.2) to SD00000V98L(1.1) Change PR310, PR311 and PR312 from SD03430118L(3.01k) to SD03424918L(2.49k) Change PR307, PR308 and PR309 from SD03422118L(2.21k) to SD03417418L(1.74k) Change PR137 from SD03449910L(4.99k) to SD03447518L(4.75k) Add PC271,PC272 and PC273 SE075223K8L(0.022uF)	X01
10	49	+VCORE MAX17030	8/20	Maxim	Vcore FDIM issue	Change PR188 and PR201 from SD03451018L(5.1k) to SD00000U28L(4.3k) Change PR199 and PR203 from SD03416228L(16.2k) to SD03413728L(13.7k) Change PR198 from SD03468008L(680 Ohm) to SD03418008L(180 Ohm) Change PR202 from SD03468008L(680 Ohm) to SD03410008L(100 Ohm) Change PC108 and PC116 from SE074331K8L(330p) to SE074471K8L(470p) Change PR200 from SD00000DM0L(200k) to SD03451028L(51k) Change PC115 from SE071300J0L(SE071300J0L) to SE071220J8L(22P) Change PC106 from SE071300J0L(30P) to SE071330J8L(33P) Change PR204 from SD03447518L(4.75K) to SD03452318L(5.23K) Change PR205 from SD03444228L(44.2K) to SD03424028L(24K) Change PR207 from SD00000LZ0L(3.83K) to SD00000J20L(4.32K) Change PR208 from SD03482518L(8.25k) to SD03464918L(6.49k)	X01
11	48	+1.05VM/ +1.05VTT	8/20	ON	Fine tune DC accurcay	Change PU301 from SA00003B10L(MAX15050) to SA00003CG0L (ISL8014) and support circuit	X01
12	47	1.8V_RUN	8/25	DELL	1.8V transient 0.1A ~ 1.6A output voltage over spec	Change PU301 from SA00003B10L(MAX15050) to SA00003CG0L (ISL8014) and support circuit	X01

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13	49	Vcore	8/25	MAXIM	Improve DC accuracy	Change exposed pad to PGND from AGND	X01
14	49	Vcore	8/25	MAXIM	Vender recommend PSI# pull down 10k	Change PR334 from SD03410018L (1k) to SD02810028L(10k)	X01
15	51	Charger	8/25	Compal ADC Guangyong	Improve charger choke saturation current at 100 degree C	Change PL14 from SH04856AM8L (5.6u) to SH00000I60L (5.6u)	X01
16	44	DCIN	8/25	Compal	3.3V_ALW2 black driver issue with RTC battery only	Change PD1 from SC100000Q0L(BAT54CW) to SCSB715F08L (RB715F)	X01
17	49	Vcore	8/27	Compal	Reserve resistor pad for debug	Add PR122 and PR123	X01
18	52	GPU_Core	9/01	Intersil	PR916 and PR911 for debug change to 0 Ohm	Change PR916 from SD02810018L(1K) to SD02800008L(0 Ohm) Change PR911 from SD02810018L(1K) to SD02800008L(0 Ohm)	X01
19	49	Vcore	9/01	MAXIM	Fine tune Imon time constant meet Intel SPEC 300uS~500uS	Change PC270 from SE075223K8L (0.022U) to SE076333K8L (.033U)	X01
20	49	Vcore	9/01	MAXIM	Make sure DPRSLPVE low level under 0.33V	Change PR109 from SD03449908L (499 Ohm) to SD02800008L (0 Ohm)	X01
21	52	GPU_Core	10/06	NV	GPU_CORE default setting should be 1V for faster to boot to system and short warm up time for GPU	Depop PR910 and POP PR927	X02
22	44	DC_IN	10/13	TI	High inrush current on DC_IN when AC adapter plug in	Change PR20 from SD02800008L(0 Ohm) to SD02810028L(10k)	X02
23	49	Vcore	10/20	MAXIM	3 phase overlap issue with 2nd source MOSFET	Add PC198, PC199, PC255, PC256, PC259 and PC260 SE074122K8L (1200pF)	X02
24	48	+1.05VTT	10/28	INTEL	Fine tune H_VTTPWRGD voltage level meet Vih(min) = 0.75 * Vtt	Change PR94 from SD03410028L (10k) to SD03427418L (2.74K) Change PR93 from SD03428728L (28.7k) to SD03493118L (9.31K)	X02
25	49	+VCORE	11/03	Compal	change thermistor package from 0603 to 0402 for cost down	Change PH1 from SL20000068L (100K 0603) to SL20000160L (100K 0402)	X02
26	52	GPU_Core	11/12	Compal	For NVIDIA output voltage +/- 30mV criteria	Change PC918 from SGA19331D1L (330u/9m Ohm) to SGA0000420L (470u/4.5m Ohm)	X02
27	48	+1.05VTT/ +1.05VM	11/16	ON	Boost diode over stress	Change PD19 and PD27 from SC1B751V08L(RB751V) to SCS00003M0L(BAT54HT1)	X02
28	51	Charger	01/12	Compal	Reduce Pin33,34 and 35 of the CD3301 surge current	Change PC351 from SE00000130L (1u/0805) to SE043104M8L (0.1u/0805) Change PR404 from SD02800008L (0 Ohm) to SD028100B8L (1 Ohm)	A00

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